

AM13E230x Microcontrollers

1 Features

• Device Cores

- Arm® Cortex®-M33 32-bit CPU up to 200MHz
 - Floating Point Unit (FPU), Custom Datapath Extension (CDE), Memory Protection Unit (MPU) and Micro Trace Buffer (MTB)
 - DSP Extension and 32-bit Trigonometric Math Unit (TMU) accelerates trigonometric calculations
 - DMIPS=310 and Coremark=800
- 1x TinyEngine™ Neural-Network Processing Unit (NPU) optimized for time-series Edge AI enablement

• Memories

- Up to 512kB (2 banks of up to 256kB, 1kB sectors) of non-volatile flash memory
 - 144-bit word with Error Correction Code
 - Bank swap for dual-image firmware
- Up to 128kB of 0-wait state SRAM
 - Hardware parity and 1kB instruction cache
- External Peripheral Interface (EPI) supporting SDRAM, ASRAM, or ASIC/FPGA external interfaces

• High-Performance Analog Peripherals

- 3x SAR Analog-to-digital Converters (ADCs)
 - 6.67MSPS with 12-bit resolution
 - Each ADC supports up to 32 channels
 - Configurable 1.65V or 2.5V internal shared voltage reference (VREF)
 - Support for external voltage reference (VREF)
 - Hardware oversampling and undersampling modes, with accumulation, averaging and outlier rejection
- 4x Analog Comparator Sub-systems (CMPSS)
 - 2x Comparators with Window Functionality
 - 2x 10-bit effective DAC and 2x digital filters
 - CMPSS[2:3] support buffered DACL_OUT to pin
- 3x Programmable Gain Amplifiers (PGA)
 - Unity Gain Support
 - Inverting and non-inverting gain mode support
 - Gain options: 1, 2/-1, 4/-3, 8/-7, 16/-15, 32/-31, 64/-63
 - 4:1 input mux supporting up to 12 channels
 - Programmable output filtering
- Programmable analog connections between ADC, PGAs, CMPSS and DAC

• Optimized Low-Power Modes

- RUN: 49mA @ 200MHz
- STANDBY: 1.84mA with CPU execution resume and 32kB SRAM retention
- SHUTDOWN: <5µA with IO wake-up capability

• Flexible System Peripherals

- 12-channel Data Movement Architecture (DMA) controller
- Nested Vectored Interrupt Controller (NVIC)
- Up to 107 GPIO with Input/Output XBAR connectivity
- 8 GPIOs with Shutdown Wakeup Capability
- 1x Windowed Watchdog Timer (WWDT)
 - Independent 32kHz clock with programmable divider
 - 25-bit counter with configurable timer periods
- 2x general-purpose timers
 - TIMG4 (32-bit), TIMG12 (16-bit)
 - Pre-scaler, Compare/Capture, Shadow
 - Up to 2x channels each

• Real-time Control Peripherals

- 5x Motor Control Pulse Width Modulation (MCPWM) modules
 - 6 PWM channels per module with 16-bit time base
 - 4 Start Of Conversion (SOCs) per module enable precise ADC sampling for single shunt or three shunt current sensing mode
 - Support dead-band, trip event and time base synchronization
- 2x Enhanced Capture (eCAP) modules
 - 32-bit timer for speed, elapsed time, period and duty cycle measurements
 - 1x alternative PWM channel per module
- 3x Enhanced Quadrature Encoder Pulse (eQEP)
 - Supports linear or rotary incremental encoder interface
 - Edge capture unit for optimized speed measurement at low speed
- Device Crossbars (INPUTXBAR, OUTPUTXBAR, PWMXBAR)
 - Flexibility to route signals from GPIO to other modules
 - For example, the INPUTXBAR is used to route signals from a GPIO to other modules such as ADC, CMPSS, MCPWM, eCAP, eQEP, and external interrupts



- **Enhanced Serial Communication Interfaces**
 - Two configurable serial interfaces supporting UART (LIN) or I²C (SMBus/PMBus)
 - Four configurable serial interfaces supporting UART, I²C, or SPI
 - One Modular Controller Area Network (MCAN) with Flexible Data-rate (CAN FD)
- **Clock System**
 - Internal 4MHz/32MHz oscillator (SYSOSC)
 - Internal 32kHz oscillator (LFOSC)
 - System Phase-locked loop (SYSPLL) up to 200MHz
 - External 4MHz to 25MHz crystal oscillator (XTAL)
 - External 4MHz to 48MHz clock input (HFCLK)
- **OS Support**
 - FreeRTOS, Zephyr, Baremetal
- **Safety**
 - Enabling IEC61508 SIL-2 and SIL-3 systems
- **Data Integrity and Encryption**
 - Secure Boot/FWU/Debug/JTAG Lock
 - Secure Key Storage and Management
 - Privileged/Non-Privileged resource partitioning
 - Flash Write/Erase/Hide Protections
 - Device Life cycle Management
 - AES Encryption with 128- or 256-bit Key
 - Unique Identification Number (UID)
- **Internal Diagnostic Modules**
 - Cyclic Redundancy Checker (CRC-16, CRC-32)
 - Integrated Temperature Sensor
 - Integrated BOR/POR Supply Monitors
- **Development Support**
 - JTAG (4-pin) and Serial Wire Debug (SWD) (2-pin)
 - Micro Trace Buffer (MTB)
 - Embedded Trace Macrocell (ETM) (TRACE_DATA[0:3])
 - Supports Serial Trace and Parallel Trace
- **Package Options**
 - 128-pin PDT Thin Quad Flat Package (TQFP) (0.4mm pitch)
 - 100-pin PZ Low-profile Quad Flat Pack (LQFP) (0.5mm pitch)
 - 80-pin PN Low-profile Quad Flat Pack (LQFP) (0.5mm pitch)
 - 64-pin PM Low-profile Quad Flat Pack (LQFP) (0.5mm pitch)
 - 48-pin PT Low-profile Quad Flat Pack (LQFP) (0.5mm pitch)
 - 48-pin RGZ Very Thin Quad Flatpack No-Lead (VQFN) (0.5mm pitch)

- **Operating Characteristics**

- Supply voltage: 3.3V
- Ambient Temperature Range(T_A): –40°C up to 105°C

2 Applications

- [Dual Motor Drive + PFC \(Power Factor Correction\)](#)
- [Multiple Motor Control](#)
- [3-Phase Motor](#)
- [Industrial Drive](#)
- [Fan/Pump Drive](#)
- [Power Tools](#)
- [HVAC](#)
- [Air conditional outdoor unit](#)
- [Robotic lawn mower](#)
- [Washer & dryer](#)
- [Refrigerator & freezer](#)
- [AC inverter & VF drives](#)
- [Servo & stepper drives](#)
- [Field transmitter & sensor](#)
- [Humanoid robot motor drive](#)
- [Robot safety module](#)
- [Collaborative robot servo drive](#)
- [HVAC controller](#)
- [HVAC motor control](#)
- [HVAC valve and actuator control](#)
- [Elevator main control panel](#)
- [Elevator & escalator motor controll](#)
- [Cordless power tool](#)
- [Appliances](#)
- [Industrial Automation](#)
- [Robotics](#)
- [Medical & Healthcare](#)
- [Building Automation](#)
- [Test & Measurement](#)

3 Description

AM13E230x microcontrollers (MCUs) are part of the AM13x highly integrated, low-cost 32-bit MCU family based on the Arm® Cortex®-M33 32-bit CPU operating at up to 200MHz frequency. These real-time control optimized MCUs offer high-performance analog, control, and digital peripheral integration, support ambient temperature ranges from -40°C to 105°C, and operate with a 3.3V supply voltage.

The AM13E230x MCUs provide up to 512KB of embedded flash program memory (2 banks of up to 256KB) with built-in error correction code (ECC) and up to 128KB SRAM with hardware parity. Smaller memory configuration variants are offered.

The processing system incorporates Custom Datapath Extension (CDE) support, a Memory Protection Unit (MPU), Micro Trace Buffer (MTB), a 32-bit Trigonometric Math Unit (TMU), and a TinyEngine™ Neural-network Processing Unit (NPU).

AM13E230x MCUs are enabled with robust, high-performance analog peripherals. Three 12-bit ADCs with a maximum sampling rate of 6.67MSPS, four high speed comparator subsystems with built-in 10-bit reference DACs, and three programmable gain amplifiers with 4:1 mux provide true real-time signal chain performance.

These MCUs also offer real-time control and timing peripherals such as a 12-channel DMA controller, multi-channel PWM generation, generic timers, specialty timers for capture and encoder interface, and a flexible X-BAR system for connecting GPIO and control peripherals.

An independent oscillator and windowed watchdog timer are included as well as multiple internal and external clocking options. Multiple operational power modes are offered for flexibility in controlling power consumption vs. wake-up time.

Data integrity and encryption features (AES, secure boot) provide security across the AM13E230x domains. A Cyclic Redundancy Checker (CRC) module provides internal diagnostics to the AM13E230x MCUs.

Enhanced communication interfaces are supported through one MCAN and up to 6 UNICOMM peripherals to support a combination of UART/LIN, I2C/SMBUS, and SPI. For connecting to external devices or memory, the high-speed External Peripheral Interface (EPI) can connect to SDRAM or asynchronous RAM devices such as FPGA or ASIC.

Package options include 48-pin QFN as well as 48/64/80/100/128-pin QFP.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾	BODY SIZE (NOM)	PITCH
AM13E23019	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm
AM13E23018	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm

Package Information (continued)

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾	BODY SIZE (NOM)	PITCH
AM13E23017	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm

(1) For more information, see the Mechanical, Packaging, and Orderable Information section.

(2) The package size (length × width) is a nominal value and includes pins, where applicable.

3.1 Functional Block Diagram

Figure 3-1 shows the AM13E230x functional block diagram.

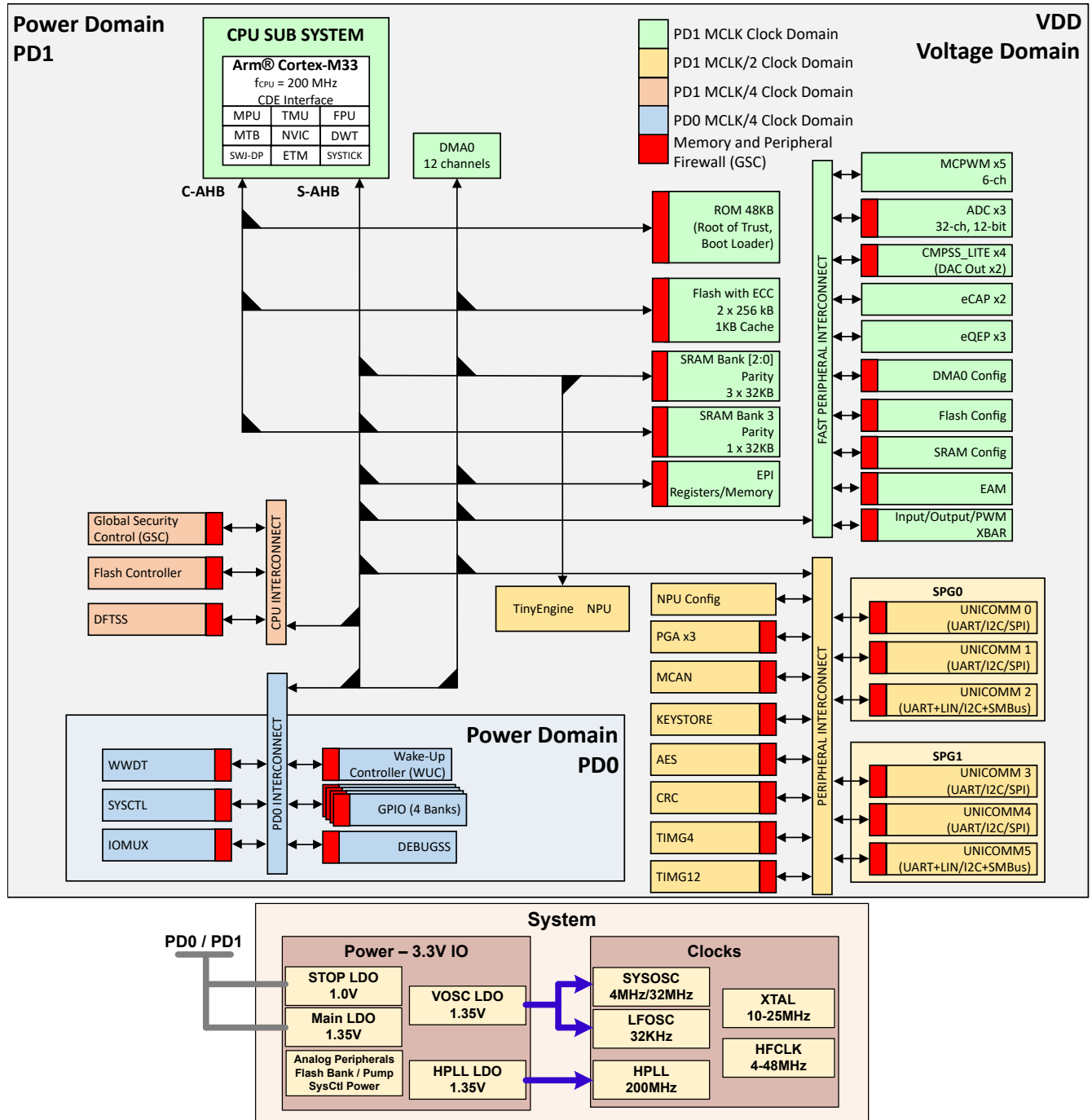


Figure 3-1. AM13E230x Functional Block Diagram

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4 Device Comparison

Table 4-1 lists the features of the AM13E230x microcontrollers.

Table 4-1. Device Comparison

Feature		AM13E23019	AM13E23018	AM13E23017
PROCESSOR AND ACCELERATORS				
Arm® Cortex®-M33	CPU Core Frequency	200MHz		
	Custom Datapath Extension (CDE)	Yes		
	Memory Protection Unit (MPU)	Yes		
	Micro Trace Buffer (MTB)	Yes		
	Trigonometric Math Unit (TMU)	Yes		
TinyEngine™ Neural-network Processing Unit (NPU)		Yes		
MEMORY				
Flash - with Error Correction Code (ECC)		512KB	256KB	128KB
SRAM - with HW Parity		128KB	128KB	64KB
Security Features		JTAGLOCK, Secure Boot		
Cyclic Redundancy Check (CRC)		CRC-16/CRC-32		
SYSTEM				
Data Movement Architecture (DMA) Controller		1x12-Channel		
16-bit General-Purpose Timer (TIMG12)		1		
32-bit General-Purpose Timer (TIMG4)		1		
Windowed Watchdog Timer (WWDT)		1		
Internal 4MHz/32MHz Oscillator (SYSOSC)		1		
Phase-Locked Loop up to 200MHz (SYSPLL)		1		
Internal 32kHz Oscillator (LFOSC)		1		
Crystal Oscillator (HFXT)/External Clock (HFCLK) input		1		
Internal 3.3V to 1.35V LDO		Yes		
General Purpose Input/Output (GPIO)		Up to 107 (package-dependent)		
ANALOG PERIPHERALS				
Analog to Digital Converter (ADC)	ADCs	3		
	Bits	12-bit ADC		
	ADC channels	Up to 32 channels		
Temperature Sensor		1		
Programmable Gain Amplifier (PGA) with Analog Input Mux		3		
Comparator Subsystem (CMPSS)	CMPSS (each includes 2x 11-bit DAC + 2x digital filters)	4		
	DACL Buffered Output	2		
CONTROL PERIPHERALS				
Motor-control Pulse Width Modulation (MCPWM)		5 (6-ch)		
Enhanced Capture Module (eCAP)		2		
Enhanced Quadrature Encoder Pulse Module (eQEP)		3		

Table 4-1. Device Comparison (continued)

Feature			AM13E23019	AM13E23018	AM13E23017
COMMUNICATION PERIPHERALS					
UNICOMM	SPGSS 0	UART	Up to 3 (2 UART, 1 UART+LIN)		
		I ² C	Up to 3 (2 I ² C, 1 I ² C+SMBUS)		
		SPI	Up to 2		
	SPGSS 1	UART	Up to 3 (2 UART, 1 UART+LIN)		
		I ² C	Up to 3 (2 I ² C, 1 I ² C+SMBUS)		
		SPI	Up to 2		
Modular Controller Area Network (MCAN)			1x (CAN/CAN-FD)		
HIGH SPEED PERIPHERALS					
External Peripheral Interface (EPI)			1		
PACKAGE, TEMPERATURE, AND QUALIFICATION OPTIONS					
Junction temperature (T _J)			−40°C to 125°C		
Ambient Temperature (T _A)			−40°C to 105°C		

5 Terminal Configuration and Functions

5.1 Pin Diagram

Note

The terms "ball", "pin", and "terminal" are used interchangeably throughout the document. An attempt is made to use "ball" only when referring to the physical package.

The diagrams in this section are used in conjunction with the other Terminal Configuration and Functions tables to locate signal names and ball grid numbers. The HTML version of this document provides additional information when hovering your cursor over a ball.

Device Package Options

Package	Type	Size	Pitch	Pin Layout	Analog IO	Digital IO	Pin Count (Total)
LQFP128	PDT (TQFP)	14x14mm ²	0.4mm	32x32	44	107	128-pin
LQFP100_G	PZ (LQFP)	14x14mm ²	0.5mm	25x25	44	86	100-pin
LQFP100_H	PZ (LQFP)	14x14mm ²	0.5mm	25x25	43	85	100-pin
LQFP80	PN (LQFP)	12x12mm ²	0.5mm	20x20	39	66	80-pin
LQFP64_G	PM (LQFP)	10x10mm ²	0.5mm	16x16	27	52	64-pin
LQFP64_H	PM (LQFP)	10x10mm ²	0.5mm	16x16	26	52	64-pin
LQFP48	PT (LQFP)	9x9mm ²	0.5mm	12x12	21	38	48-pin
QFN48	RGZ (VQFN)	7x7mm ²	0.5mm	12x12	22	42	48-pin (PWRPAD)

5.1.1 AM13E230x Pin Diagrams

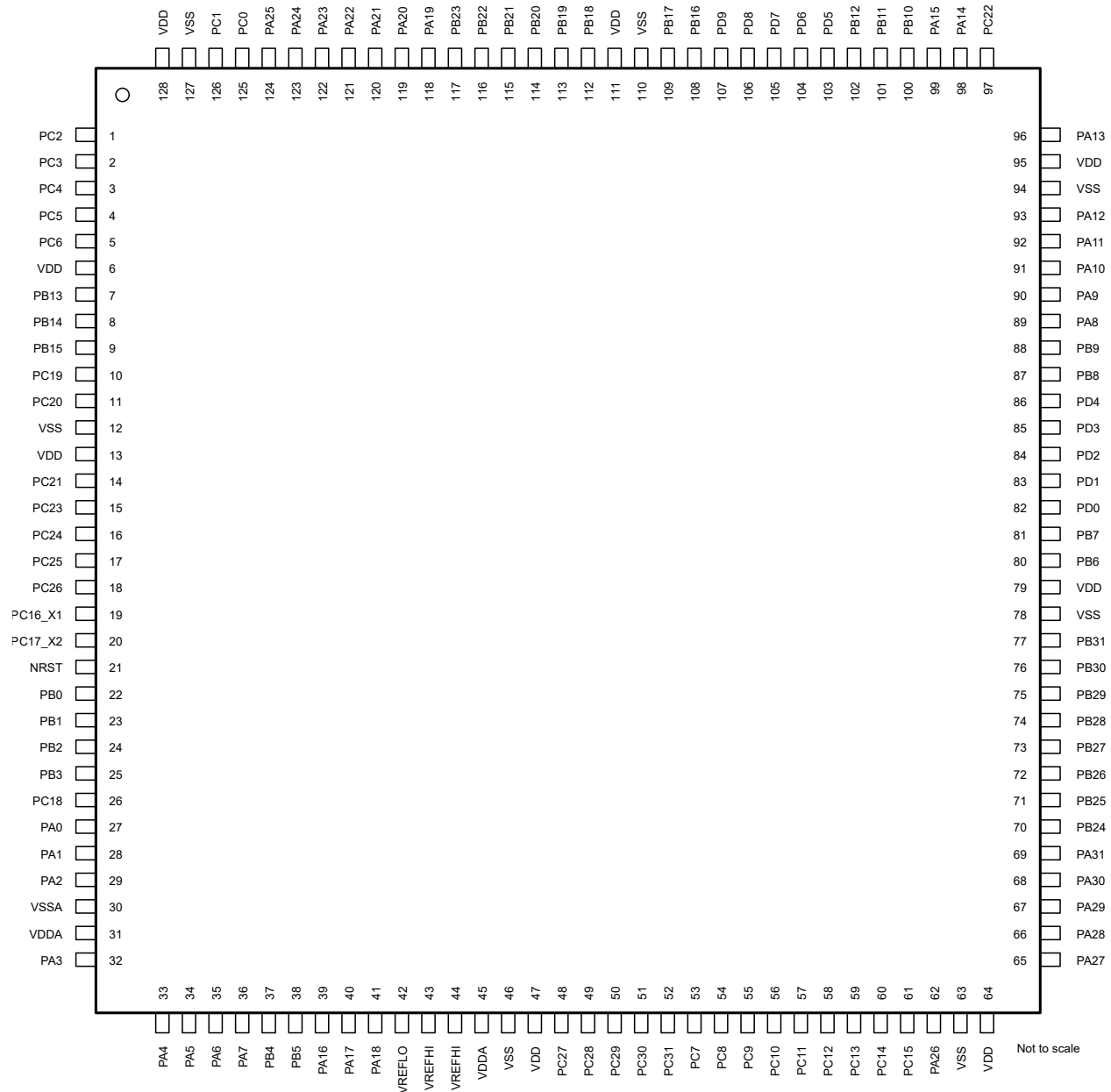


Figure 5-1. LQFP128 (PDT) Package



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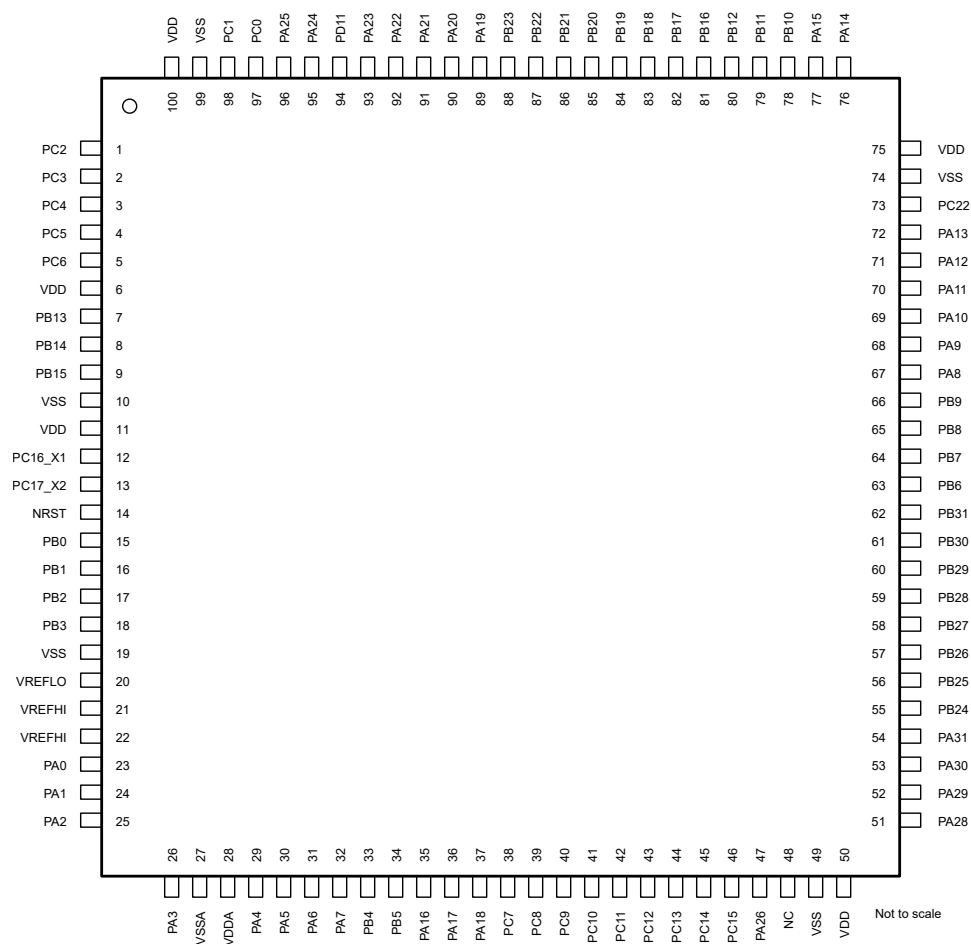


Figure 5-3. LQFP100_H (PZ) Package

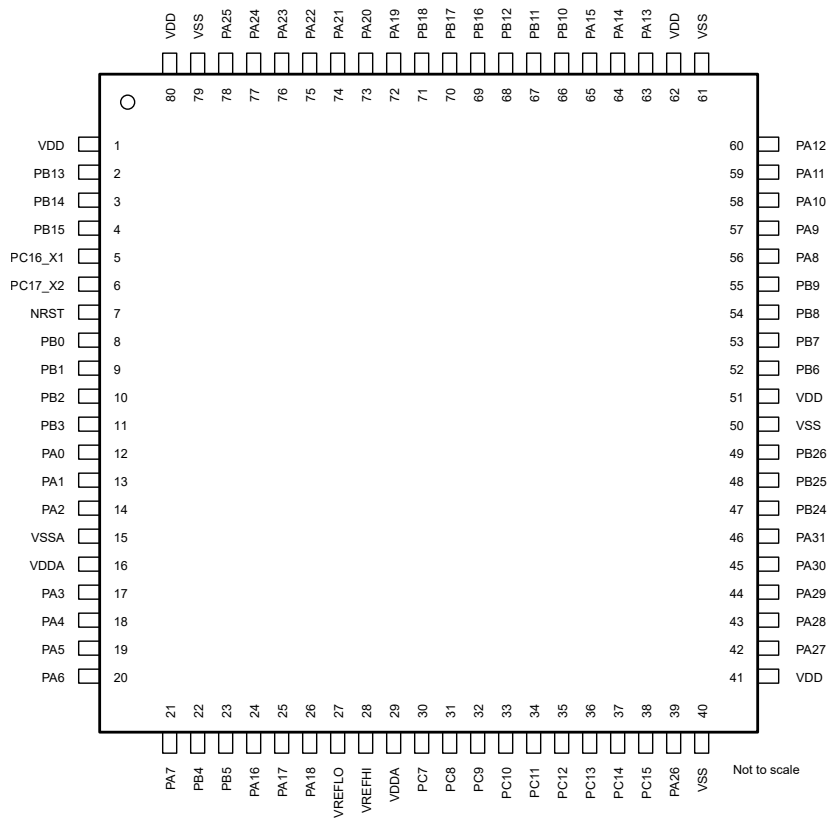


Figure 5-4. LQFP80 (PN) Package

ADVANCE INFORMATION

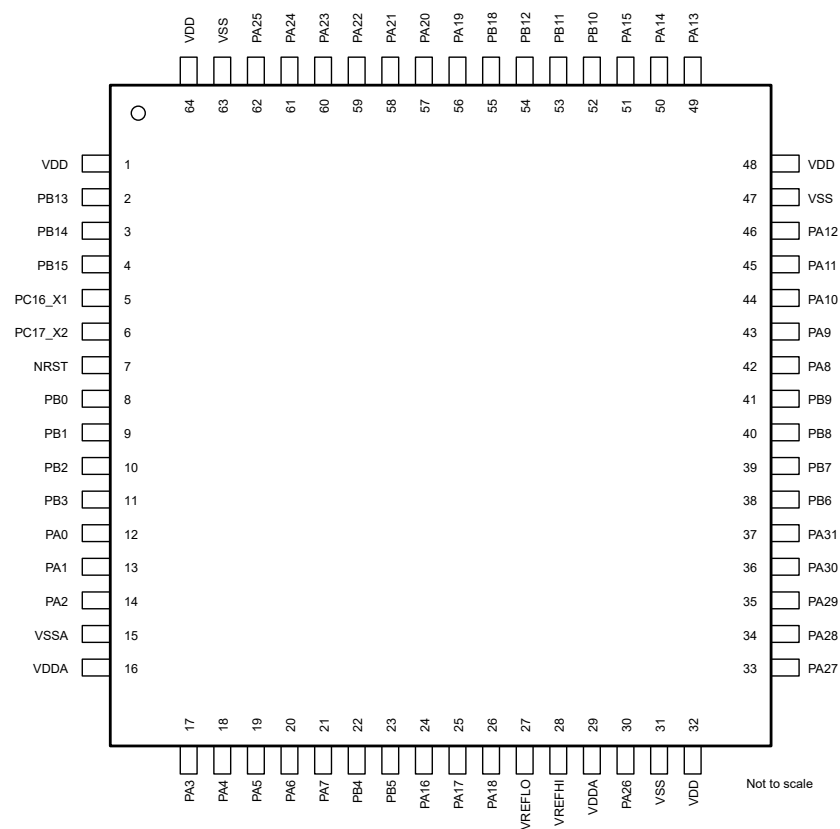


Figure 5-5. LQFP64_G (PM) Package

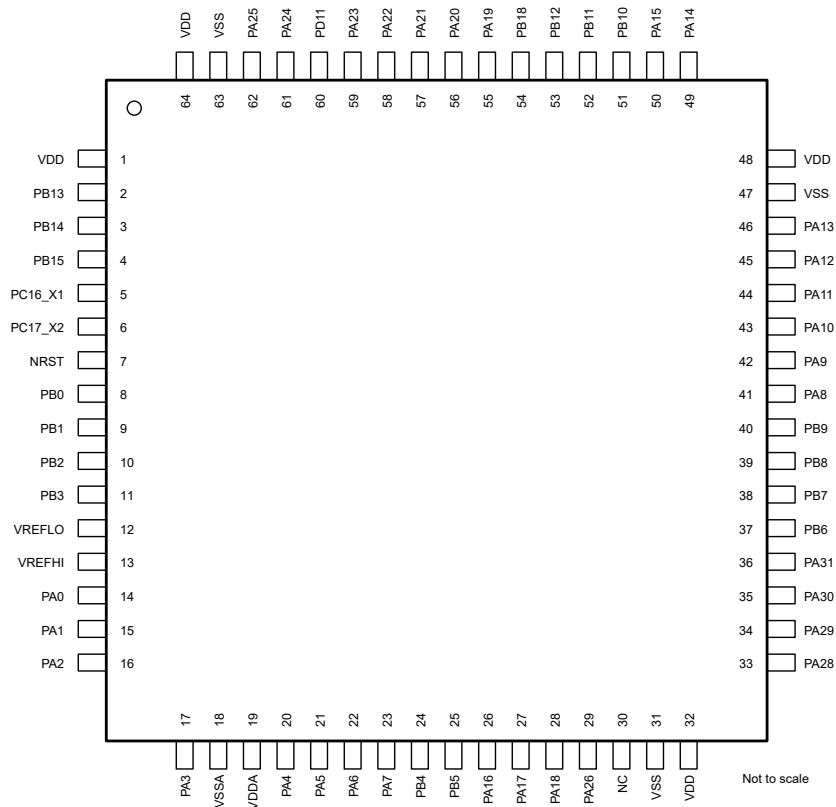


Figure 5-6. LQFP64_H (PM) Package

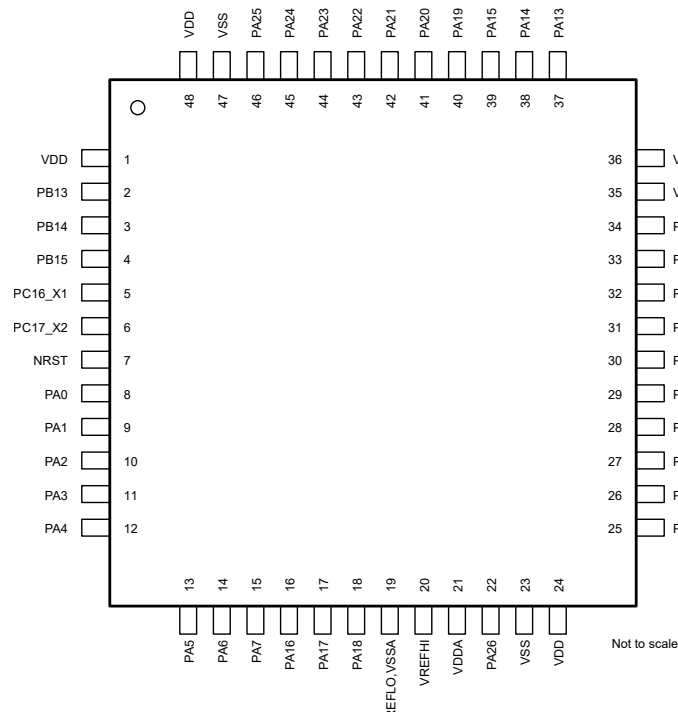


Figure 5-7. LQFP48 (PT) Package

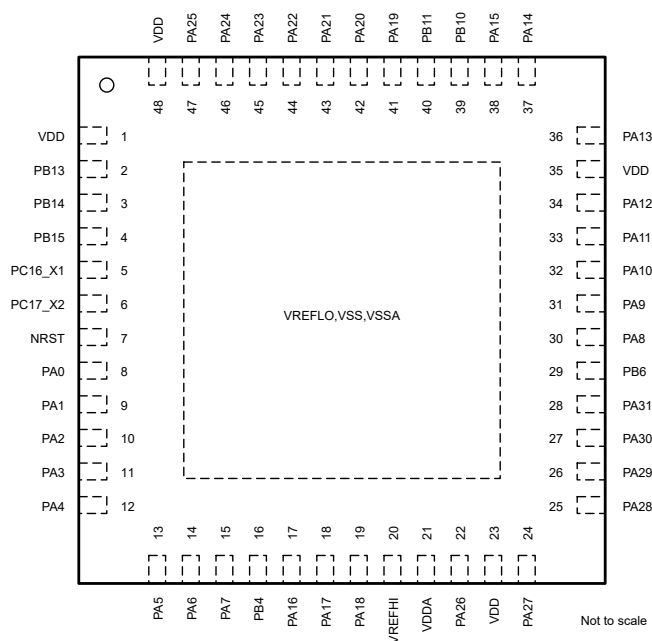


Figure 5-8. QFN48 (RGZ) Package

5.2 Pin Attributes

5.2.1 Pin Attributes Header List

The following list describes the contents of each column in the *Pin Attributes* table:

1. **Ball Number:** Ball numbers assigned to each terminal of the Ball Grid Array package.
2. **Ball Name:** Ball name assigned to each terminal of the Ball Grid Array package (this name is typically taken from the primary MUXMODE 0 signal function).
3. **Signal Name:** Signal name of all dedicated and pin multiplexed signal functions associated with a ball.

Note

The *Pin Attributes* table, defines the SoC pin multiplexed signal function implemented at the pin and **does not** define secondary multiplexing of signal functions implemented in device subsystems. Secondary multiplexing of signal functions are not described in this table. For more information on secondary multiplexed signal functions, see the respective peripheral chapter of the device TRM.

4. **Mux Mode:** The MUXMODE value associated with each pin multiplexed signal function:
 - MUXMODE 0 is the primary pin multiplexed signal function. However, the primary pin multiplexed signal function is not necessarily the default pin multiplexed signal function.
 - MUXMODE values 1 through 15 are possible for pin multiplexed signal functions. However, not all MUXMODE values have been implemented. The only valid MUXMODE values are those defined as pin multiplexed signal functions within the Pin Attributes table. Only defined valid values of MUXMODE can be used.
 - An empty box or "-" means Not Applicable.

Note

- The value found in the MUX MODE AFTER RESET column defines the default pin multiplexed signal function selected when PORz is deasserted.
 - Configuring two pins to the same pin multiplexed signal function can yield unexpected results and is not supported. This can be prevented with proper software configuration.
 - Configuring a pad to an undefined multiplexing mode results in undefined behavior and must be avoided.
-

5. **Pad Configuration Register Name:** This is the name of the device pad/pin configuration register.
6. **Pad Configuration Register Address:** This is the memory address of the device pad/pin configuration register.
7. **Pad Configuration Register Default Value:** This is the default value of the register device pad/pin configuration register after PORz is deasserted.

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
		48			30			NC	0	NC
21	14	14	7	7	7	7	7	NRST IOMUX_PD10_NRST 0x400C_C1A8	0	NRST
27	20	23	12	12	14	8	8	PA0 IOMUX_PA0 0x400C_C000	A	ANALOG_AIN6
									0	Disconnected
									AMUX0	A0_1
									AMUX1	A1_1
									1	GPIO00
									AMUX2	CMP0_HN0
									2	MCPWM4_1A
									AMUX3	CMP2_HP0_LP0
									3	MCPWM3_1A
									4	TIMG12_0_CCP0
									5	TIMG4_0_CCP0
									6	UC5_RX_SCL
									7	UC4_TX_SDA_PICO
									8	UC1_CTS_CS0
									9	UC1_TX_SDA_PICO
									10	MCPWM4_2A
									11	UC2_RX_SCL
									13	UC0_CTS_CS0
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
28	21	24	13	13	15	9	9	PA1 IOMUX_PA1 0x400C_C004	A	ANALOG_AIN7
									AMUX0	A0_2
									0	Disconnected
									1	GPIO01
									AMUX1	A1_2
									AMUX2	CMP0_HP1_LP1
									2	MCPWM4_1B
									AMUX3	PGA0_P1
									3	MCPWM3_2A
									AMUX4	PGA1_M0
									4	TIMG12_0_CCP1
									AMUX5	PGA2_P2
									5	TIMG4_0_CCP1
									6	UC5_TX_SDA
									7	UC4_RX_SCL_SCLK
									8	UC1_RTS_POCI
									9	UC1_RX_SCL_SCLK
29	22	25	14	14	16	10	10	PA2 IOMUX_PA2 0x400C_C008	AMUX0	A0_3
									0	Disconnected
									A	ANALOG_AIN8
									1	GPIO02
									AMUX1	A2_25
									AMUX2	CMP1_HN0
									2	MCPWM4_2A
									3	MCPWM3_1B
									AMUX3	PGA0_OUT
									4	MCPWM3_3A
									5	MCPWM4_3A
									6	MCPWM4_2B
									8	UC1_TX_SDA_PICO
									10	MCPWM3_1A
									13	UC0_TX_SDA_PICO
									16	OUTPUTXBAR5

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
32	25	26	17	17	17	11	11	PA3 IOMUX_PA3 0x400C_C00C	0	Disconnected
									AMUX0	A0_4
									A	ANALOG_AIN9
									AMUX1	A2_21
									1	GPIO03
									AMUX2	CMP1_HP0_LP0
									2	SYSCTL_HFCLKIN
									3	MCPWM3_2B
									AMUX3	PGA0_M0
									4	TIMG4_0_CCP0
									AMUX4	PGA0_P2
									AMUX5	PGA2_M0
									5	TIMG12_0_CCP0
									6	MCPWM3_3B
									7	MCPWM4_2B
									8	UC1_RX_SCL_SCLK
33	26	29	18	18	20	12	12	PA4 IOMUX_PA4 0x400C_C010	10	MCPWM3_2A
									13	UC0_RX_SCL_SCLK
									16	OUTPUTXBAR6
									A	ANALOG_AIN10
									0	Disconnected
									AMUX0	A1_17
									AMUX1	A2_18
									1	GPIO04
									2	SYSCTL_XCLKOUT
									AMUX2	CMP2_DACL
									AMUX3	CMP0_HN1
									3	MCPWM4_3B
									AMUX4	INTERNAL_TESTANA0
									4	TIMG4_0_CCP1
									5	TIMG12_0_CCP1
									6	UC0_RTS_POCI
									7	UC2_RTS
									9	UC3_RTS_POCI
									11	UC5_RTS
									16	OUTPUTXBAR6

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
34	27	30	19	19	21	13	13	PA5 IOMUX_PA5 0x400C_C014	0	Disconnected
									AMUX0	A1_13
									A	ANALOG_AIN11
									AMUX1	A2_19
									1	GPIO05
									2	MCPWM4_1A
									AMUX2	CMP1_HN1
									AMUX3	PGA1_M1
									3	MCPWM2_1B
									4	MCPWM3_1B
									AMUX4	INTERNAL_TESTANA1
									6	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
35	28	31	20	20	22	14	14	PA6 IOMUX_PA6 0x400C_C018	16	OUTPUTXBAR7
									0	Disconnected
									AMUX0	A0_17
									A	ANALOG_AIN12
									AMUX1	A1_3
									1	GPIO06
									AMUX2	A2_26
									2	MCPWM3_1A
									3	MCPWM3_3A
									AMUX3	CMP3_DACL
									4	MCPWM4_2A
									AMUX4	PGA1_OUT
									AMUX5	ADCCAL_ADCINCAL0
									6	UC0_CTS_CS0
									9	UC3_CTS_CS0
									11	UC3_RTS_POCI
									13	UC0_RTS_POCI
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
36	29	32	21	21	23	15	15	PA7 IOMUX_PA7 0x400C_C01C	A	ANALOG_AIN13
									0	Disconnected
									AMUX0	A1_4
									AMUX1	A2_22
									1	GPIO07
									AMUX2	CMP1_HP1_LP1
									2	MCPWM3_3A
									AMUX3	PGA0_P3
									3	MCPWM3_3B
									AMUX4	PGA1_P1
									4	MCPWM4_1A
									5	MCPWM1_1B
									6	UC0_TX_SDA_PICO
									7	MCPWM0_1B
									8	MCPWM4_1B
									9	UC3_TX_SDA_PICO
89	69	67	56	42	41	30	30	PA8 IOMUX_PA8 0x400C_C020	10	MCPWM4_3A
									11	MCPWM4_2B
									16	OUTPUTXBAR1
									A	ANALOG_AIN42
									AMUX0	A1_18
									0	Disconnected
									1	GPIO08
									3	UC0_RX_SCL_SCLK
									5	UC1_TX_SDA_PICO
									6	MCPWM4_1A
									7	MCPWM0_1A
									9	UC3_RX_SCL_SCLK
									10	UC4_TX_SDA_PICO
									12	MCAN0_TX
									14	MCPWM3_1A
									15	MCPWM4_2A
									16	OUTPUTXBAR3

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Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
90	70	68	57	43	42	31	31	PA9 IOMUX_PA9 0x400C_C024	A	ANALOG_AIN43
									AMUX0	A1_19
									0	Disconnected
									1	GPIO09
									5	UC1_RX_SCL_SCLK
									6	UC4_RX_SCL_SCLK
									7	MCPWM0_2A
									8	UC0_TX_SDA_PICO
									9	UC5_RTS
									10	UC4_TX_SDA_PICO
									11	MCPWM4_2A
									12	UC2_RTS
									13	MCPWM3_3A
									14	MCPWM3_1B
									15	MCPWM4_2B
									16	OUTPUTXBAR4
91	71	69	58	44	43	32	32	PA10 IOMUX_PA10 0x400C_C028	0	Disconnected
									1	GPIO10
									4	MCPWM4_3A
									5	UC4_TX_SDA_PICO
									6	UC1_TX_SDA_PICO
									7	MCPWM0_3A
									8	UC0_RX_SCL_SCLK
									9	UC5_RX_SCL
									10	UC4_RX_SCL_SCLK
									11	MCPWM4_2B
									12	UC2_RX_SCL
									13	MCPWM3_3B
									14	MCPWM3_2A
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
92	72	70	59	45	44	33	33	PA11 IOMUX_PA11 0x400C_C02C	0	Disconnected
									1	GPIO11
									2	MCPWM4_2A
									3	UC3_CTS_CS0
									4	UC2_TX_SDA
									5	UC4_CTS_CS0
									6	UC1_CTS_CS0
									7	MCPWM0_1B
									8	UC0_CTS_CS0
									9	UC5_TX_SDA
									10	MCAN0_RX
									11	MCPWM2_2A
									12	MCPWM0_1A
									13	MCPWM4_1B
									14	MCPWM3_2B
									15	MCPWM4_1A
									16	OUTPUTXBAR5
93	73	71	60	46	45	34	34	PA12 IOMUX_PA12 0x400C_C030	0	Disconnected
									1	GPIO12
									2	MCPWM3_1A
									3	MCPWM4_2A
									6	MCPWM3_2B
									7	MCPWM0_2B
									8	UC0_RTS_POCI
									9	UC3_RTS_POCI
									10	MCAN0_TX
									11	MCPWM2_2B
									12	MCPWM0_1B
									13	MCPWM4_2B
									14	MCPWM3_3B
									15	MCPWM4_1B
									16	OUTPUTXBAR6

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Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
96	76	72	63	49	46	37	36	PA13 IOMUX_PA13 0x400C_C034	0	Disconnected
									1	GPIO13
									2	DEBUG_TMS_SWDIO
									3	MCPWM3_1B
									4	MCPWM4_2B
									5	UC0_RX_SCL_SCLK
									6	UC3_RX_SCL_SCLK
									8	UC0_CTS_CS0
									9	SYSCTL_FCC_IN
									10	UC3_CTS_CS0
									11	MCPWM2_3A
									12	MCPWM3_3A
									13	MCPWM4_3A
									16	OUTPUTXBAR7
98	77	76	64	50	49	38	37	PA14 IOMUX_PA14 0x400C_C038	0	Disconnected
									1	GPIO14
									2	DEBUG_JTCK_SWCLK
									5	UC0_TX_SDA_PICO
									6	MCPWM1_2A
									7	MCPWM3_3A
									8	UC1_TX_SDA_PICO
									9	UC2_CTS
									10	UC5_CTS
									16	OUTPUTXBAR8
99	78	77	65	51	50	39	38	PA15 IOMUX_PA15 0x400C_C03C	0	Disconnected
									1	GPIO15
									2	DEBUG_JTDI
									3	MCPWM3_1A
									4	MCPWM1_1A
									5	UC0_RX_SCL_SCLK
									6	UC0_RTS_POCI
									7	UC3_RTS_POCI
									8	UC1_RX_SCL_SCLK
									9	UC2_RTS
									10	UC5_RTS
									11	MCPWM4_2A
									12	MCAN0_RX
									16	OUTPUTXBAR1

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
39	32	35	24	24	26	16	17	PA16 IOMUX_PA16 0x400C_C040	A	ANALOG_AIN16
									0	Disconnected
									AMUX0	A0_15
									AMUX1	A2_12
									1	GPIO16
									AMUX2	CMP3_HP1_LP1
									AMUX3	PGA1_P2
									3	MCPWM4_1A
									4	MCPWM4_3B
									AMUX4	PGA2_P3
									5	MCPWM1_2B
									6	MCPWM4_2B
									7	MCPWM0_2B
									8	MCPWM3_3B
									9	SYSCTL_FCC_IN
									16	OUTPUTXBAR1
40	33	36	25	25	27	17	18	PA17 IOMUX_PA17 0x400C_C044	A	ANALOG_AIN17
									AMUX0	A0_12
									0	Disconnected
									1	GPIO17
									AMUX1	A2_1
									AMUX2	CMP0_HP0_LP0
									AMUX3	PGA1_M3
									3	MCPWM4_1B
									4	MCPWM2_1B
									AMUX4	PGA2_OUT
									5	MCPWM1_3B
									6	MCPWM4_3B
									7	MCPWM0_3B
									8	MCPWM3_1B
									11	UC3_RTS_POCI
									13	UC0_RTS_POCI
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
41	34	37	26	26	28	18	19	PA18 IOMUX_PA18 0x400C_C048	A	ANALOG_AIN18
									AMUX0	A1_12
									0	Disconnected
									1	GPIO18
									AMUX1	CMP3_HN0_LN0
									AMUX2	PGA2_M1
									3	MCPWM3_1A
									4	MCPWM2_1A
									5	MCPWM4_2A
118	90	89	72	56	55	40	41	PA19 IOMUX_PA19 0x400C_C04C	16	OUTPUTXBAR3
									0	Disconnected
									1	GPIO19
									2	DEBUG_JTDO_SWO
									3	MCPWM4_1B
									4	MCPWM4_2B
									5	MCPWM1_1B
									6	UC0_RX_SCL_SCLK
									7	UC3_RX_SCL_SCLK
									8	UC1_TX_SDA_PICO
									9	UC3_TX_SDA_PICO
									12	MCAN0_RX
119	91	90	73	57	56	41	42	PA20 IOMUX_PA20 0x400C_C050	16	OUTPUTXBAR2
									0	Disconnected
									1	GPIO20
									2	MCPWM4_2A
									3	MCPWM3_1A
									4	MCPWM4_3A
									5	MCPWM1_2B
									6	UC0_CTS_CS0
									7	UC3_CTS_CS0
									8	UC1_RX_SCL_SCLK
									9	UC3_RTS_POCI
									10	UC4_RX_SCL_SCLK
									11	UC0_RTS_POCI
									12	MCAN0_TX
									13	MCPWM4_3B
									16	OUTPUTXBAR3

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
120	92	91	74	58	57	42	43	PA21 IOMUX_PA21 0x400C_C054	0	Disconnected
									1	GPIO21
									3	MCPWM4_3B
									4	MCPWM1_3B
									5	MCPWM4_1B
									6	UC0_TX_SDA_PICO
									7	UC3_TX_SDA_PICO
									8	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
									10	MCAN0_RX
									11	MCPWM3_3A
									12	MCPWM4_3A
									14	UC0_CTS_CS0
									15	UC3_CTS_CS0
									16	OUTPUTXBAR4
121	93	92	75	59	58	43	44	PA22 IOMUX_PA22 0x400C_C058	0	Disconnected
									1	GPIO22
									2	MCPWM3_1B
									3	MCPWM2_2A
									4	UC2_TX_SDA
									5	MCPWM4_2B
									6	MCPWM1_1A
									7	UC5_TX_SDA
									8	UC0_TX_SDA_PICO
									9	UC3_TX_SDA_PICO
									10	MCAN0_TX
									11	MCPWM3_3B
									12	MCPWM4_3B
									13	EPI0_S30
									14	MCPWM4_2A
									15	MCPWM3_2A
									16	OUTPUTXBAR5

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
122	94	93	76	60	59	44	45	PA23 IOMUX_PA23 0x400C_C05C	0	Disconnected
									1	GPIO23
									2	MCPWM3_3B
									3	MCPWM2_2B
									4	UC2_RX_SCL
									5	UC0_TX_SDA_PICO
									6	MCPWM4_3B
									7	UC5_RX_SCL
									8	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
									10	UC3_TX_SDA_PICO
									11	MCPWM4_1B
									12	MCPWM3_2B
									13	MCPWM4_2B
									14	UC4_CTS_CS0
									15	UC1_CTS_CS0
									16	OUTPUTXBAR6
123	95	95	77	61	61	45	46	PA24 IOMUX_PA24 0x400C_C060	0	Disconnected
									1	GPIO24
									2	MCPWM3_1A
									3	MCPWM2_3A
									4	MCPWM4_2A
									5	UC0_RX_SCL_SCLK
									6	UC3_RX_SCL_SCLK
									7	MCPWM3_3A
									8	UC0_TX_SDA_PICO
									9	UC3_TX_SDA_PICO
									10	MCAN0_RX
									11	MCPWM1_2A
									12	MCPWM4_3A
									16	OUTPUTXBAR7

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Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
124	96	96	78	62	62	46	47	PA25 IOMUX_PA25 0x400C_C064	0	Disconnected
									1	GPIO25
									2	MCPWM3_3A
									3	MCPWM2_3B
									4	MCPWM4_3A
									5	UC0_TX_SDA_PICO
									6	UC3_TX_SDA_PICO
									7	MCPWM3_3B
									8	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
									10	MCAN0_TX
									11	MCPWM1_3A
									12	MCPWM4_3B
									13	MCPWM0_3B
									14	MCPWM4_1A
									16	OUTPUTXBAR7
62	47	47	39	30	29	22	22	PA26 IOMUX_PA26 0x400C_C068	AMUX0	A2_17
									0	Disconnected
									A	ANALOG_AIN28
									1	GPIO26
									AMUX1	CMP0_LN1
									AMUX2	PGA2_M2
									2	MCPWM4_2A
									3	TIMG4_0_CCP0
									AMUX3	PGA0_M2
									4	TIMG12_0_CCP0
									5	MCPWM3_3A
									6	MCPWM4_3A
									8	UC0_RX_SCL_SCLK
									9	UC0_TX_SDA_PICO
									10	UC3_TX_SDA_PICO
									11	UC3_RX_SCL_SCLK
									13	EPI0_S33
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
65	50		42	33		25	24	PA27 IOMUX_PA27 0x400C_C06C	AMUX0	A0_14
									0	Disconnected
									A	ANALOG_AIN29
									1	GPIO27
									AMUX1	A1_14
									AMUX2	CMP1_HP2_LP2
									2	MCPWM4_2B
									3	TIMG4_0_CCP1
									AMUX3	PGA0_P4
									4	TIMG12_0_CCP1
									AMUX4	PGA2_P0
									5	MCPWM3_3B
									7	SYSCTL_XCLKOUT
									8	UC0_RX_SCL_SCLK
									9	UC0_TX_SDA_PICO
									10	UC3_TX_SDA_PICO
									11	UC3_RX_SCL_SCLK
									16	OUTPUTXBAR3
66	51	51	43	34	33	26	25	PA28 IOMUX_PA28 0x400C_C070	0	Disconnected
									AMUX0	A0_11
									A	ANALOG_AIN30
									AMUX1	A2_30
									1	GPIO28
									AMUX2	CMP2_LN1
									2	TIMG12_0_CCP0
									3	TIMG4_0_CCP0
									AMUX3	PGA1_P3
									4	MCAN0_RX
									AMUX4	PGA0_P7
									6	UC1_RTS_POCI
									8	UC0_CTS_CS0
									9	UC0_RTS_POCI
									10	UC4_RTS_POCI
									11	UC3_CTS_CS0
									13	EPI0_S34
									14	MCPWM3_3A
									15	MCPWM4_1A
									16	OUTPUTXBAR4

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
67	52	52	44	35	34	27	26	PA29 IOMUX_PA29 0x400C_C074	AMUX0	A2_5
									0	Disconnected
									A	ANALOG_AIN31
									1	GPIO29
									AMUX1	CMP0_HP2_LP2
									AMUX2	PGA0_P5
									2	TIMG12_0_CCP1
									3	TIMG4_0_CCP1
									AMUX3	PGA1_P4
									AMUX4	PGA2_P4
									4	MCAN0_TX
									6	MCPWM4_1B
									7	MCPWM0_1B
									8	SYSCTL_FCC_IN
									9	UC0_CTS_CS0
									11	UC3_CTS_CS0
									13	EPI0_S35
									14	MCPWM3_3B
									15	MCPWM4_3B
									16	OUTPUTXBAR5

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
68	53	53	45	36	35	28	27	PA30 IOMUX_PA30 0x400C_C078	0	Disconnected
									AMUX0	A0_5
									A	ANALOG_AIN32
									AMUX1	A2_27
									1	GPIO30
									2	MCPWM3_1A
									AMUX2	CMP2_HP3_LP3
									3	MCPWM4_2A
									AMUX3	PGA1_P5
									4	MCPWM3_3B
									AMUX4	PGA2_P5
									5	MCPWM4_2B
									6	UC1_TX_SDA_PICO
									7	MCPWM0_2B
									8	UC0_RTS_POCI
									10	UC4_RTS_POCI
69	54	54	46	37	36	29	28	PA31 IOMUX_PA31 0x400C_C07C	11	UC4_TX_SDA_PICO
									14	MCPWM4_1A
									16	OUTPUTXBAR6
									0	Disconnected
									AMUX0	A1_15
									A	ANALOG_AIN33
									AMUX1	A2_28
									1	GPIO31
									2	MCPWM3_2A
									AMUX2	CMP1_LN1
									3	MCPWM3_1B
									AMUX3	PGA2_M3
									4	MCPWM4_3B
									5	MCPWM0_3B
									6	UC1_CTS_CS0
									7	MCPWM4_2B
									11	UC4_CTS_CS0
									14	MCPWM4_1B
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
22	15	15	8	8	8			PB0 IOMUX_PB0 0x400C_C080	0	Disconnected
									AMUX0	A0_6
									A	ANALOG_AIN2
									AMUX1	A1_6
									1	GPIO32
									AMUX2	CMP2_HN1
									3	MCPWM0_1A
									4	MCPWM4_1A
									9	UC0_RX_SCL_SCLK
									11	UC3_RX_SCL_SCLK
23	16	16	9	9	9			PB1 IOMUX_PB1 0x400C_C084	16	OUTPUTXBAR5
									A	ANALOG_AIN3
									0	Disconnected
									AMUX0	A0_7
									AMUX1	A1_7
									1	GPIO33
									AMUX2	CMP2_HP1_LP1
									3	MCPWM0_2A
									4	MCPWM4_2A
									5	MCPWM3_3A
24	17	17	10	10	10			PB2 IOMUX_PB2 0x400C_C088	9	UC0_TX_SDA_PICO
									11	UC3_TX_SDA_PICO
									16	OUTPUTXBAR6
									A	ANALOG_AIN4
									0	Disconnected
									AMUX0	A0_8
									AMUX1	A1_8
									1	GPIO34
									3	MCPWM0_3A
									4	MCPWM4_3A
									6	MCPWM4_2A
									7	MCPWM2_2A
									8	MCPWM3_2A
									16	OUTPUTXBAR7

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
25	18	18	11	11	11			PB3 IOMUX_PB3 0x400C_C08C	A	ANALOG_AIN5
									AMUX0	A0_9
									0	Disconnected
									1	GPIO35
									AMUX1	A1_9
									AMUX2	PGA2_P1
									3	MCPWM0_1A
									AMUX3	PGA0_P0
									AMUX4	PGA1_P0
									4	MCPWM4_1A
									16	OUTPUTXBAR8
37	30	33	22	22	24		16	PB4 IOMUX_PB4 0x400C_C090	A	ANALOG_AIN14
									AMUX0	A1_5
									0	Disconnected
									1	GPIO36
									AMUX1	A2_23
									5	UC1_RX_SCL_SCLK
									8	UC0_TX_SDA_PICO
									9	UC3_TX_SDA_PICO
									10	MCAN0_RX
									11	UC4_RX_SCL_SCLK
									16	OUTPUTXBAR2
38	31	34	23	23	25			PB5 IOMUX_PB5 0x400C_C094	AMUX0	A1_11
									0	Disconnected
									A	ANALOG_AIN15
									1	GPIO37
									AMUX1	A2_24
									AMUX2	PGA0_M1
									AMUX3	PGA1_M2
									6	MCPWM4_1B
									7	MCPWM0_1B
									8	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
									10	MCAN0_TX
									16	OUTPUTXBAR3

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
80	65	63	52	38	37		29	PB6 IOMUX_PB6 0x400C_C098	0	Disconnected
									1	GPIO38
									3	MCPWM3_3A
									5	MCPWM1_1A
									6	MCPWM4_2A
									8	UC5_RX_SCL
									9	UC2_RX_SCL
									14	MCPWM4_3B
									16	OUTPUTXBAR3
81	66	64	53	39	38			PB7 IOMUX_PB7 0x400C_C09C	0	Disconnected
									1	GPIO39
									3	MCPWM3_3B
									4	MCPWM4_3A
									5	MCPWM1_2A
									8	UC5_TX_SDA
									9	UC2_TX_SDA
									16	OUTPUTXBAR4
87	67	65	54	40	39			PB8 IOMUX_PB8 0x400C_C0A0	0	Disconnected
									1	GPIO40
									2	TRACE_DATA1
									3	MCPWM3_1A
									4	MCPWM4_2A
									5	MCPWM1_3A
									6	UC2_CTS
									7	MCPWM2_3A
									8	MCPWM3_3A
									9	UC0_RX_SCL_SCLK
									10	UC3_RX_SCL_SCLK
									11	UC5_RTS
									13	MCPWM4_3A
									14	MCPWM4_3B
									15	MCPWM3_3B
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
88	68	66	55	41	40			PB9 IOMUX_PB9 0x400C_C0A4	0	Disconnected
									1	GPIO41
									3	MCPWM3_1B
									4	MCPWM4_2B
									5	MCPWM1_1A
									6	UC2_RTS
									7	MCPWM4_2A
									8	MCPWM3_3B
									9	UC0_TX_SDA_PICO
									10	UC3_TX_SDA_PICO
									11	UC5_CTS
									16	OUTPUTXBAR3
100	79	78	66	52	51		39	PB10 IOMUX_PB10 0x400C_C0A8	0	Disconnected
									1	GPIO42
									4	UC5_TX_SDA
									5	MCPWM1_1B
									6	UC2_TX_SDA
									7	UC3_RX_SCL_SCLK
									8	UC0_TX_SDA_PICO
									9	UC0_RX_SCL_SCLK
									10	UC3_TX_SDA_PICO
									11	MCPWM3_2B
									16	OUTPUTXBAR2
101	80	79	67	53	52		40	PB11 IOMUX_PB11 0x400C_C0AC	0	Disconnected
									1	GPIO43
									2	TRACE_CLK
									4	UC5_RX_SCL
									5	MCPWM1_2B
									6	UC2_RX_SCL
									7	UC3_CTS_CS0
									8	UC0_RX_SCL_SCLK
									9	UC0_TX_SDA_PICO
									10	UC0_CTS_CS0
									11	UC3_RX_SCL_SCLK
									13	UC3_TX_SDA_PICO
									16	OUTPUTXBAR3

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Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
102	81	80	68	54	53			PB12 IOMUX_PB12 0x400C_C0B0	0	Disconnected
									1	GPIO44
									2	TRACE_DATA3
									3	MCPWM3_1B
									4	MCPWM4_2B
									5	MCPWM1_3B
									6	UC3_TX_SDA_PICO
									7	UC3_RX_SCL_SCLK
									8	UC0_RX_SCL_SCLK
									9	MCPWM4_1B
									11	UC0_TX_SDA_PICO
									13	EPI0_S27
									16	OUTPUTXBAR4
7	7	7	2	2	2	2	2	PB13 IOMUX_PB13 0x400C_C0B4	0	Disconnected
									1	GPIO45
									2	SYSCTL_XCLKOUT
									5	MCPWM0_1B
									6	MCPWM3_1B
									7	MCPWM1_1B
									8	SYSCTL_FCC_IN
									9	MCPWM4_2B
									16	OUTPUTXBAR6
8	8	8	3	3	3	3	3	PB14 IOMUX_PB14 0x400C_C0B8	0	Disconnected
									1	GPIO46
									2	SYSCTL_XCLKOUT
									8	UC0_TX_SDA_PICO
									10	MCAN0_RX
									11	UC3_TX_SDA_PICO
9	9	9	4	4	4	4	4	PB15 IOMUX_PB15 0x400C_C0BC	16	OUTPUTXBAR1
									0	Disconnected
									1	GPIO47
									8	UC0_RX_SCL_SCLK
									10	MCAN0_TX
									11	UC3_RX_SCL_SCLK
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
108	82	81	69					PB16 IOMUX_PB16 0x400C_C0C0	0	Disconnected
									1	GPIO48
									4	UC5_TX_SDA
									7	MCPWM1_1B
									8	MCPWM3_2B
									10	MCAN0_TX
									11	UC2_TX_SDA
									13	EPI0_S2
									16	OUTPUTXBAR2
109	83	82	70					PB17 IOMUX_PB17 0x400C_C0C4	0	Disconnected
									1	GPIO49
									4	UC5_RX_SCL
									5	MCPWM1_1A
									6	MCPWM3_2A
									10	MCAN0_RX
									11	UC2_RX_SCL
									13	EPI0_S3
112	84	83	71	55	54			PB18 IOMUX_PB18 0x400C_C0C8	16	OUTPUTXBAR3
									0	Disconnected
									1	GPIO50
									2	TRACE_DATA2
									4	UC5_CTS
									6	UC3_RX_SCL_SCLK
									7	UC3_TX_SDA_PICO
									8	UC0_RX_SCL_SCLK
									9	UC0_TX_SDA_PICO
									11	UC2_CTS
113	85	84						PB19 IOMUX_PB19 0x400C_C0CC	13	EPI0_S31
									16	OUTPUTXBAR4
									0	Disconnected
									1	GPIO51
									3	MCPWM4_1A
									4	UC5_RTS
									8	UC1_CTS_CS0
									10	UC4_CTS_CS0
									11	UC2_RTS
									13	EPI0_S28
									16	OUTPUTXBAR5

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
114	86	85						PB20 IOMUX_PB20 0x400C_C0D0	0	Disconnected
									1	GPIO52
									3	MCPWM4_1B
									8	UC1_RTS_POCI
									10	UC4_RTS_POCI
									13	EPI0_S29
									16	OUTPUTXBAR6
115	87	86						PB21 IOMUX_PB21 0x400C_C0D4	0	Disconnected
									1	GPIO53
									8	UC1_TX_SDA_PICO
									10	UC4_TX_SDA_PICO
									13	EPI0_S32
116	88	87						PB22 IOMUX_PB22 0x400C_C0D8	16	OUTPUTXBAR7
									0	Disconnected
									1	GPIO54
									3	MCPWM4_2B
									4	MCPWM3_3B
									5	MCPWM4_3B
									8	UC1_RX_SCL_SCLK
									10	UC4_RX_SCL_SCLK
									13	EPI0_S26
117	89	88						PB23 IOMUX_PB23 0x400C_C0DC	16	OUTPUTXBAR8
									0	Disconnected
									1	GPIO55
									3	MCPWM4_2A
									4	MCPWM3_3A
									5	MCPWM4_3A
70	55	55	47					PB24 IOMUX_PB24 0x400C_C0E0	16	OUTPUTXBAR1
									A	ANALOG_AIN34
									0	Disconnected
									AMUX0	A0_21
									AMUX1	A1_21
									1	GPIO56
									AMUX2	PGA0_M3
									9	UC5_RX_SCL
									11	UC2_RX_SCL
									13	EPI0_S13
									16	OUTPUTXBAR3

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
71	56	56	48					PB25 IOMUX_PB25 0x400C_C0E4	A	ANALOG_AIN35
									0	Disconnected
									AMUX0	A0_22
									AMUX1	A1_22
									1	GPIO57
									AMUX2	PGA1_P6
									AMUX3	PGA2_P7
									9	UC5_TX_SDA
									11	UC2_TX_SDA
									13	EPIO_S14
72	57	57	49					PB26 IOMUX_PB26 0x400C_C0E8	16	OUTPUTXBAR4
									A	ANALOG_AIN36
									0	Disconnected
									AMUX0	A0_26
									AMUX1	A1_26
									1	GPIO58
									AMUX2	A2_7
									2	TIMG4_0_CCP0
									AMUX3	CMP1_LN0
									13	EPIO_S15
73	58	58						PB27 IOMUX_PB27 0x400C_C0EC	16	OUTPUTXBAR5
									0	Disconnected
									AMUX0	A0_27
									A	ANALOG_AIN37
									AMUX1	A1_27
									1	GPIO59
									AMUX2	A2_8
									2	TIMG4_0_CCP1
									AMUX3	CMP1_HP3_LP3
									AMUX4	PGA0_P6
									AMUX5	PGA1_P8
									AMUX6	PGA2_P8
									8	UC0_CTS_CS0
									9	UC5_CTS
									10	UC2_CTS
									11	UC3_CTS_CS0
									13	EPIO_S16
									16	OUTPUTXBAR6

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
74	59	59						PB28 IOMUX_PB28 0x400C_C0F0	A	ANALOG_AIN38
									AMUX0	A0_28
									0	Disconnected
									1	GPIO60
									AMUX1	A1_28
									AMUX2	A2_9
									2	TIMG4_0_CCP0
									AMUX3	CMP0_HP3_LP3
									3	MCPWM2_2A
									AMUX4	PGA2_P6
									4	MCPWM3_2A
									AMUX5	PGA0_P8
									5	MCPWM4_2A
									8	UC0_RTS_POCI
									9	UC5_RTS
									10	UC2_RTS
75	60	60						PB29 IOMUX_PB29 0x400C_C0F4	11	UC3_RTS_POCI
									13	EPI0_S17
									16	OUTPUTXBAR7
									AMUX0	A0_29
									0	Disconnected
									A	ANALOG_AIN39
									1	GPIO61
									AMUX1	A1_29
									2	TIMG4_0_CCP1
									AMUX2	A2_10
									3	MCPWM2_2B
									AMUX3	CMP0_LN0
									4	MCPWM3_2B
									5	MCPWM4_2B
									6	UC5_RX_SCL
									8	UC5_TX_SDA
									10	UC2_RX_SCL
									11	UC2_TX_SDA
									13	EPI0_S18
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
76	61	61						PB30 IOMUX_PB30 0x400C_C0F8	A	ANALOG_AIN40
									AMUX0	A0_30
									0	Disconnected
									1	GPIO62
									AMUX1	A1_30
									2	TIMG4_0_CCP0
									AMUX2	A2_11
									AMUX3	CMP2_HP2_LP2
									3	MCPWM2_3A
									4	MCPWM3_3A
									AMUX4	PGA1_P7
									5	MCPWM4_3A
									6	UC5_TX_SDA
									8	UC5_RX_SCL
									10	UC2_TX_SDA
									11	UC2_RX_SCL
77	62	62						PB31 IOMUX_PB31 0x400C_C0FC	13	EPI0_S0
									16	OUTPUTXBAR1
									A	ANALOG_AIN41
									AMUX0	A2_29
									0	Disconnected
									1	GPIO63
									AMUX1	CMP2_LN0
									2	TIMG4_0_CCP1
									3	MCPWM2_3B
									4	MCPWM3_3B
									5	MCPWM4_3B
									7	UC1_RTS_POCI
									11	UC4_RTS_POCI
									13	EPI0_S1
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
125	97	97						PC0 IOMUX_PC0 0x400C_C100	0	Disconnected
									1	GPIO64
									3	MCPWM3_1B
									4	MCPWM2_1B
									5	MCPWM3_1A
									6	MCPWM4_2A
									8	UC0_TX_SDA_PICO
									9	UC3_TX_SDA_PICO
									13	EPI0_S24
									16	OUTPUTXBAR1
126	98	98						PC1 IOMUX_PC1 0x400C_C104	0	Disconnected
									1	GPIO65
									2	TRACE_DATA0
									4	MCPWM4_1A
									5	MCPWM3_3A
									6	MCPWM3_1A
									7	MCPWM2_1A
									8	UC0_RX_SCL_SCLK
									9	UC3_RX_SCL_SCLK
									13	EPI0_S25
1	1	1						PC2 IOMUX_PC2 0x400C_C108	16	OUTPUTXBAR2
									0	Disconnected
									1	GPIO66
									2	TRACE_CLK
									3	MCPWM4_3A
									5	UC5_RX_SCL
									6	UC3_RX_SCL_SCLK
									7	MCPWM2_1A
									8	SYSCTL_FCC_IN
									9	MCPWM3_1A
									10	UC2_RX_SCL
									11	UC0_RX_SCL_SCLK
									13	EPI0_S23
									16	OUTPUTXBAR1

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
2	2	2						PC3 IOMUX_PC3 0x400C_C10C	0	Disconnected
									1	GPIO67
									2	TRACE_DATA0
									3	MCPWM4_3B
									4	MCPWM4_2A
									5	UC5_TX_SDA
									6	UC3_RTS_POCI
									7	MCPWM2_2A
									8	MCPWM3_2A
									10	UC2_TX_SDA
									11	UC0_RTS_POCI
									13	EPIO_S19
									16	OUTPUTXBAR2
3	3	3						PC4 IOMUX_PC4 0x400C_C110	0	Disconnected
									1	GPIO68
									2	TRACE_DATA1
									3	MCPWM4_1A
									6	UC3_RTS_POCI
									7	MCPWM2_1B
									8	MCPWM3_1B
									11	UC0_RTS_POCI
									13	EPIO_S20
									16	OUTPUTXBAR3
4	4	4						PC5 IOMUX_PC5 0x400C_C114	0	Disconnected
									1	GPIO69
									2	TRACE_DATA2
									3	MCPWM4_1B
									4	MCPWM4_2B
									6	UC3_CTS_CS0
									7	MCPWM2_2B
									8	MCPWM3_2B
									11	UC0_CTS_CS0
									13	EPIO_S21
									16	OUTPUTXBAR4

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
5	5	5						PC6 IOMUX_PC6 0x400C_C118	0	Disconnected
									1	GPIO70
									2	TRACE_DATA3
									4	MCPWM3_3B
									6	UC3_TX_SDA_PICO
									7	MCPWM2_3B
									11	UC0_TX_SDA_PICO
									13	EPI0_S22
53	38	38	30					PC7 IOMUX_PC7 0x400C_C11C	16	OUTPUTXBAR5
									0	Disconnected
									AMUX0	A2_4
									A	ANALOG_AIN19
									AMUX1	CMP3_HP0_LP0
									1	GPIO71
									7	UC0_RTS_POCI
									8	UC5_RX_SCL
54	39	39	31					PC8 IOMUX_PC8 0x400C_C120	11	UC2_RX_SCL
									13	EPI0_S4
									16	OUTPUTXBAR1
									AMUX0	A0_23
									0	Disconnected
									A	ANALOG_AIN20
									1	GPIO72
									AMUX1	A1_23
									2	MCPWM3_2A
									AMUX2	A2_6
									AMUX3	CMP3_HN1_LN1
									3	MCPWM0_1B
									4	MCPWM4_1B
									7	MCPWM0_2B
									8	UC5_TX_SDA
									11	UC2_TX_SDA
									13	EPI0_S5
									16	OUTPUTXBAR2

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
55	40	40	32					PC9 IOMUX_PC9 0x400C_C124	A	ANALOG_AIN21
									AMUX0	A2_2
									0	Disconnected
									1	GPIO73
									AMUX1	CMP3_HP2_LP2
									2	MCPWM3_2B
									3	MCPWM0_1A
									4	MCPWM4_1A
									7	MCPWM0_3B
									13	EPI0_S6
56	41	41	33					PC10 IOMUX_PC10 0x400C_C128	16	OUTPUTXBAR3
									0	Disconnected
									AMUX0	A0_16
									A	ANALOG_AIN22
									AMUX1	A1_16
									1	GPIO74
									AMUX2	A2_14
									3	MCPWM0_2B
									4	MCPWM4_2B
									5	MCPWM3_3B
57	42	42	34					PC11 IOMUX_PC11 0x400C_C12C	7	MCPWM0_1B
									13	EPI0_S7
									16	OUTPUTXBAR4
									0	Disconnected
									AMUX0	A0_24
									A	ANALOG_AIN23
									AMUX1	A1_24
									1	GPIO75
									AMUX2	A2_15
									3	MCPWM0_2A
									4	MCPWM4_2A
									5	MCPWM3_3A
									6	UC3_RTS_POCI
									11	UC0_RTS_POCI
									13	EPI0_S8
									16	OUTPUTXBAR5

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
58	43	43	35					PC12 IOMUX_PC12 0x400C_C130	0	Disconnected
									AMUX0	A0_25
									A	ANALOG_AIN24
									AMUX1	A1_25
									1	GPIO76
									AMUX2	A2_16
									3	MCPWM0_3B
									4	MCPWM4_3B
									6	UC3_RX_SCL_SCLK
									11	UC0_RX_SCL_SCLK
									13	EPI0_S9
									16	OUTPUTXBAR6
59	44	44	36					PC13 IOMUX_PC13 0x400C_C134	A	ANALOG_AIN25
									0	Disconnected
									AMUX0	A2_3
									1	GPIO77
									3	MCPWM0_3A
									4	MCPWM4_3A
									6	UC3_CTS_CS0
									11	UC0_CTS_CS0
									12	EPI0_S26
									13	EPI0_S10
									16	OUTPUTXBAR7
									0	Disconnected
60	45	45	37					PC14 IOMUX_PC14 0x400C_C138	AMUX0	A0_18
									A	ANALOG_AIN26
									1	GPIO78
									3	MCPWM0_1A
									4	MCPWM4_1A
									5	MCPWM4_1B
									6	UC3_TX_SDA_PICO
									7	MCPWM0_1B
									11	UC0_TX_SDA_PICO
									13	EPI0_S11
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
61	46	46	38					PC15 IOMUX_PC15 0x400C_C13C	A	ANALOG_AIN27
									AMUX0	A0_19
									0	Disconnected
									1	GPIO79
									AMUX1	CMP3_HP3_LP3
									5	MCPWM4_1A
									7	MCPWM0_1A
									8	UC0_TX_SDA_PICO
									9	UC0_RX_SCL_SCLK
									10	UC3_RX_SCL_SCLK
									11	UC3_TX_SDA_PICO
									13	EPI0_S12
									16	OUTPUTXBAR1
26	19							PC18 IOMUX_PC18 0x400C_C148	0	Disconnected
									1	GPIO82
									3	MCPWM2_3A
									4	MCPWM3_3A
									5	MCPWM4_3A
									13	EPI0_S2
									16	OUTPUTXBAR7
10								PC19 IOMUX_PC19 0x400C_C14C	0	Disconnected
									1	GPIO83
									3	MCPWM2_1A
									4	MCPWM3_1A
									5	UC0_RX_SCL_SCLK
									6	UC5_RX_SCL
									7	UC4_TX_SDA_PICO
									8	UC5_CTS
									9	SYSCTL_FCC_IN
									11	UC1_TX_SDA_PICO
									13	EPI0_S3
									16	OUTPUTXBAR3

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
19	12	12	5	5	5	5	5	PC16_X1 IOMUX_PC16_X1 0x400C_C140	A	ANALOG_AIN0
									0	Disconnected
									AMUX0	A0_10
									AMUX1	SYSCTL_HFCLKIN
									1	GPIO80
									AMUX2	SYSCTL_X1
									2	UC2_TX_SDA
									4	MCPWM3_2B
									5	UC1_TX_SDA_PICO
									6	UC1_RTS_POCI
									7	MCPWM0_3B
									8	UC4_RTS_POCI
									9	MCPWM4_3B
									16	OUTPUTXBAR2
20	13	13	6	6	6	6	6	PC17_X2 IOMUX_PC17_X2 0x400C_C144	A	ANALOG_AIN1
									0	Disconnected
									AMUX0	A1_10
									AMUX1	CMP2_HN0
									1	GPIO81
									AMUX2	SYSCTL_X2
									2	UC2_RX_SCL
									6	UC1_RX_SCL_SCLK
11								PC20 IOMUX_PC20 0x400C_C150	0	Disconnected
									1	GPIO84
									3	MCPWM3_1B
									4	MCPWM2_1B
									5	UC0_TX_SDA_PICO
									6	UC5_TX_SDA
									7	UC4_RX_SCL_SCLK
									8	UC5_RTS
									11	UC1_RX_SCL_SCLK
									13	EPI0_S4
									16	OUTPUTXBAR4

ADVANCE INFORMATION

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
14								PC21 IOMUX_PC21 0x400C_C154	0	Disconnected
									1	GPIO85
									3	MCPWM2_2B
									4	MCPWM3_2B
									6	MCPWM4_2B
									13	EPI0_S5
									16	OUTPUTXBAR5
97		73						PC22 IOMUX_PC22 0x400C_C158	0	Disconnected
									1	GPIO86
									3	MCPWM3_3B
									4	MCPWM2_3B
									5	UC1_RX_SCL_SCLK
									6	UC4_RX_SCL_SCLK
									7	MCPWM3_1A
									8	UC0_RTS_POCI
									9	MCPWM4_2A
									10	UC3_RTS_POCI
									11	MCPWM4_3B
15								PC23 IOMUX_PC23 0x400C_C15C	16	OUTPUTXBAR2
									0	Disconnected
									1	GPIO87
									2	UC5_RX_SCL
									3	MCPWM2_2A
									4	MCPWM3_2A
									5	UC4_RTS_POCI
									6	MCPWM4_2A
									7	MCPWM3_1B
									10	UC1_RTS_POCI
									11	UC2_RX_SCL
									13	EPI0_S1
									16	OUTPUTXBAR6

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
16								PC24 IOMUX_PC24 0x400C_C160	0	Disconnected
									1	GPIO88
									2	UC5_TX_SDA
									4	MCPWM3_1B
									5	UC4_CTS_CS0
									7	MCPWM3_2A
									10	UC1_CTS_CS0
									11	UC2_TX_SDA
									13	EPI0_S24
	10							PC25 IOMUX_PC25 0x400C_C164	16	OUTPUTXBAR7
									0	Disconnected
									1	GPIO89
									2	UC5_CTS
									3	UC2_TX_SDA
									4	MCPWM3_1A
									5	UC4_TX_SDA_PICO
									6	UC1_RX_SCL_SCLK
									7	MCPWM3_2B
	11							PC26 IOMUX_PC26 0x400C_C168	8	UC5_RX_SCL
									9	MCPWM4_2A
									11	UC2_CTS
									13	EPI0_S25
									16	OUTPUTXBAR8
									0	Disconnected
									1	GPIO90
									2	UC5_RTS
									3	UC2_RX_SCL
									4	MCPWM3_2A
									5	UC4_RX_SCL_SCLK
									6	UC1_RX_SCL_SCLK
									7	SYSCTL_XCLKOUT
									8	UC5_TX_SDA
									11	UC2_RTS
									13	EPI0_S0
									16	OUTPUTXBAR1

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
48								PC27 IOMUX_PC27 0x400C_C16C	0	Disconnected
									1	GPIO91
									13	EPI0_S33
									16	OUTPUTXBAR4
49								PC28 IOMUX_PC28 0x400C_C170	0	Disconnected
									1	GPIO92
									3	MCPWM2_1A
									4	MCPWM3_1A
									13	EPI0_S6
50								PC29 IOMUX_PC29 0x400C_C174	16	OUTPUTXBAR5
									0	Disconnected
									1	GPIO93
									3	MCPWM2_2A
									4	MCPWM3_2A
									5	MCPWM4_2A
									7	UC0_CTS_CS0
51								PC30 IOMUX_PC30 0x400C_C178	13	EPI0_S7
									16	OUTPUTXBAR6
									0	Disconnected
									1	GPIO94
									3	MCPWM2_3A
									4	MCPWM3_3A
									5	UC2_RX_SCL
									6	MCPWM4_3A
									7	UC0_RX_SCL_SCLK
52								PC31 IOMUX_PC31 0x400C_C17C	8	UC5_RX_SCL
									13	EPI0_S8
									16	OUTPUTXBAR7
									0	Disconnected
									1	GPIO95
									3	MCPWM2_1A
									4	MCPWM3_1A
									5	UC2_TX_SDA
									7	UC0_TX_SDA_PICO
									8	UC5_TX_SDA
									13	EPI0_S9
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
82								PD0 IOMUX_PD0 0x400C_C180	0	Disconnected
									1	GPIO96
									3	MCPWM2_1B
									4	MCPWM3_1B
									5	UC2_RTS
									8	UC5_RTS
									14	MCPWM4_2A
									15	MCPWM3_1A
									16	OUTPUTXBAR5
83								PD1 IOMUX_PD1 0x400C_C184	0	Disconnected
									1	GPIO97
									3	MCPWM2_2B
									4	MCPWM3_2B
									5	UC2_CTS
									8	UC5_CTS
									14	MCPWM4_2B
									15	MCPWM3_1B
84								PD2 IOMUX_PD2 0x400C_C188	16	OUTPUTXBAR6
									0	Disconnected
									1	GPIO98
									3	MCPWM2_3B
									4	MCPWM3_3B
									5	MCPWM4_3B
									6	UC0_RX_SCL_SCLK
									11	UC3_RX_SCL_SCLK
									15	MCPWM3_2A
85								PD3 IOMUX_PD3 0x400C_C18C	16	OUTPUTXBAR7
									0	Disconnected
									1	GPIO99
									5	UC2_RX_SCL
									6	UC0_CTS_CS0
									7	MCPWM2_1B
									8	MCPWM3_1B
									10	UC3_CTS_CS0
									11	UC5_RX_SCL
									15	MCPWM3_2B
									16	OUTPUTXBAR8

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
86								PD4 IOMUX_PD4 0x400C_C190	0	Disconnected
									1	GPIO100
									5	UC2_TX_SDA
									6	UC0_TX_SDA_PICO
									10	UC3_TX_SDA_PICO
									11	UC5_TX_SDA
									13	MCPWM4_1A
									14	MCPWM4_3A
									15	MCPWM3_3A
									16	OUTPUTXBAR1
103								PD5 IOMUX_PD5 0x400C_C194	0	Disconnected
									1	GPIO101
									6	UC0_RTS_POCI
									8	UC1_CTS_CS0
									9	UC0_CTS_CS0
									16	OUTPUTXBAR5
104								PD6 IOMUX_PD6 0x400C_C198	0	Disconnected
									1	GPIO102
									8	UC1_RTS_POCI
									9	UC0_RTS_POCI
									16	OUTPUTXBAR6
105								PD7 IOMUX_PD7 0x400C_C19C	0	Disconnected
									1	GPIO103
									5	UC0_RX_SCL_SCLK
									8	UC1_TX_SDA_PICO
									9	UC0_TX_SDA_PICO
									11	UC3_RX_SCL_SCLK
									13	EPI0_S35
									16	OUTPUTXBAR7

Table 5-1. Pin Attributes (LQFP128, LQFP100_G, LQFP100_H, LQFP80, LQFP64_G, LQFP64_H, LQFP48, QFN48 Packages) (continued)

LQFP128	LQFP100_G	LQFP100_H	LQFP80	LQFP64_G	LQFP64_H	LQFP48	QFN48	BALL NAME/ IOMUX REGISTER/ IOMUX ADDRESS	MODE	SIGNAL NAME
106								PD8 IOMUX_PD8 0x400C_C1A0	0	Disconnected
									1	GPIO104
									5	UC0_TX_SDA_PICO
									8	UC1_RX_SCL_SCLK
									9	UC0_RX_SCL_SCLK
									11	UC3_TX_SDA_PICO
									13	EPI0_S34
									14	MCPWM4_2A
									15	MCPWM3_1A
									16	OUTPUTXBAR8
107								PD9 IOMUX_PD9 0x400C_C1A4	0	Disconnected
									1	GPIO105
									7	UC2_RX_SCL
									8	UC0_TX_SDA_PICO
									9	UC5_RX_SCL
									10	UC3_TX_SDA_PICO
									13	EPI0_S27
									14	MCPWM4_2B
									15	MCPWM3_1B
									16	OUTPUTXBAR1
		94			60			PD11 IOMUX_PD11 0x400C_C1AC	0	Disconnected
									1	GPIO107
									16	OUTPUTXBAR8
111, 128, 13, 47, 6, 64, 79, 95	100, 49, 6, 64, 75	100, 11, 50, 6, 75	1, 41, 51, 62, 80	1, 32, 48, 64	1, 32, 48, 64	1, 24, 36, 48	1, 23, 35, 48	VDD	0	VDD
31, 45	24, 37	28	16, 29	16, 29	19	21	21	VDDA	0	VDDA
43, 44	36	21, 22	28	28	13	20	20	VREFHI	0	VREFHI
42	35	20	27	27	12	19	PAD	VREFLO	0	VREFLO
110, 12, 127, 46, 63, 78, 94	48, 63, 74, 99	10, 19, 49, 74, 99	40, 50, 61, 79	31, 47, 63	31, 47, 63	23, 35, 47	PAD	VSS	0	VSS
30	23	27	15	15	18	19	PAD	VSSA None None	0	VSSA

5.3 Signal Descriptions

Many signals are available on multiple pins, according to the software configuration of the pin multiplexing options.

The following list describes the column headers:

1. **SIGNAL NAME:** The name of the signal passing through the pin.

Note

Signal names and descriptions provided in each Signal Descriptions table, represent the pin multiplexed signal function which is implemented at the pin and selected via IOMUX pad configuration registers. Some device subsystems provide secondary multiplexing of signal functions, which are not described in these tables. For more information on secondary multiplexed signal functions, see the respective peripheral chapter of the device TRM.

2. **PIN TYPE:** Signal direction and type:

- I = Input
- O = Output
- IO = Input, Output, or simultaneously Input and Output
- ID = Input with open-drain output function
- OD = Output, with open-drain output function
- IOD = Input, Output, or simultaneously Input and Output, with open-drain output function
- IOZ = Input, Output, or simultaneously Input and Output, with three-state output function
- OZ = Output with three-state output function
- A = Analog
- CAP = LDO capacitor
- PWR = Power
- GND = Ground

3. **DESCRIPTION:** Description of the signal

4. **BALL:** Associated ball number

For more information on the I/O cell configurations, see the *Pad Configuration Registers* section within the *Device Configuration* chapter of the device TRM.

Table 5-2. ADC0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
A0_1	ADC0 Input 1	A	27	20	23	12	12	14	8	8
A0_2	ADC0 Input 2	A	28	21	24	13	13	15	9	9
A0_3	ADC0 Input 3	A	29	22	25	14	14	16	10	10
A0_4	ADC0 Input 4	A	32	25	26	17	17	17	11	11
A0_5	ADC0 Input 5	A	68	53	53	45	36	35	28	27
A0_6	ADC0 Input 6	A	22	15	15	8	8	8		
A0_7	ADC0 Input 7	A	23	16	16	9	9	9		
A0_8	ADC0 Input 8	A	24	17	17	10	10	10		
A0_9	ADC0 Input 9	A	25	18	18	11	11	11		
A0_10	ADC0 Input 10	A	19	12	12	5	5	5	5	5
A0_11	ADC0 Input 11	A	66	51	51	43	34	33	26	25
A0_12	ADC0 Input 12	A	40	33	36	25	25	27	17	18
A0_14	ADC0 Input 14	A	65	50		42	33		25	24
A0_15	ADC0 Input 15	A	39	32	35	24	24	26	16	17
A0_16	ADC0 Input 16	A	56	41	41	33				
A0_17	ADC0 Input 17	A	35	28	31	20	20	22	14	14
A0_18	ADC0 Input 18	A	60	45	45	37				
A0_19	ADC0 Input 19	A	61	46	46	38				
A0_21	ADC0 Input 21	A	70	55	55	47				
A0_22	ADC0 Input 22	A	71	56	56	48				
A0_23	ADC0 Input 23	A	54	39	39	31				
A0_24	ADC0 Input 24	A	57	42	42	34				
A0_25	ADC0 Input 25	A	58	43	43	35				
A0_26	ADC0 Input 26	A	72	57	57	49				
A0_27	ADC0 Input 27	A	73	58	58					
A0_28	ADC0 Input 28	A	74	59	59					
A0_29	ADC0 Input 29	A	75	60	60					
A0_30	ADC0 Input 30	A	76	61	61					

Table 5-3. ADC1 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
A1_1	ADC1 Input 1	A	27	20	23	12	12	14	8	8
A1_2	ADC1 Input 2	A	28	21	24	13	13	15	9	9
A1_3	ADC1 Input 3	A	35	28	31	20	20	22	14	14

Table 5-3. ADC1 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
A1_4	ADC1 Input 4	A	36	29	32	21	21	23	15	15
A1_5	ADC1 Input 5	A	37	30	33	22	22	24		16
A1_6	ADC1 Input 6	A	22	15	15	8	8	8		
A1_7	ADC1 Input 7	A	23	16	16	9	9	9		
A1_8	ADC1 Input 8	A	24	17	17	10	10	10		
A1_9	ADC1 Input 9	A	25	18	18	11	11	11		
A1_10	ADC1 Input 10	A	20	13	13	6	6	6	6	6
A1_11	ADC1 Input 11	A	38	31	34	23	23	25		
A1_12	ADC1 Input 12	A	41	34	37	26	26	28	18	19
A1_13	ADC1 Input 13	A	34	27	30	19	19	21	13	13
A1_14	ADC1 Input 14	A	65	50		42	33		25	24
A1_15	ADC1 Input 15	A	69	54	54	46	37	36	29	28
A1_16	ADC1 Input 16	A	56	41	41	33				
A1_17	ADC1 Input 17	A	33	26	29	18	18	20	12	12
A1_18	ADC1 Input 18	A	89	69	67	56	42	41	30	30
A1_19	ADC1 Input 19	A	90	70	68	57	43	42	31	31
A1_21	ADC1 Input 21	A	70	55	55	47				
A1_22	ADC1 Input 22	A	71	56	56	48				
A1_23	ADC1 Input 23	A	54	39	39	31				
A1_24	ADC1 Input 24	A	57	42	42	34				
A1_25	ADC1 Input 25	A	58	43	43	35				
A1_26	ADC1 Input 26	A	72	57	57	49				
A1_27	ADC1 Input 27	A	73	58	58					
A1_28	ADC1 Input 28	A	74	59	59					
A1_29	ADC1 Input 29	A	75	60	60					
A1_30	ADC1 Input 30	A	76	61	61					

Table 5-4. ADC2 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
A2_1	ADC2 Input 1	A	40	33	36	25	25	27	17	18
A2_2	ADC2 Input 2	A	55	40	40	32				
A2_3	ADC2 Input 3	A	59	44	44	36				
A2_4	ADC2 Input 4	A	53	38	38	30				
A2_5	ADC2 Input 5	A	67	52	52	44	35	34	27	26

Table 5-4. ADC2 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
A2_6	ADC2 Input 6	A	54	39	39	31				
A2_7	ADC2 Input 7	A	72	57	57	49				
A2_8	ADC2 Input 8	A	73	58	58					
A2_9	ADC2 Input 9	A	74	59	59					
A2_10	ADC2 Input 10	A	75	60	60					
A2_11	ADC2 Input 11	A	76	61	61					
A2_12	ADC2 Input 12	A	39	32	35	24	24	26	16	17
A2_14	ADC2 Input 14	A	56	41	41	33				
A2_15	ADC2 Input 15	A	57	42	42	34				
A2_16	ADC2 Input 16	A	58	43	43	35				
A2_17	ADC2 Input 17	A	62	47	47	39	30	29	22	22
A2_18	ADC2 Input 18	A	33	26	29	18	18	20	12	12
A2_19	ADC2 Input 19	A	34	27	30	19	19	21	13	13
A2_21	ADC2 Input 21	A	32	25	26	17	17	17	11	11
A2_22	ADC2 Input 22	A	36	29	32	21	21	23	15	15
A2_23	ADC2 Input 23	A	37	30	33	22	22	24		16
A2_24	ADC2 Input 24	A	38	31	34	23	23	25		
A2_25	ADC2 Input 25	A	29	22	25	14	14	16	10	10
A2_26	ADC2 Input 26	A	35	28	31	20	20	22	14	14
A2_27	ADC2 Input 27	A	68	53	53	45	36	35	28	27
A2_28	ADC2 Input 28	A	69	54	54	46	37	36	29	28
A2_29	ADC2 Input 29	A	77	62	62					
A2_30	ADC2 Input 30	A	66	51	51	43	34	33	26	25

Table 5-5. ADCCAL Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ADCCAL_ADCINCAL0	ADC Calibration Input 0	A	35	28	31	20	20	22	14	14

Table 5-6. ANALOG Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ANALOG_AIN0	A0_10 HFCLKIN X1	A	19	12	12	5	5	5	5	5

Table 5-6. ANALOG Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ANALOG_AIN1	A1_10 CMP2_HN0 X2	A	20	13	13	6	6	6	6	6
ANALOG_AIN2	A0_6 A1_6 CMP2_HN1	A	22	15	15	8	8	8		
ANALOG_AIN3	A0_7 A1_7 CMP2_HP1_LP1	A	23	16	16	9	9	9		
ANALOG_AIN4	A0_8 A1_8	A	24	17	17	10	10	10		
ANALOG_AIN5	A0_9 A1_9 PGA2_P1 PGA0_P0 PGA1_P0	A	25	18	18	11	11	11		
ANALOG_AIN6	A0_1 A1_1 CMP0_HN0 CMP2_HP0_LP0	A	27	20	23	12	12	14	8	8
ANALOG_AIN7	A0_2 A1_2 CMP0_HP1_LP1 PGA0_P1 PGA1_M0 PGA2_P2	A	28	21	24	13	13	15	9	9
ANALOG_AIN8	A0_3 A2_25 CMP1_HN0 PGA0_OUT	A	29	22	25	14	14	16	10	10
ANALOG_AIN9	A0_4 A2_21 CMP1_HP0_LP0 PGA0_M0 PGA0_P2 PGA2_M0	A	32	25	26	17	17	17	11	11
ANALOG_AIN10	A1_17 A2_18 CMP2_DACL CMP0_HN1 TESTANA0	A	33	26	29	18	18	20	12	12
ANALOG_AIN11	A1_13 A2_19 CMP1_HN1 PGA1_M1 TESTANA1	A	34	27	30	19	19	21	13	13

Table 5-6. ANALOG Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ANALOG_AIN12	A0_17 A1_3 A2_26 CMP3_DACL PGA1_OUT ADCINCAL0	A	35	28	31	20	20	22	14	14
ANALOG_AIN13	A1_4 A2_22 CMP1_HP1_LP1 PGA0_P3 PGA1_P1	A	36	29	32	21	21	23	15	15
ANALOG_AIN14	A1_5 A2_23	A	37	30	33	22	22	24		16
ANALOG_AIN15	A1_11 A2_24 PGA0_M1 PGA1_M2	A	38	31	34	23	23	25		
ANALOG_AIN16	A0_15 A2_12 CMP3_HP1_LP1 PGA1_P2 PGA2_P3	A	39	32	35	24	24	26	16	17
ANALOG_AIN17	A0_12 A2_1 CMP0_HP0_LP0 PGA1_M3 PGA2_OUT	A	40	33	36	25	25	27	17	18
ANALOG_AIN18	A1_12 CMP3_HN0_LN0 PGA2_M1	A	41	34	37	26	26	28	18	19
ANALOG_AIN19	A2_4 CMP3_HP0_LP0	A	53	38	38	30				
ANALOG_AIN20	A0_23 A1_23 A2_6 CMP3_HN1_LN1	A	54	39	39	31				
ANALOG_AIN21	A2_2 CMP3_HP2_LP2	A	55	40	40	32				
ANALOG_AIN22	A0_16 A1_16 A2_14	A	56	41	41	33				
ANALOG_AIN23	A0_24 A1_24 A2_15	A	57	42	42	34				

Table 5-6. ANALOG Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ANALOG_AIN24	A0_25 A1_25 A2_16	A	58	43	43	35				
ANALOG_AIN25	A2_3	A	59	44	44	36				
ANALOG_AIN26	A0_18	A	60	45	45	37				
ANALOG_AIN27	A0_19 CMP3_HP3_LP3	A	61	46	46	38				
ANALOG_AIN28	A2_17 CMP0_LN1 PGA2_M2 PGA0_M2	A	62	47	47	39	30	29	22	22
ANALOG_AIN29	A0_14 A1_14 CMP1_HP2_LP2 PGA0_P4 PGA2_P0	A	65	50		42	33		25	24
ANALOG_AIN30	A0_11 A2_30 CMP2_LN1 PGA1_P3 PGA0_P7	A	66	51	51	43	34	33	26	25
ANALOG_AIN31	A2_5 CMP0_HP2_LP2 PGA0_P5 PGA1_P4 PGA2_P4	A	67	52	52	44	35	34	27	26
ANALOG_AIN32	A0_5 A2_27 CMP2_HP3_LP3 PGA1_P5 PGA2_P5	A	68	53	53	45	36	35	28	27
ANALOG_AIN33	A1_15 A2_28 CMP1_LN1 PGA2_M3	A	69	54	54	46	37	36	29	28
ANALOG_AIN34	A0_21 A1_21 PGA0_M3	A	70	55	55	47				
ANALOG_AIN35	A0_22 A1_22 PGA1_P6 PGA2_P7	A	71	56	56	48				
ANALOG_AIN36	A0_26 A1_26 A2_7 CMP1_LN0	A	72	57	57	49				

Table 5-6. ANALOG Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
ANALOG_AIN37	A0_27 A1_27 A2_8 CMP1_HP3_LP3 PGA0_P6 PGA1_P8 PGA2_P8	A	73	58	58					
ANALOG_AIN38	A0_28 A1_28 A2_9 CMP0_HP3_LP3 PGA2_P6 PGA0_P8	A	74	59	59					
ANALOG_AIN39	A0_29 A1_29 A2_10 CMP0_LN0	A	75	60	60					
ANALOG_AIN40	A0_30 A1_30 A2_11 CMP2_HP2_LP2 PGA1_P7	A	76	61	61					
ANALOG_AIN41	A2_29 CMP2_LN0	A	77	62	62					
ANALOG_AIN42	A1_18	A	89	69	67	56	42	41	30	30
ANALOG_AIN43	A1_19	A	90	70	68	57	43	42	31	31

Table 5-7. CMP0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP0_HN0	CMPSS0 High Comparator Negative Input 0	A	27	20	23	12	12	14	8	8
CMP0_HN1	CMPSS0 High Comparator Negative Input 1	A	33	26	29	18	18	20	12	12
CMP0_HP0_LP0	CMPSS0 High/Low Comparator Positive Input 0	A	40	33	36	25	25	27	17	18
CMP0_HP1_LP1	CMPSS0 High/Low Comparator Positive Input 1	A	28	21	24	13	13	15	9	9
CMP0_HP2_LP2	CMPSS0 High/Low Comparator Positive Input 2	A	67	52	52	44	35	34	27	26
CMP0_HP3_LP3	CMPSS0 High/Low Comparator Positive Input 3	A	74	59	59					
CMP0_LN0	CMPSS0 Low Comparator Negative Input 0	A	75	60	60					

Table 5-7. CMP0 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP0_LN1	CMPSS0 Low Comparator Negative Input 1	A	62	47	47	39	30	29	22	22

Table 5-8. CMP1 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP1_HN0	CMPSS1 High Comparator Negative Input 0	A	29	22	25	14	14	16	10	10
CMP1_HN1	CMPSS1 High Comparator Negative Input 1	A	34	27	30	19	19	21	13	13
CMP1_HP0_LP0	CMPSS1 High/Low Comparator Positive Input 0	A	32	25	26	17	17	17	11	11
CMP1_HP1_LP1	CMPSS1 High/Low Comparator Positive Input 1	A	36	29	32	21	21	23	15	15
CMP1_HP2_LP2	CMPSS1 High/Low Comparator Positive Input 2	A	65	50		42	33		25	24
CMP1_HP3_LP3	CMPSS1 High/Low Comparator Positive Input 3	A	73	58	58					
CMP1_LN0	CMPSS1 Low Comparator Negative Input 0	A	72	57	57	49				
CMP1_LN1	CMPSS1 Low Comparator Negative Input 1	A	69	54	54	46	37	36	29	28

Table 5-9. CMP2 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP2_DACL	CMPSS2 Buffered DACL Out	A	33	26	29	18	18	20	12	12
CMP2_HN0	CMPSS2 High Comparator Negative Input 0	A	20	13	13	6	6	6	6	6
CMP2_HN1	CMPSS2 High Comparator Negative Input 1	A	22	15	15	8	8	8		
CMP2_HP0_LP0	CMPSS2 High/Low Comparator Positive Input 0	A	27	20	23	12	12	14	8	8
CMP2_HP1_LP1	CMPSS2 High/Low Comparator Positive Input 1	A	23	16	16	9	9	9		
CMP2_HP2_LP2	CMPSS2 High/Low Comparator Positive Input 2	A	76	61	61					
CMP2_HP3_LP3	CMPSS2 High/Low Comparator Positive Input 3	A	68	53	53	45	36	35	28	27

Table 5-9. CMP2 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP2_LN0	CMPSS2 Low Comparator Negative Input 0	A	77	62	62					
CMP2_LN1	CMPSS2 Low Comparator Negative Input 1	A	66	51	51	43	34	33	26	25

Table 5-10. CMP3 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
CMP3_DACL	CMPSS3 Buffered DACL Out	A	35	28	31	20	20	22	14	14
CMP3_HN0_LN0	CMPSS3 High/Low Comparator Negative Input 0	A	41	34	37	26	26	28	18	19
CMP3_HN1_LN1	CMPSS3 High/Low Comparator Negative Input 1	A	54	39	39	31				
CMP3_HP0_LP0	CMPSS3 High/Low Comparator Positive Input 0	A	53	38	38	30				
CMP3_HP1_LP1	CMPSS3 High/Low Comparator Positive Input 1	A	39	32	35	24	24	26	16	17
CMP3_HP2_LP2	CMPSS3 High/Low Comparator Positive Input 2	A	55	40	40	32				
CMP3_HP3_LP3	CMPSS3 High/Low Comparator Positive Input 3	A	61	46	46	38				

Table 5-11. DEBUG Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
DEBUG_JTCK_SWCLK	JTAG Test Clock/Serial Wire Debug Clock	IO	98	77	76	64	50	49	38	37
DEBUG_JTDI	JTAG Test Data In	I	99	78	77	65	51	50	39	38
DEBUG_JTDO_SWO	JTAG Test Data Out/Serial Wire Debug Out	O	118	90	89	72	56	55	40	41
DEBUG_TMS_SWDIO	JTAG Test Mode Select/Serial Wire Debug In-Out	IO	96	76	72	63	49	46	37	36

Table 5-12. EPI0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
EPI0_S0	External Peripheral Interface Signal 0	IO	18, 76	11, 61	61					
EPI0_S1	External Peripheral Interface Signal 1	IO	15, 77	62	62					

Table 5-12. EPIO Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
EPIO_S2	External Peripheral Interface Signal 2	IO	108, 26	19, 82	81	69				
EPIO_S3	External Peripheral Interface Signal 3	IO	10, 109	83	82	70				
EPIO_S4	External Peripheral Interface Signal 4	IO	11, 53	38	38	30				
EPIO_S5	External Peripheral Interface Signal 5	IO	14, 54	39	39	31				
EPIO_S6	External Peripheral Interface Signal 6	IO	49, 55	40	40	32				
EPIO_S7	External Peripheral Interface Signal 7	IO	50, 56	41	41	33				
EPIO_S8	External Peripheral Interface Signal 8	IO	51, 57	42	42	34				
EPIO_S9	External Peripheral Interface Signal 9	IO	52, 58	43	43	35				
EPIO_S10	External Peripheral Interface Signal 10	IO	59	44	44	36				
EPIO_S11	External Peripheral Interface Signal 11	IO	60	45	45	37				
EPIO_S12	External Peripheral Interface Signal 12	IO	61	46	46	38				
EPIO_S13	External Peripheral Interface Signal 13	IO	70	55	55	47				
EPIO_S14	External Peripheral Interface Signal 14	IO	71	56	56	48				
EPIO_S15	External Peripheral Interface Signal 15	IO	72	57	57	49				
EPIO_S16	External Peripheral Interface Signal 16	IO	73	58	58					
EPIO_S17	External Peripheral Interface Signal 17	IO	74	59	59					
EPIO_S18	External Peripheral Interface Signal 18	IO	75	60	60					
EPIO_S19	External Peripheral Interface Signal 19	IO	2	2	2					
EPIO_S20	External Peripheral Interface Signal 20	IO	3	3	3					
EPIO_S21	External Peripheral Interface Signal 21	IO	4	4	4					
EPIO_S22	External Peripheral Interface Signal 22	IO	5	5	5					
EPIO_S23	External Peripheral Interface Signal 23	IO	1	1	1					
EPIO_S24	External Peripheral Interface Signal 24	IO	125, 16	97	97					
EPIO_S25	External Peripheral Interface Signal 25	IO	126, 17	10, 98	98					
EPIO_S26	External Peripheral Interface Signal 26 (Chip Select 0)	IO	116, 59	44, 88	44, 87	36				
EPIO_S27	External Peripheral Interface Signal 27 (Chip Select 1)	IO	102, 107	81	80	68	54	53		
EPIO_S28	External Peripheral Interface Signal 28 (Read/Output Enable)	IO	113	85	84					
EPIO_S29	External Peripheral Interface Signal 29 (Write Enable)	IO	114	86	85					
EPIO_S30	External Peripheral Interface Signal 30 (Address Latch Enable)	IO	121	93	92	75	59	58	43	44
EPIO_S31	External Peripheral Interface Signal 31 (Clock)	IO	112	84	83	71	55	54		

Table 5-12. EPIO Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
EPIO_S32	External Peripheral Interface Signal 32 (Input Ready/nWAIT)	IO	115	87	86					
EPIO_S33	External Peripheral Interface Signal 33 (Chip Select 3)	IO	48, 62	47	47	39	30	29	22	22
EPIO_S34	External Peripheral Interface Signal 34 (Chip Select 2)	IO	106, 66	51	51	43	34	33	26	25
EPIO_S35	External Peripheral Interface Signal 35 (Configure Register Enable)	IO	105, 67	52	52	44	35	34	27	26

Table 5-13. GPIO Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
GPIO00	General Purpose Input/Output 0 (Wakeup0)	IO	27	20	23	12	12	14	8	8
GPIO01	General Purpose Input/Output 1	IO	28	21	24	13	13	15	9	9
GPIO02	General Purpose Input/Output 2 (Wakeup3)	IO	29	22	25	14	14	16	10	10
GPIO03	General Purpose Input/Output 3	IO	32	25	26	17	17	17	11	11
GPIO04	General Purpose Input/Output 4	IO	33	26	29	18	18	20	12	12
GPIO05	General Purpose Input/Output 5	IO	34	27	30	19	19	21	13	13
GPIO06	General Purpose Input/Output 6	IO	35	28	31	20	20	22	14	14
GPIO07	General Purpose Input/Output 7	IO	36	29	32	21	21	23	15	15
GPIO08	General Purpose Input/Output 8	IO	89	69	67	56	42	41	30	30
GPIO09	General Purpose Input/Output 9	IO	90	70	68	57	43	42	31	31
GPIO10	General Purpose Input/Output 10	IO	91	71	69	58	44	43	32	32
GPIO11	General Purpose Input/Output 11	IO	92	72	70	59	45	44	33	33
GPIO12	General Purpose Input/Output 12	IO	93	73	71	60	46	45	34	34
GPIO13	General Purpose Input/Output 13	IO	96	76	72	63	49	46	37	36
GPIO14	General Purpose Input/Output 14	IO	98	77	76	64	50	49	38	37
GPIO15	General Purpose Input/Output 15	IO	99	78	77	65	51	50	39	38
GPIO16	General Purpose Input/Output 16	IO	39	32	35	24	24	26	16	17
GPIO17	General Purpose Input/Output 17	IO	40	33	36	25	25	27	17	18
GPIO18	General Purpose Input/Output 18	IO	41	34	37	26	26	28	18	19
GPIO19	General Purpose Input/Output 19	IO	118	90	89	72	56	55	40	41
GPIO100	General Purpose Input/Output 100	IO	86							
GPIO101	General Purpose Input/Output 101	IO	103							
GPIO102	General Purpose Input/Output 102	IO	104							

Table 5-13. GPIO Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
GPIO103	General Purpose Input/Output 103	IO	105							
GPIO104	General Purpose Input/Output 104	IO	106							
GPIO105	General Purpose Input/Output 105	IO	107							
GPIO107	General Purpose Input/Output 107	IO			94			60		
GPIO20	General Purpose Input/Output 20	IO	119	91	90	73	57	56	41	42
GPIO21	General Purpose Input/Output 21	IO	120	92	91	74	58	57	42	43
GPIO22	General Purpose Input/Output 22	IO	121	93	92	75	59	58	43	44
GPIO23	General Purpose Input/Output 23	IO	122	94	93	76	60	59	44	45
GPIO24	General Purpose Input/Output 24	IO	123	95	95	77	61	61	45	46
GPIO25	General Purpose Input/Output 25	IO	124	96	96	78	62	62	46	47
GPIO26	General Purpose Input/Output 26	IO	62	47	47	39	30	29	22	22
GPIO27	General Purpose Input/Output 27	IO	65	50		42	33		25	24
GPIO28	General Purpose Input/Output 28	IO	66	51	51	43	34	33	26	25
GPIO29	General Purpose Input/Output 29	IO	67	52	52	44	35	34	27	26
GPIO30	General Purpose Input/Output 30	IO	68	53	53	45	36	35	28	27
GPIO31	General Purpose Input/Output 31	IO	69	54	54	46	37	36	29	28
GPIO32	General Purpose Input/Output 32	IO	22	15	15	8	8	8		
GPIO33	General Purpose Input/Output 33 (Wakeup5)	IO	23	16	16	9	9	9		
GPIO34	General Purpose Input/Output 34	IO	24	17	17	10	10	10		
GPIO35	General Purpose Input/Output 35	IO	25	18	18	11	11	11		
GPIO36	General Purpose Input/Output 36	IO	37	30	33	22	22	24		16
GPIO37	General Purpose Input/Output 37 (Wakeup4)	IO	38	31	34	23	23	25		
GPIO38	General Purpose Input/Output 38	IO	80	65	63	52	38	37		29
GPIO39	General Purpose Input/Output 39	IO	81	66	64	53	39	38		
GPIO40	General Purpose Input/Output 40	IO	87	67	65	54	40	39		
GPIO41	General Purpose Input/Output 41	IO	88	68	66	55	41	40		
GPIO42	General Purpose Input/Output 42	IO	100	79	78	66	52	51		39
GPIO43	General Purpose Input/Output 43	IO	101	80	79	67	53	52		40
GPIO44	General Purpose Input/Output 44	IO	102	81	80	68	54	53		
GPIO45	General Purpose Input/Output 45 (Wakeup1)	IO	7	7	7	2	2	2	2	2
GPIO46	General Purpose Input/Output 46	IO	8	8	8	3	3	3	3	3
GPIO47	General Purpose Input/Output 47	IO	9	9	9	4	4	4	4	4
GPIO48	General Purpose Input/Output 48	IO	108	82	81	69				

Table 5-13. GPIO Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
GPIO49	General Purpose Input/Output 49	IO	109	83	82	70				
GPIO50	General Purpose Input/Output 50 (Wakeup6)	IO	112	84	83	71	55	54		
GPIO51	General Purpose Input/Output 51 (Wakeup7)	IO	113	85	84					
GPIO52	General Purpose Input/Output 52	IO	114	86	85					
GPIO53	General Purpose Input/Output 53	IO	115	87	86					
GPIO54	General Purpose Input/Output 54	IO	116	88	87					
GPIO55	General Purpose Input/Output 55	IO	117	89	88					
GPIO56	General Purpose Input/Output 56	IO	70	55	55	47				
GPIO57	General Purpose Input/Output 57	IO	71	56	56	48				
GPIO58	General Purpose Input/Output 58	IO	72	57	57	49				
GPIO59	General Purpose Input/Output 59	IO	73	58	58					
GPIO60	General Purpose Input/Output 60	IO	74	59	59					
GPIO61	General Purpose Input/Output 61	IO	75	60	60					
GPIO62	General Purpose Input/Output 62	IO	76	61	61					
GPIO63	General Purpose Input/Output 63	IO	77	62	62					
GPIO64	General Purpose Input/Output 64	IO	125	97	97					
GPIO65	General Purpose Input/Output 65	IO	126	98	98					
GPIO66	General Purpose Input/Output 66	IO	1	1	1					
GPIO67	General Purpose Input/Output 67	IO	2	2	2					
GPIO68	General Purpose Input/Output 68	IO	3	3	3					
GPIO69	General Purpose Input/Output 69	IO	4	4	4					
GPIO70	General Purpose Input/Output 70 (Wakeup2)	IO	5	5	5					
GPIO71	General Purpose Input/Output 71	IO	53	38	38	30				
GPIO72	General Purpose Input/Output 72	IO	54	39	39	31				
GPIO73	General Purpose Input/Output 73	IO	55	40	40	32				
GPIO74	General Purpose Input/Output 74	IO	56	41	41	33				
GPIO75	General Purpose Input/Output 75	IO	57	42	42	34				
GPIO76	General Purpose Input/Output 76	IO	58	43	43	35				
GPIO77	General Purpose Input/Output 77	IO	59	44	44	36				
GPIO78	General Purpose Input/Output 78	IO	60	45	45	37				
GPIO79	General Purpose Input/Output 79	IO	61	46	46	38				
GPIO80	General Purpose Input/Output 80	IO	19	12	12	5	5	5	5	5
GPIO81	General Purpose Input/Output 81	IO	20	13	13	6	6	6	6	6

Table 5-13. GPIO Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
GPIO82	General Purpose Input/Output 82	IO	26	19						
GPIO83	General Purpose Input/Output 83	IO	10							
GPIO84	General Purpose Input/Output 84	IO	11							
GPIO85	General Purpose Input/Output 85	IO	14							
GPIO86	General Purpose Input/Output 86	IO	97		73					
GPIO87	General Purpose Input/Output 87	IO	15							
GPIO88	General Purpose Input/Output 88	IO	16							
GPIO89	General Purpose Input/Output 89	IO	17	10						
GPIO90	General Purpose Input/Output 90	IO	18	11						
GPIO91	General Purpose Input/Output 91	IO	48							
GPIO92	General Purpose Input/Output 92	IO	49							
GPIO93	General Purpose Input/Output 93	IO	50							
GPIO94	General Purpose Input/Output 94	IO	51							
GPIO95	General Purpose Input/Output 95	IO	52							
GPIO96	General Purpose Input/Output 96	IO	82							
GPIO97	General Purpose Input/Output 97	IO	83							
GPIO98	General Purpose Input/Output 98	IO	84							
GPIO99	General Purpose Input/Output 99	IO	85							

Table 5-14. GROUND Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
VSS	Digital Ground	GND	110, 12, 127, 46, 63, 78, 94	48, 63, 74, 99	10, 19, 49, 74, 99	40, 50, 61, 79	31, 47, 63	31, 47, 63	23, 35, 47	PAD
VSSA	Analog Ground	AGND	30	23	27	15	15	18	19	PAD

Table 5-15. MCAN0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCAN0_RX	CAN Receive (RX) Signal	I	109, 118, 120, 123, 37, 66, 8, 92, 99	30, 51, 72, 78, 8, 83, 90, 92, 95	33, 51, 70, 77, 8, 82, 89, 91, 95	22, 3, 43, 59, 65, 70, 72, 74, 77	22, 3, 34, 45, 51, 56, 58, 61	24, 3, 33, 44, 50, 55, 57, 61	26, 3, 33, 39, 40, 42, 45	16, 25, 3, 33, 38, 41, 43, 46
MCAN0_TX	CAN Transmit (TX) Signal	O	108, 119, 121, 124, 38, 67, 89, 9, 93	31, 52, 69, 73, 82, 9, 91, 93, 96	34, 52, 67, 71, 81, 9, 90, 92, 96	23, 4, 44, 56, 60, 69, 73, 75, 78	23, 35, 4, 42, 46, 57, 59, 62	25, 34, 4, 41, 45, 56, 58, 62	27, 30, 34, 4, 41, 43, 46	26, 30, 34, 4, 42, 44, 47

Table 5-16. MCPWM0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM0_1A	MCPWM0 Output 1A	O	22, 25, 55, 60, 61, 89, 92	15, 18, 40, 45, 46, 69, 72	15, 18, 40, 45, 46, 67, 70	11, 32, 37, 38, 56, 59, 8	11, 42, 45, 8	11, 41, 44, 8	30, 33	30, 33
MCPWM0_1B	MCPWM0 Output 1B	O	36, 38, 54, 56, 60, 67, 7, 92, 93	29, 31, 39, 41, 45, 52, 7, 72, 73	32, 34, 39, 41, 45, 52, 7, 70, 71	2, 21, 23, 31, 33, 37, 44, 59, 60	2, 21, 23, 35, 45, 46	2, 23, 25, 34, 44, 45	15, 2, 27, 33, 34	15, 2, 26, 33, 34
MCPWM0_2A	MCPWM0 Output 2A	O	23, 57, 90	16, 42, 70	16, 42, 68	34, 57, 9	43, 9	42, 9	31	31
MCPWM0_2B	MCPWM0 Output 2B	O	39, 54, 56, 68, 93	32, 39, 41, 53, 73	35, 39, 41, 53, 71	24, 31, 33, 45, 60	24, 36, 46	26, 35, 45	16, 28, 34	17, 27, 34
MCPWM0_3A	MCPWM0 Output 3A	O	24, 59, 91	17, 44, 71	17, 44, 69	10, 36, 58	10, 44	10, 43	32	32
MCPWM0_3B	MCPWM0 Output 3B	O	124, 19, 40, 55, 58, 69	12, 33, 40, 43, 54, 96	12, 36, 40, 43, 54, 96	25, 32, 35, 46, 5, 78	25, 37, 5, 62	27, 36, 5, 62	17, 29, 46, 5	18, 28, 47, 5

Table 5-17. MCPWM1 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM1_1A	MCPWM1 Output 1A	O	109, 121, 80, 88, 99	65, 68, 78, 83, 93	63, 66, 77, 82, 92	52, 55, 65, 70, 75	38, 41, 51, 59	37, 40, 50, 58	39, 43	29, 38, 44
MCPWM1_1B	MCPWM1 Output 1B	O	100, 108, 118, 36, 7	29, 7, 79, 82, 90	32, 7, 78, 81, 89	2, 21, 66, 69, 72	2, 21, 52, 56	2, 23, 51, 55	15, 2, 40	15, 2, 39, 41
MCPWM1_2A	MCPWM1 Output 2A	O	123, 81, 98	66, 77, 95	64, 76, 95	53, 64, 77	39, 50, 61	38, 49, 61	38, 45	37, 46
MCPWM1_2B	MCPWM1 Output 2B	O	101, 119, 39	32, 80, 91	35, 79, 90	24, 67, 73	24, 53, 57	26, 52, 56	16, 41	17, 40, 42
MCPWM1_3A	MCPWM1 Output 3A	O	124, 87	67, 96	65, 96	54, 78	40, 62	39, 62	46	47
MCPWM1_3B	MCPWM1 Output 3B	O	102, 120, 40	33, 81, 92	36, 80, 91	25, 68, 74	25, 54, 58	27, 53, 57	17, 42	18, 43

Table 5-18. MCPWM2 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM2_1A	MCPWM2 Output 1A	O	1, 10, 126, 41, 49, 52	1, 34, 98	1, 37, 98	26	26	28	18	19
MCPWM2_1B	MCPWM2 Output 1B	O	11, 125, 3, 34, 40, 82, 85	27, 3, 33, 97	3, 30, 36, 97	19, 25	19, 25	21, 27	13, 17	13, 18
MCPWM2_2A	MCPWM2 Output 2A	O	121, 15, 2, 24, 50, 74, 92	17, 2, 59, 72, 93	17, 2, 59, 70, 92	10, 59, 75	10, 45, 59	10, 44, 58	33, 43	33, 44
MCPWM2_2B	MCPWM2 Output 2B	O	122, 14, 4, 75, 83, 93	4, 60, 73, 94	4, 60, 71, 93	60, 76	46, 60	45, 59	34, 44	34, 45
MCPWM2_3A	MCPWM2 Output 3A	O	123, 26, 51, 76, 87, 96	19, 61, 67, 76, 95	61, 65, 72, 95	54, 63, 77	40, 49, 61	39, 46, 61	37, 45	36, 46

Table 5-18. MCPWM2 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM2_3B	MCPWM2 Output 3B	O	124, 5, 77, 84, 97	5, 62, 96	5, 62, 73, 96	78	62	62	46	47

Table 5-19. MCPWM3 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM3_1A	MCPWM3 Output 1A	O	1, 10, 106, 119, 123, 125, 126, 17, 27, 29, 35, 41, 49, 52, 68, 82, 87, 89, 93, 97, 99	1, 10, 20, 22, 28, 34, 53, 67, 69, 73, 78, 91, 95, 97, 98	1, 23, 25, 31, 37, 53, 65, 67, 71, 73, 77, 90, 95, 97, 98	12, 14, 20, 26, 45, 54, 56, 60, 65, 73, 77	12, 14, 20, 26, 36, 40, 42, 46, 51, 57, 61	14, 16, 22, 28, 35, 39, 41, 45, 50, 56, 61	10, 14, 18, 28, 30, 34, 39, 41, 45, 8	10, 14, 19, 27, 30, 34, 38, 42, 46, 8
MCPWM3_1B	MCPWM3 Output 1B	O	102, 107, 11, 121, 125, 15, 16, 28, 29, 3, 34, 40, 69, 7, 82, 83, 85, 88, 90, 96	21, 22, 27, 3, 33, 54, 68, 7, 70, 76, 81, 93, 97	24, 25, 3, 30, 36, 54, 66, 68, 7, 72, 80, 92, 97	13, 14, 19, 2, 25, 46, 55, 57, 63, 68, 75	13, 14, 19, 2, 25, 37, 41, 43, 49, 54, 59	15, 16, 2, 21, 27, 36, 40, 42, 46, 53, 58	10, 13, 17, 2, 29, 31, 37, 43, 9	10, 13, 18, 2, 28, 31, 36, 44, 9
MCPWM3_2A	MCPWM3 Output 2A	O	109, 121, 15, 16, 18, 2, 24, 28, 32, 50, 54, 69, 74, 84, 91	11, 17, 2, 21, 25, 39, 54, 59, 71, 83, 93	17, 2, 24, 26, 39, 54, 59, 69, 82, 92	10, 13, 17, 31, 46, 58, 70, 75	10, 13, 17, 37, 44, 59	10, 15, 17, 36, 43, 58	11, 29, 32, 43, 9	11, 28, 32, 44, 9
MCPWM3_2B	MCPWM3 Output 2B	O	100, 108, 122, 14, 17, 19, 32, 4, 55, 75, 83, 85, 92, 93	10, 12, 25, 4, 40, 60, 72, 73, 79, 82, 94	12, 26, 4, 40, 60, 70, 71, 78, 81, 93	17, 32, 5, 59, 60, 66, 69, 76	17, 45, 46, 5, 52, 60	17, 44, 45, 5, 51, 59	11, 33, 34, 44, 5	11, 33, 34, 39, 45, 5
MCPWM3_3A	MCPWM3 Output 3A	O	117, 120, 123, 124, 126, 23, 26, 29, 35, 36, 51, 57, 62, 66, 76, 80, 86, 87, 90, 96, 98	16, 19, 22, 28, 29, 42, 47, 51, 61, 65, 67, 70, 76, 77, 89, 92, 95, 96, 98	16, 25, 31, 32, 42, 47, 51, 61, 63, 65, 68, 72, 76, 88, 91, 95, 96, 98	14, 20, 21, 34, 39, 43, 52, 54, 57, 63, 64, 74, 77, 78, 9	14, 20, 21, 30, 34, 38, 40, 43, 49, 50, 58, 61, 62, 9	16, 22, 23, 29, 33, 37, 39, 42, 46, 49, 57, 61, 62, 9	10, 14, 15, 22, 26, 31, 37, 38, 42, 45, 46	10, 14, 15, 22, 25, 29, 31, 36, 37, 43, 46, 47
MCPWM3_3B	MCPWM3 Output 3A	O	116, 121, 122, 124, 32, 36, 39, 5, 56, 65, 67, 68, 77, 81, 84, 87, 88, 91, 93, 97	25, 29, 32, 41, 5, 50, 52, 53, 62, 66, 67, 68, 71, 73, 88, 93, 94, 96	26, 32, 35, 41, 5, 52, 53, 62, 64, 65, 66, 69, 71, 73, 87, 92, 93, 96	17, 21, 24, 33, 42, 44, 45, 53, 54, 55, 58, 60, 75, 76, 78	17, 21, 24, 33, 35, 36, 39, 40, 41, 44, 46, 59, 60, 62	17, 23, 26, 34, 35, 38, 39, 40, 43, 45, 58, 59, 62	11, 15, 16, 25, 27, 28, 32, 34, 43, 44, 46	11, 15, 17, 24, 26, 27, 32, 34, 44, 45, 47

Table 5-20. MCPWM4 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
MCPWM4_1A	MCPWM4 Output 1A	O	113, 124, 126, 22, 25, 27, 3, 34, 36, 39, 55, 60, 61, 66, 68, 86, 89, 92	15, 18, 20, 27, 29, 3, 32, 40, 45, 46, 51, 53, 69, 72, 85, 96, 98	15, 18, 23, 3, 30, 32, 35, 40, 45, 46, 51, 53, 67, 70, 84, 96, 98	11, 12, 19, 21, 24, 32, 37, 38, 43, 45, 56, 59, 78, 8	11, 12, 19, 21, 24, 34, 36, 42, 45, 62, 8	11, 14, 21, 23, 26, 33, 35, 41, 44, 62, 8	13, 15, 16, 26, 28, 30, 33, 46, 8	13, 15, 17, 25, 27, 30, 33, 47, 8
MCPWM4_1B	MCPWM4 Output 1B	O	102, 114, 118, 120, 122, 28, 36, 38, 4, 40, 54, 60, 67, 69, 92, 93	21, 29, 31, 33, 39, 4, 45, 52, 54, 72, 73, 81, 86, 90, 92, 94	24, 32, 34, 36, 39, 4, 45, 52, 54, 70, 71, 80, 85, 89, 91, 93	13, 21, 23, 25, 31, 37, 44, 46, 59, 60, 68, 72, 74, 76	13, 21, 23, 25, 35, 37, 45, 46, 54, 56, 58, 60	15, 23, 25, 27, 34, 36, 44, 45, 53, 55, 57, 59	15, 17, 27, 29, 33, 34, 40, 42, 44, 9	15, 18, 26, 28, 33, 34, 41, 43, 45, 9
MCPWM4_2A	MCPWM4 Output 2A	O	106, 117, 119, 121, 123, 125, 15, 17, 2, 23, 24, 27, 29, 35, 41, 50, 57, 62, 68, 74, 80, 82, 87, 88, 89, 90, 92, 93, 97, 99	10, 16, 17, 2, 20, 22, 28, 34, 42, 47, 53, 59, 65, 67, 68, 69, 70, 72, 73, 78, 89, 91, 93, 95, 97	16, 17, 2, 23, 25, 31, 37, 42, 47, 53, 59, 63, 65, 66, 67, 68, 70, 71, 73, 77, 88, 90, 92, 95, 97	10, 12, 14, 20, 26, 34, 39, 45, 52, 54, 55, 56, 57, 59, 60, 65, 73, 75, 77, 9	10, 12, 14, 20, 26, 30, 36, 38, 40, 41, 42, 43, 45, 46, 51, 57, 59, 61, 9	10, 14, 16, 22, 28, 29, 35, 37, 39, 40, 41, 42, 44, 45, 50, 56, 58, 61, 9	10, 14, 18, 22, 28, 30, 31, 33, 34, 39, 41, 43, 45, 8	10, 14, 19, 22, 27, 29, 30, 31, 33, 34, 38, 42, 44, 46, 8
MCPWM4_2B	MCPWM4 Output 2B	O	102, 107, 116, 118, 121, 122, 14, 28, 29, 32, 36, 39, 4, 56, 65, 68, 69, 7, 75, 83, 88, 90, 91, 93, 96	21, 22, 25, 29, 32, 4, 41, 50, 53, 54, 60, 68, 7, 70, 71, 73, 76, 81, 88, 90, 93, 94	24, 25, 26, 32, 35, 4, 41, 53, 54, 60, 66, 68, 69, 7, 71, 72, 80, 87, 89, 92, 93	13, 14, 17, 2, 21, 24, 33, 42, 45, 46, 55, 57, 58, 60, 63, 68, 72, 75, 76	13, 14, 17, 2, 21, 24, 33, 36, 37, 41, 43, 44, 46, 49, 54, 56, 59, 60	15, 16, 17, 2, 23, 26, 35, 36, 40, 42, 43, 45, 46, 53, 55, 58, 59	10, 11, 15, 16, 2, 25, 28, 29, 31, 32, 34, 37, 40, 43, 44, 9	10, 11, 15, 17, 2, 24, 27, 28, 31, 32, 34, 36, 41, 44, 45, 9
MCPWM4_3A	MCPWM4 Output 3A	O	1, 117, 119, 120, 123, 124, 24, 26, 29, 36, 51, 59, 62, 76, 81, 86, 87, 91, 96	1, 17, 19, 22, 29, 44, 47, 61, 66, 67, 71, 76, 89, 91, 92, 95, 96	1, 17, 25, 32, 44, 47, 61, 64, 65, 69, 72, 88, 90, 91, 95, 96	10, 14, 21, 36, 39, 53, 54, 58, 63, 73, 74, 77, 78	10, 14, 21, 30, 39, 40, 44, 49, 57, 58, 61, 62	10, 16, 23, 29, 38, 39, 43, 46, 56, 57, 61, 62	10, 15, 22, 32, 37, 41, 42, 45, 46	10, 15, 22, 32, 36, 42, 43, 46, 47
MCPWM4_3B	MCPWM4 Output 3B	O	116, 119, 120, 121, 122, 124, 19, 2, 33, 39, 40, 58, 67, 69, 77, 80, 84, 87, 97	12, 2, 26, 32, 33, 43, 52, 54, 62, 65, 67, 88, 91, 92, 93, 94, 96	12, 2, 29, 35, 36, 43, 52, 54, 62, 63, 65, 73, 87, 90, 91, 92, 93, 96	18, 24, 25, 35, 44, 46, 5, 52, 54, 73, 74, 75, 76, 78	18, 24, 25, 35, 37, 38, 40, 5, 57, 58, 59, 60, 62	20, 26, 27, 34, 36, 37, 39, 5, 56, 57, 58, 59, 62	12, 16, 17, 27, 29, 41, 42, 43, 44, 46, 5	12, 17, 18, 26, 28, 29, 42, 43, 44, 45, 47, 5

Table 5-21. NC Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
NC	No Connect	NC			48			30		

Table 5-22. OUTPUTXBAR Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
OUTPUTXBAR1	Output X-BAR Output (Group 1)	O	1, 107, 117, 125, 18, 36, 39, 53, 61, 76, 8, 86, 99	1, 11, 29, 32, 38, 46, 61, 78, 8, 89, 97	1, 32, 35, 38, 46, 61, 77, 8, 88, 97	21, 24, 3, 30, 38, 65	21, 24, 3, 51	23, 26, 3, 50	15, 16, 3, 39	15, 17, 3, 38
OUTPUTXBAR2	Output X-BAR Output (Group 2)	O	100, 108, 118, 126, 19, 2, 37, 40, 54, 62, 69, 77, 87, 9, 97	12, 2, 30, 33, 39, 47, 54, 62, 67, 79, 82, 9, 90, 98	12, 2, 33, 36, 39, 47, 54, 62, 65, 73, 78, 81, 89, 9, 98	22, 25, 31, 39, 4, 46, 5, 54, 66, 69, 72	22, 25, 30, 37, 4, 40, 5, 52, 56	24, 27, 29, 36, 39, 4, 5, 51, 55	17, 22, 29, 4, 40, 5	16, 18, 22, 28, 39, 4, 41, 5
OUTPUTXBAR3	Output X-BAR Output (Group 3)	O	10, 101, 109, 119, 20, 3, 38, 41, 55, 65, 70, 80, 88, 89	13, 3, 31, 34, 40, 50, 55, 65, 68, 69, 80, 83, 91	13, 3, 34, 37, 40, 55, 63, 66, 67, 79, 82, 90	23, 26, 32, 42, 47, 52, 55, 56, 6, 67, 70, 73	23, 26, 33, 38, 41, 42, 53, 57, 6	25, 28, 37, 40, 41, 52, 56, 6	18, 25, 30, 41, 6	19, 24, 29, 30, 40, 42, 6
OUTPUTXBAR4	Output X-BAR Output (Group 4)	O	102, 11, 112, 120, 28, 4, 48, 56, 66, 71, 81, 90	21, 4, 41, 51, 56, 66, 70, 81, 84, 92	24, 4, 41, 51, 56, 64, 68, 80, 83, 91	13, 33, 43, 48, 53, 57, 68, 71, 74	13, 34, 39, 43, 54, 55, 58	15, 33, 38, 42, 53, 54, 57	26, 31, 42, 9	25, 31, 43, 9
OUTPUTXBAR5	Output X-BAR Output (Group 5)	O	103, 113, 121, 14, 22, 29, 49, 5, 57, 67, 72, 82, 92	15, 22, 42, 5, 52, 57, 72, 85, 93	15, 25, 42, 5, 52, 57, 70, 84, 92	14, 34, 44, 49, 59, 75, 8	14, 35, 45, 59, 8	16, 34, 44, 58, 8	10, 27, 33, 43	10, 26, 33, 44
OUTPUTXBAR6	Output X-BAR Output (Group 6)	O	104, 114, 122, 15, 23, 32, 33, 50, 58, 68, 7, 73, 83, 93	16, 25, 26, 43, 53, 58, 7, 73, 86, 94	16, 26, 29, 43, 53, 58, 7, 71, 85, 93	17, 18, 2, 35, 45, 60, 76, 9	17, 18, 2, 36, 46, 60, 9	17, 2, 20, 35, 45, 59, 9	11, 12, 2, 28, 34, 44	11, 12, 2, 27, 34, 45
OUTPUTXBAR7	Output X-BAR Output (Group 7)	O	105, 115, 123, 124, 16, 24, 26, 34, 51, 59, 74, 84, 96	17, 19, 27, 44, 59, 76, 87, 95, 96	17, 30, 44, 59, 72, 86, 95, 96	10, 19, 36, 63, 77, 78	10, 19, 49, 61, 62	10, 21, 46, 61, 62	13, 37, 45, 46	13, 36, 46, 47
OUTPUTXBAR8	Output X-BAR Output (Group 8)	O	106, 116, 17, 25, 27, 35, 52, 60, 75, 85, 91, 98	10, 18, 20, 28, 45, 60, 71, 77, 88	18, 23, 31, 45, 60, 69, 76, 87, 94	11, 12, 20, 37, 58, 64	11, 12, 20, 44, 50	11, 14, 22, 43, 49, 60	14, 32, 38, 8	14, 32, 37, 8

Table 5-23. PGA0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
PGA0_OUT	PGA0 Output	A	29	22	25	14	14	16	10	10
PGA0_M0	PGA0 Negative (-) Input 0	A	32	25	26	17	17	17	11	11
PGA0_M1	PGA0 Negative (-) Input 1	A	38	31	34	23	23	25		
PGA0_M2	PGA0 Negative (-) Input 2	A	62	47	47	39	30	29	22	22
PGA0_M3	PGA0 Negative (-) Input 3	A	70	55	55	47				
PGA0_P0	PGA0 Positive (+) Input 0	A	25	18	18	11	11	11		

Table 5-23. PGA0 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
PGA0_P1	PGA0 Positive (+) Input 1	A	28	21	24	13	13	15	9	9
PGA0_P2	PGA0 Positive (+) Input 2	A	32	25	26	17	17	17	11	11
PGA0_P3	PGA0 Positive (+) Input 3	A	36	29	32	21	21	23	15	15
PGA0_P4	PGA0 Positive (+) Input 4	A	65	50		42	33		25	24
PGA0_P5	PGA0 Positive (+) Input 5	A	67	52	52	44	35	34	27	26
PGA0_P6	PGA0 Positive (+) Input 6	A	73	58	58					
PGA0_P7	PGA0 Positive (+) Input 7	A	66	51	51	43	34	33	26	25
PGA0_P8	PGA0 Positive (+) Input 8	A	74	59	59					

Table 5-24. PGA1 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
PGA1_OUT	PGA1 Output	A	35	28	31	20	20	22	14	14
PGA1_M0	PGA1 Negative (-) Input 0	A	28	21	24	13	13	15	9	9
PGA1_M1	PGA1 Negative (-) Input 1	A	34	27	30	19	19	21	13	13
PGA1_M2	PGA1 Negative (-) Input 2	A	38	31	34	23	23	25		
PGA1_M3	PGA1 Negative (-) Input 3	A	40	33	36	25	25	27	17	18
PGA1_P0	PGA1 Positive (+) Input 0	A	25	18	18	11	11	11		
PGA1_P1	PGA1 Positive (+) Input 1	A	36	29	32	21	21	23	15	15
PGA1_P2	PGA1 Positive (+) Input 2	A	39	32	35	24	24	26	16	17
PGA1_P3	PGA1 Positive (+) Input 3	A	66	51	51	43	34	33	26	25
PGA1_P4	PGA1 Positive (+) Input 4	A	67	52	52	44	35	34	27	26
PGA1_P5	PGA1 Positive (+) Input 5	A	68	53	53	45	36	35	28	27
PGA1_P6	PGA1 Positive (+) Input 6	A	71	56	56	48				
PGA1_P7	PGA1 Positive (+) Input 7	A	76	61	61					
PGA1_P8	PGA1 Positive (+) Input 8	A	73	58	58					

Table 5-25. PGA2 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
PGA2_OUT	PGA2 Output	A	40	33	36	25	25	27	17	18
PGA2_M0	PGA2 Negative (-) Input 0	A	32	25	26	17	17	17	11	11
PGA2_M1	PGA2 Negative (-) Input 1	A	41	34	37	26	26	28	18	19
PGA2_M2	PGA2 Negative (-) Input 2	A	62	47	47	39	30	29	22	22
PGA2_M3	PGA2 Negative (-) Input 3	A	69	54	54	46	37	36	29	28

Table 5-25. PGA2 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
PGA2_P0	PGA2 Positive (+) Input 0	A	65	50		42	33		25	24
PGA2_P1	PGA2 Positive (+) Input 1	A	25	18	18	11	11	11		
PGA2_P2	PGA2 Positive (+) Input 2	A	28	21	24	13	13	15	9	9
PGA2_P3	PGA2 Positive (+) Input 3	A	39	32	35	24	24	26	16	17
PGA2_P4	PGA2 Positive (+) Input 4	A	67	52	52	44	35	34	27	26
PGA2_P5	PGA2 Positive (+) Input 5	A	68	53	53	45	36	35	28	27
PGA2_P6	PGA2 Positive (+) Input 6	A	74	59	59					
PGA2_P7	PGA2 Positive (+) Input 7	A	71	56	56	48				
PGA2_P8	PGA2 Positive (+) Input 8	A	73	58	58					

Table 5-26. POWER Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
VDD	3.3V Digital Power Pin	PWR	111, 128, 13, 47, 6, 64, 79, 95	100, 49, 6, 64, 75	100, 11, 50, 6, 75	1, 41, 51, 62, 80	1, 32, 48, 64	1, 32, 48, 64	1, 24, 36, 48	1, 23, 35, 48
VDDA	3.3V Analog Power Pin	APWR	31, 45	24, 37	28	16, 29	16, 29	19	21	21

Table 5-27. SYSCTL Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
NRST	Device Reset (NRST)	RST	21	14	14	7	7	7	7	7
SYSCTL_FCC_IN	Frequency Clock Counter (FCC) Input Signal	I	1, 10, 39, 67, 7, 96	1, 32, 52, 7, 76	1, 35, 52, 7, 72	2, 24, 44, 63	2, 24, 35, 49	2, 26, 34, 46	16, 2, 27, 37	17, 2, 26, 36
SYSCTL_HFCLKIN	External Clock Input	A	19, 32	12, 25	12, 26	17, 5	17, 5	17, 5	11, 5	11, 5
SYSCTL_X1	Crystal (XTAL) Input (X1) or Single-ended Clock Input	A	19	12	12	5	5	5	5	5
SYSCTL_X2	Crystal (XTAL) Output (X2)	A	20	13	13	6	6	6	6	6
SYSCTL_XCLKOUT	External Clock Output. This pin outputs an (optionally) divided-down version of a chosen clock signal from within the device.	O	18, 33, 65, 7, 8	11, 26, 50, 7, 8	29, 7, 8	18, 2, 3, 42	18, 2, 3, 33	2, 20, 3	12, 2, 25, 3	12, 2, 24, 3

Table 5-28. TIMER Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
TIMG12_0_CCP0	TIMG12_0 Capture/Compare0 Signal	IO	27, 32, 62, 66	20, 25, 47, 51	23, 26, 47, 51	12, 17, 39, 43	12, 17, 30, 34	14, 17, 29, 33	11, 22, 26, 8	11, 22, 25, 8

Table 5-28. TIMER Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
TIMG12_0_CCP1	TIMG12_0 Capture/Compare1 Signal	IO	28, 33, 65, 67	21, 26, 50, 52	24, 29, 52	13, 18, 42, 44	13, 18, 33, 35	15, 20, 34	12, 25, 27, 9	12, 24, 26, 9
TIMG4_0_CCP0	TIMG4_0 Capture/Compare0 Signal	IO	27, 32, 62, 66, 72, 74, 76	20, 25, 47, 51, 57, 59, 61	23, 26, 47, 51, 57, 59, 61	12, 17, 39, 43, 49	12, 17, 30, 34	14, 17, 29, 33	11, 22, 26, 8	11, 22, 25, 8
TIMG4_0_CCP1	TIMG4_0 Capture/Compare1 Signal	IO	28, 33, 65, 67, 73, 75, 77	21, 26, 50, 52, 58, 60, 62	24, 29, 52, 58, 60, 62	13, 18, 42, 44	13, 18, 33, 35	15, 20, 34	12, 25, 27, 9	12, 24, 26, 9

Table 5-29. TRACE Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
TRACE_CLK	Trace Clock	IO	1, 101	1, 80	1, 79	67	53	52		40
TRACE_DATA0	Trace Data 0	O	126, 2	2, 98	2, 98					
TRACE_DATA1	Trace Data 1	O	3, 87	3, 67	3, 65	54	40	39		
TRACE_DATA2	Trace Data 2	O	112, 4	4, 84	4, 83	71	55	54		
TRACE_DATA3	Trace Data 3	O	102, 5	5, 81	5, 80	68	54	53		

Table 5-30. UC0 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC0_RTS_POCI	UNICOMM0 RTS: UART Release To Send POCI: SPI Peripheral Out - Controller In	O	103, 104, 119, 2, 28, 3, 33, 35, 40, 53, 57, 66, 68, 74, 93, 97, 99	2, 21, 26, 28, 3, 33, 38, 42, 51, 53, 59, 73, 78, 91	2, 24, 29, 3, 31, 36, 38, 42, 51, 53, 59, 71, 73, 77, 90	13, 18, 20, 25, 30, 34, 43, 45, 60, 65, 73	13, 18, 20, 25, 34, 36, 46, 51, 57	15, 20, 22, 27, 33, 35, 45, 50, 56	12, 14, 17, 26, 28, 34, 39, 41, 9	12, 14, 18, 25, 27, 34, 38, 42, 9
UC0_RX_SCL_SCLK	UNICOMM0 RX: UART Receive SCL: I2C Clock SCLK: SPI Clock	IO	1, 10, 100, 101, 102, 105, 106, 112, 118, 120, 122, 123, 124, 126, 22, 32, 34, 38, 51, 58, 61, 62, 65, 84, 87, 89, 9, 91, 96, 99	1, 15, 25, 27, 31, 43, 46, 47, 50, 67, 69, 71, 76, 78, 79, 80, 81, 84, 9, 90, 92, 94, 95, 96, 98	1, 15, 26, 30, 34, 43, 46, 47, 65, 67, 69, 72, 77, 78, 79, 80, 83, 89, 9, 91, 93, 95, 96, 98	17, 19, 23, 35, 38, 39, 4, 42, 54, 56, 58, 63, 65, 66, 67, 68, 71, 72, 74, 76, 77, 78, 8	17, 19, 23, 30, 33, 4, 40, 42, 44, 49, 51, 52, 53, 54, 55, 56, 58, 60, 61, 62, 8	17, 21, 25, 29, 39, 4, 41, 43, 46, 50, 51, 52, 53, 54, 55, 57, 59, 61, 62, 8	11, 13, 22, 25, 30, 32, 37, 39, 4, 40, 42, 44, 45, 46	11, 13, 22, 24, 30, 32, 36, 38, 39, 4, 40, 41, 43, 45, 46, 47
UC0_TX_SDA_PICO	UNICOMM0 TX: UART Transmit SDA: I2C Data PICO: SPI Peripheral In - Controller Out	O	100, 101, 102, 105, 106, 107, 11, 112, 120, 121, 122, 123, 124, 125, 23, 29, 36, 37, 5, 52, 60, 61, 62, 65, 8, 86, 88, 90, 98	16, 22, 29, 30, 45, 46, 47, 5, 50, 68, 70, 77, 79, 8, 80, 81, 84, 92, 93, 94, 95, 96, 97	16, 25, 32, 33, 45, 46, 47, 5, 66, 68, 76, 78, 79, 8, 80, 83, 91, 92, 93, 95, 96, 97	14, 21, 22, 3, 37, 38, 39, 42, 55, 57, 64, 66, 67, 68, 71, 74, 75, 76, 77, 78, 9	14, 21, 22, 3, 30, 33, 41, 43, 50, 52, 53, 54, 55, 58, 59, 60, 61, 62, 9	16, 23, 24, 29, 3, 40, 42, 49, 51, 52, 53, 54, 57, 58, 59, 61, 62, 9	10, 15, 22, 25, 3, 31, 38, 42, 43, 44, 45, 46	10, 15, 16, 22, 24, 3, 31, 37, 39, 40, 43, 44, 45, 46, 47

Table 5-30. UC0 Signal Descriptions (continued)

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC0_CTS_CS0	UNICOMM0 CTS: UART Clear To Send CS0: SPI Chip Select 0	IO	101, 103, 119, 120, 27, 35, 4, 50, 59, 66, 67, 73, 85, 92, 96	20, 28, 4, 44, 51, 52, 58, 72, 76, 80, 91, 92	23, 31, 4, 44, 51, 52, 58, 70, 72, 79, 90, 91	12, 20, 36, 43, 44, 59, 63, 67, 73, 74	12, 20, 34, 35, 45, 49, 53, 57, 58	14, 22, 33, 34, 44, 46, 52, 56, 57	14, 26, 27, 33, 37, 41, 42, 8	14, 25, 26, 33, 36, 40, 42, 43, 8

Table 5-31. UC1 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC1_RTS_POCI	UNICOMM1 RTS: UART Release To Send POCI: SPI Peripheral Out - Controller In	O	104, 114, 15, 19, 28, 66, 77	12, 21, 51, 62, 86	12, 24, 51, 62, 85	13, 43, 5	13, 34, 5	15, 33, 5	26, 5, 9	25, 5, 9
UC1_RX_SCL_SCLK	UNICOMM1 RX: UART Receive SCL: I2C Clock SCLK: SPI Clock	IO	106, 11, 116, 119, 17, 18, 20, 28, 32, 37, 90, 97, 99	10, 11, 13, 21, 25, 30, 70, 78, 88, 91	13, 24, 26, 33, 68, 73, 77, 87, 90	13, 17, 22, 57, 6, 65, 73	13, 17, 22, 43, 51, 57, 6	15, 17, 24, 42, 50, 56, 6	11, 31, 39, 41, 6, 9	11, 16, 31, 38, 42, 6, 9
UC1_TX_SDA_PICO	UNICOMM1 TX: UART Transmit SDA: I2C Data PICO: SPI Peripheral In - Controller Out	O	10, 105, 115, 118, 19, 27, 29, 68, 89, 91, 98	12, 20, 22, 53, 69, 71, 77, 87, 90	12, 23, 25, 53, 67, 69, 76, 86, 89	12, 14, 45, 5, 56, 58, 64, 72	12, 14, 36, 42, 44, 5, 50, 56	14, 16, 35, 41, 43, 49, 5, 55	10, 28, 30, 32, 38, 40, 5, 8	10, 27, 30, 32, 37, 41, 5, 8
UC1_CTS_CS0	UNICOMM1 CTS: UART Clear To Send CS0: SPI Chip Select 0	IO	103, 113, 122, 16, 27, 69, 92	20, 54, 72, 85, 94	23, 54, 70, 84, 93	12, 46, 59, 76	12, 37, 45, 60	14, 36, 44, 59	29, 33, 44, 8	28, 33, 45, 8

Table 5-32. UC2 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC2_CTS	UNICOMM2 CTS: UART Clear To Send	O	112, 17, 73, 83, 87, 98	10, 58, 67, 77, 84	58, 65, 76, 83	54, 64, 71	40, 50, 55	39, 49, 54	38	37
UC2_RTS	UNICOMM2 RTS: UART Release To Send	O	113, 18, 33, 74, 82, 88, 90, 99	11, 26, 59, 68, 70, 78, 85	29, 59, 66, 68, 77, 84	18, 55, 57, 65	18, 41, 43, 51	20, 40, 42, 50	12, 31, 39	12, 31, 38
UC2_RX_SCL	UNICOMM2 RX: UART Receive SCL: I2C Clock	IO	1, 101, 107, 109, 122, 15, 18, 20, 27, 51, 53, 70, 75, 76, 80, 85, 91	1, 11, 13, 20, 38, 55, 60, 61, 65, 71, 80, 83, 94	1, 13, 23, 38, 55, 60, 61, 63, 69, 79, 82, 93	12, 30, 47, 52, 58, 6, 67, 70, 76	12, 38, 44, 53, 6, 60	14, 37, 43, 52, 59, 6	32, 44, 6, 8	29, 32, 40, 45, 6, 8
UC2_TX_SDA	UNICOMM2 TX: UART Transmit SDA: I2C Data	O	100, 108, 121, 16, 17, 19, 2, 28, 52, 54, 71, 75, 76, 81, 86, 92	10, 12, 2, 21, 39, 56, 60, 61, 66, 72, 79, 82, 93	12, 2, 24, 39, 56, 60, 61, 64, 70, 78, 81, 92	13, 31, 48, 5, 53, 59, 66, 69, 75	13, 39, 45, 5, 52, 59	15, 38, 44, 5, 51, 58	33, 43, 5, 9	33, 39, 44, 5, 9

Table 5-33. UC3 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC3_RTS_POCI	UNICOMM3 RTS: UART Release To Send POCI: SPI Peripheral Out - Controller In	O	119, 2, 3, 33, 35, 40, 57, 74, 93, 97, 99	2, 26, 28, 3, 33, 42, 59, 73, 78, 91	2, 29, 3, 31, 36, 42, 59, 71, 73, 77, 90	18, 20, 25, 34, 60, 65, 73	18, 20, 25, 46, 51, 57	20, 22, 27, 45, 50, 56	12, 14, 17, 34, 39, 41	12, 14, 18, 34, 38, 42
UC3_RX_SCL_SCLK	UNICOMM3 RX: UART Receive SCL: I2C Clock SCLK: SPI Clock	IO	1, 100, 101, 102, 105, 112, 118, 120, 122, 123, 124, 126, 22, 34, 38, 58, 61, 62, 65, 84, 87, 89, 9, 96	1, 15, 27, 31, 43, 46, 47, 50, 67, 69, 76, 79, 80, 81, 84, 9, 90, 92, 94, 95, 96, 98	1, 15, 30, 34, 43, 46, 47, 65, 67, 72, 78, 79, 80, 83, 89, 9, 91, 93, 95, 96, 98	19, 23, 35, 38, 39, 4, 42, 54, 56, 63, 66, 67, 68, 71, 72, 74, 76, 77, 78, 8	19, 23, 30, 33, 4, 40, 42, 49, 52, 53, 54, 55, 56, 58, 60, 61, 62, 8	21, 25, 29, 39, 4, 41, 46, 51, 52, 53, 54, 55, 57, 59, 61, 62, 8	13, 22, 25, 30, 37, 4, 40, 42, 44, 45, 46	13, 22, 24, 30, 36, 39, 4, 40, 41, 43, 45, 46, 47
UC3_TX_SDA_PICO	UNICOMM3 TX: UART Transmit SDA: I2C Data PICO: SPI Peripheral In - Controller Out	O	100, 101, 102, 106, 107, 112, 118, 120, 121, 122, 123, 124, 125, 23, 36, 37, 5, 60, 61, 62, 65, 8, 86, 88	16, 29, 30, 45, 46, 47, 5, 50, 68, 79, 8, 80, 81, 84, 90, 92, 93, 94, 95, 96, 97	16, 32, 33, 45, 46, 47, 5, 66, 78, 79, 8, 80, 83, 89, 91, 92, 93, 95, 96, 97	21, 22, 3, 37, 38, 39, 42, 55, 66, 67, 68, 71, 72, 74, 75, 76, 77, 78, 9	21, 22, 3, 30, 33, 41, 52, 53, 54, 55, 56, 58, 59, 60, 61, 62, 9	23, 24, 29, 3, 40, 51, 52, 53, 54, 55, 57, 58, 59, 61, 62, 9	15, 22, 25, 3, 40, 42, 43, 44, 45, 46	15, 16, 22, 24, 3, 39, 40, 41, 43, 44, 45, 46, 47
UC3_CTS_CS0	UNICOMM3 CTS: UART Clear To Send CS0: SPI Chip Select 0	IO	101, 119, 120, 35, 4, 59, 66, 67, 73, 85, 92, 96	28, 4, 44, 51, 52, 58, 72, 76, 80, 91, 92	31, 4, 44, 51, 52, 58, 70, 72, 79, 90, 91	20, 36, 43, 44, 59, 63, 67, 73, 74	20, 34, 35, 45, 49, 53, 57, 58	22, 33, 34, 44, 46, 52, 56, 57	14, 26, 27, 33, 37, 41, 42	14, 25, 26, 33, 36, 40, 42, 43

Table 5-34. UC4 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC4_RTS_POCI	UNICOMM4 RTS: UART Release To Send POCI: SPI Peripheral Out - Controller In	O	114, 15, 19, 66, 68, 77	12, 51, 53, 62, 86	12, 51, 53, 62, 85	43, 45, 5	34, 36, 5	33, 35, 5	26, 28, 5	25, 27, 5
UC4_RX_SCL_SCLK	UNICOMM4 RX: UART Receive SCL: I2C Clock SCLK: SPI Clock	IO	11, 116, 119, 18, 28, 37, 90, 91, 97	11, 21, 30, 70, 71, 88, 91	24, 33, 68, 69, 73, 87, 90	13, 22, 57, 58, 73	13, 22, 43, 44, 57	15, 24, 42, 43, 56	31, 32, 41, 9	16, 31, 32, 42, 9
UC4_TX_SDA_PICO	UNICOMM4 TX: UART Transmit SDA: I2C Data PICO: SPI Peripheral In - Controller Out	O	10, 115, 17, 27, 68, 89, 90, 91	10, 20, 53, 69, 70, 71, 87	23, 53, 67, 68, 69, 86	12, 45, 56, 57, 58	12, 36, 42, 43, 44	14, 35, 41, 42, 43	28, 30, 31, 32, 8	27, 30, 31, 32, 8
UC4_CTS_CS0	UNICOMM4 CTS: UART Clear To Send CS0: SPI Chip Select 0	IO	113, 122, 16, 69, 92	54, 72, 85, 94	54, 70, 84, 93	46, 59, 76	37, 45, 60	36, 44, 59	29, 33, 44	28, 33, 45

Table 5-35. UC5 Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
UC5_CTS	UNICOMM5 CTS: UART Clear To Send	O	10, 112, 17, 73, 83, 88, 98	10, 58, 68, 77, 84	58, 66, 76, 83	55, 64, 71	41, 50, 55	40, 49, 54	38	37
UC5_RTS	UNICOMM5 RTS: UART Release To Send	O	11, 113, 18, 33, 74, 82, 87, 90, 99	11, 26, 59, 67, 70, 78, 85	29, 59, 65, 68, 77, 84	18, 54, 57, 65	18, 40, 43, 51	20, 39, 42, 50	12, 31, 39	12, 31, 38
UC5_RX_SCL	UNICOMM5 RX: UART Receive SCL: I2C Clock	IO	1, 10, 101, 107, 109, 122, 15, 17, 27, 51, 53, 70, 75, 76, 80, 85, 91	1, 10, 20, 38, 55, 60, 61, 65, 71, 80, 83, 94	1, 23, 38, 55, 60, 61, 63, 69, 79, 82, 93	12, 30, 47, 52, 58, 67, 70, 76	12, 38, 44, 53, 60	14, 37, 43, 52, 59	32, 44, 8	29, 32, 40, 45, 8
UC5_TX_SDA	UNICOMM5 TX: UART Transmit SDA: I2C Data	O	100, 108, 11, 121, 16, 18, 2, 28, 52, 54, 71, 75, 76, 81, 86, 92	11, 2, 21, 39, 56, 60, 61, 66, 72, 79, 82, 93	2, 24, 39, 56, 60, 61, 64, 70, 78, 81, 92	13, 31, 48, 53, 59, 66, 69, 75	13, 39, 45, 52, 59	15, 38, 44, 51, 58	33, 43, 9	33, 39, 44, 9

Table 5-36. VREF Signal Descriptions

SIGNAL NAME	DESCRIPTION	TYPE	LQFP128 PIN	LQFP100 G PIN	LQFP100 H PIN	LQFP80 PIN	LQFP64 G PIN	LQFP64 H PIN	LQFP48 PIN	QFN48 PIN
VREFHI	Positive ADC Voltage Reference	AREF	43, 44	36	21, 22	28	28	13	20	20
VREFLO	Negative ADC Voltage Reference	AREF	42	35	20	27	27	12	19	PAD

5.4 Pin Connectivity Requirements

Pin Number	Pin Name	Pin Connectivity Requirements
See DEBUG Signal Descriptions Table	DEBUG_JTCK_SWCLK DEBUG_JTDI DEBUG_JTDO_SWO	Each of these pins must be connected to the corresponding power supply through separate external pull resistors to ensure these balls are held to a valid logic high level if a PCB signal trace is connected and not actively driven by an attached device. The internal pull-up may be used to hold a valid logic high level if no PCB signal trace is connected to the ball.
See ADCCAL Signal Descriptions Table	ADCINCAL0	If all Ax_y inputs for all ADC instances (ADC[0:2]_AIN[0:31]) are not used, the ADCINCAL0 analog pin must be connected (shorted) directly to ground (VSS).
ADC PIN	A[0:2]_[0:31]	Any unused Ax_y input pin for any ADC instance (ADC[0:2]_AIN[0:31]) must be connected (shorted) directly to ground (VSS).
LVC MOS PIN	Any LVC MOS Voltage Buffer Pin	If an associated IOMUX pad configuration register exists for a given pin, it may remain unconnected. After NRST, the LVC MOS voltage buffer is configured to a default state compatible with an unconnected pin.

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ⁽¹⁾ ⁽²⁾

Parameters		MIN	MAX	UNIT
Supply voltage	VDDIO with respect to VSS	−0.3	4.6	V
	VDDA with respect to VSSA	−0.3	4.6	
Input voltage ⁽⁶⁾	V _{IN} (3.3V)	−0.3	4.6	V
Output voltage	V _O	−0.3	4.6	V
Input clamp current - per pin ⁽⁴⁾ ⁽⁵⁾	I _{IK} - V _{IN} < VSS/VSSA - V _{IN} > VDDIO/VDDA	−20	20	mA
Input clamp current - total for all inputs ⁽⁴⁾ ⁽⁵⁾	I _{IKTOTAL} - V _{IN} < VSS/VSSA - V _{IN} > VDDIO/VDDA	−20	20	mA
Output current	Digital output (per pin), I _{OUT}	−20	20	mA
Operating junction temperature	T _J	−40	125	°C
Storage temperature ⁽³⁾	T _{stg}	−65	150	°C

- (1) Operation outside the *Absolute Maximum Ratings* may cause permanent device damage. *Absolute Maximum Ratings* do not imply functional operation of the device at these or any other conditions beyond those listed under *Recommended Operating Conditions*. If used outside the *Recommended Operating Conditions* but within the *Absolute Maximum Ratings*, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime.
- (2) All voltage values are with respect to VSS, unless otherwise noted.
- (3) Long-term high-temperature storage or extended use at maximum temperature conditions may result in a reduction of overall device life. For additional information, see the [Semiconductor and IC Package Thermal Metrics Application Report](#).
- (4) Continuous clamp current per pin is ±2mA. Do not operate in this condition continuously as V_{DDIO}/V_{DDA} voltage may internally rise and impact other electrical specifications.
- (5) Applying a V_{IN} greater than VDDIO/VDDA or less than VSS/VSSA will turn on the ESD current clamping diode causing additional current to flow to the respective supply rail. If this occurs, the current must be kept within the MIN/MAX listed to prevent permanent damage to the device.
- (6) Input clamp current must also be observed.

6.2 ESD Ratings – Commercial

				VALUE	UNIT
AM13E23019, AM13E23018, AM13E23017 in 128-pin PDT TQFP					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 128-pin PDT: 1, 32, 33, 64, 65, 96, 97, 128	±750	
AM13E23019, AM13E23018, AM13E23017 in 100-pin PZ LQFP					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 100-pin PZ: 1, 25, 26, 50, 51, 75, 76, 100	±750	
AM13E23019, AM13E23018, AM13E23017 in 80-pin PN LQFP					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 80-pin PN: 1, 20, 21, 40, 41, 60, 61, 80	±750	
AM13E23019, AM13E23018, AM13E23017 in 64-pin PM LQFP					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 64-pin PM: 1, 16, 17, 32, 33, 48, 49, 64	±750	

				VALUE	UNIT
AM13E23019, AM13E23018, AM13E23017 in 48-pin PT LQFP					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 48-pin PT: 1, 12, 13, 24, 25, 36, 37, 48	±750	
AM13E23019, AM13E23018, AM13E23017 in 48-pin RGZ VQFN					
V _(ESD)	Electrostatic discharge (ESD)	Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾		±2000	V
		Charged-device model (CDM), per ANSI/ESDA/JEDEC JS-002 ⁽²⁾	All pins except corner pins	±500	
			Corner pins on 48-pin RGZ: 1, 12, 13, 24, 25, 36, 37, 48	±750	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

Parameters		MIN	NOM	MAX	UNIT
Device supply voltage, VDDIO and VDDA	Internal BOR enabled ⁽¹⁾	3.1	3.3	3.63	V
	Internal BOR disabled	2.8	3.3	3.63	
Device ground, VSS			0		V
Analog ground, VSSA			0		V
V _{IN}	Digital input voltage ⁽²⁾	VSS – 0.3		VDDIO + 0.3	V
V _{IN}	Analog input voltage ⁽²⁾	VSSA – 0.3		VDDA + 0.3	V
Junction temperature, T _J		–40		125	°C
Free-Air temperature, T _A		–40		105	°C

(1) Internal BOR is enabled by default.

(2) Applying a V_{IN} greater than VDDIO/VDDA or less than VSS/VSSA voltage will internally rise and could impact other electrical characteristics.

6.4 Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
Digital and Analog IO							
V _{OH}	High-level output voltage		I _{OH} = I _{OH} MIN	VDDIO * 0.8			V
			I _{OH} = −100μA	VDDIO − 0.2			
V _{OL}	Low-level output voltage		I _{OL} = I _{OL} MAX			0.4	V
			I _{OL} = 100μA			0.2	
I _{OH}	High-level output source current for all output pins			−4			mA
I _{OL}	Low-level output sink current for all output pins					4	mA
R _{OH}	High-level output impedance for all output pins		VOH=VDDS-0.4V	66			Ω
R _{OL}	Low-level output impedance for all output pins		VOL=0.4V	60			Ω
V _{IH}	High-level input voltage			2.0			V
V _{IL}	Low-level input voltage					0.8	V
V _{HYSTERESIS}	Input hysteresis (AIO)			125			mV
	Input hysteresis (GPIO)			125			
I _{PULLDOWN}	Input current	Pins with pulldown	VDDIO = 3.3V V _{IN} = VDDIO	120			μA
I _{PULLUP}	Input current	Digital inputs with pullup enabled ⁽¹⁾	VDDIO = 3.3V V _{IN} = 0 V	160			μA
R _{PULLDOWN}	Weak pulldown resistance			31			kΩ
R _{PULLUP}	Weak pullup resistance			29			kΩ
I _{LEAK}	Pin leakage	Digital inputs	Pullups and outputs disabled 0 V ≤ V _{IN} ≤ VDDIO			0.1	μA
I _{LEAK}	Pin leakage	Analog pins	Analog drivers disabled 0 V ≤ V _{IN} ≤ VDDA			0.1	μA
C _I	Input capacitance	Digital inputs		2			pF
		Analog pins ⁽²⁾					
VREG and BOR							
VREG, POR, BOR ⁽³⁾							

(1) See Pins With Internal Pullup and Pulldown table for a list of pins with a pullup or pulldown.

(2) The analog pins are specified separately; see the Per-Channel Parasitic Capacitance tables that are in the ADC Input Model section.

(3) See the *Power Management Module (PMM)* section.

6.5 Digital IO

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Electrical Characteristics					

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted)

PARAMETER		TEST CONDITIONS		MIN	TYP	MAX	UNIT
V _{IH}	High level input voltage	All I/O except Reset		0.7*VDD		VDD+0.3	V
		Reset pin		0.85*VDD		VDD+0.3	
V _{IL}	Low level input voltage	All I/O except Reset		-0.3		0.3*VDD	V
		Reset pin		-0.3		0.15*VDD	
V _{HYS}	Hysteresis	All I/O except Reset		0.1*VDD			
		Reset pin		0.3*VDD			
I _{lkg}	High-Z leakage current ⁽²⁾ ⁽³⁾	SDIO				50	nA
		HSIO				200	nA
R _{PU}	Pull up resistance				40		kΩ
R _{PD}	Pull down resistance				40		kΩ
C _I	Input capacitance				5		pF
V _{OH}	High level output voltage	SDIO	VDD≥2.7V, I _{IO} =−6mA VDD≥1.71V, I _{IO} =−2mA	VDD-0.4			V
		HSIO	VDD≥2.7V, DRV=1, I _{IO} =−6mA VDD≥1.71V, DRV=1, I _{IO} =−3mA	VDD-0.4			
			VDD≥2.7V, DRV=0, I _{IO} =−4mA VDD≥1.71V, DRV=0, I _{IO} =−2mA	VDD-0.4			
V _{OL}	Low level output voltage	SDIO	VDD≥2.7V, I _{IO} =6mA VDD≥1.71V, I _{IO} =2mA			0.4	V
		HSIO	VDD≥2.7V, DRV=1, I _{IO} =6mA VDD≥1.71V, DRV=1, I _{IO} =3mA			0.4	
			VDD≥2.7V, DRV=0, I _{IO} =4mA VDD≥1.71V, DRV=0, I _{IO} =2mA			0.4	
Switching Characteristics							
f _{max}	Port output frequency	SDIO ⁽¹⁾	VDD ≥ 2.7V, C _L = 20pF			32	MHz
			VDD ≥ 1.71V, C _L = 20pF			16	
		HSIO	VDD ≥ 2.7V, DRV = 1, C _L = 20pF			40	
			VDD ≥ 2.7V, DRV = 0, C _L = 20pF			32	
			VDD ≥ 1.71V, DRV = 1, C _L = 20pF			24	
			VDD ≥ 1.71V, DRV = 0, C _L = 20pF			16	
t _r , t _f	Output rise/fall time	SDIO	VDD ≥ 2.7V, C _L = 20pF			3.5	ns
			VDD ≥ 1.71V, C _L = 20pF			6.6	
		HSIO	VDD ≥ 2.7V, DRV = 1, C _L = 20pF			1.8	
			VDD ≥ 2.7V, DRV = 0, C _L = 20pF			5.9	
			VDD ≥ 1.71V, DRV = 1, C _L = 20pF			3.7	
			VDD ≥ 1.71V, DRV = 0, C _L = 20pF			12.6	

(1) The sum of the $|I_{IO}|$ current sourced or sunk by the device must always respect the absolute maximum rating

(2) The leakage current is measured with VSS or VDD applied to the corresponding pin(s), unless otherwise noted.

(3) The leakage of the digital port pins is measured individually. The port pin is selected for input and the pullup/pulldown resistor is disabled.

6.6 Analog Peripherals

The analog subsystem module is described in this section.

The analog modules on this device includes 3 Analog-to-Digital Converters(ADC), 1 Temperature Sensor, 3 Programmable Gain Amplifiers (PGA), and 4 Comparator Subsystems (CMPSS).

The analog subsystem has the following features:

- Flexible voltage references
 - The ADC is referenced to VREFHI and VREFLO pins.
 - VREFHI pin voltage can be driven in externally or can be generated by an internal bandgap voltage reference
 - The internal voltage reference range can be selected to be 0V to 2.5V
 - The comparator DACs are referenced to VDDA and VSSA
- Flexible pin usage
 - Low comparator DAC (COMPDACOUT) can optionally be brought out to a multiplexed ADC pin for external use (mutually exclusive with use of CMPSS compare functions and only available on some CMPSS instances)
 - Internal connection to VREFLO on ADC for offset self-calibration

6.6.1 Analog-to-Digital Converter (ADC)

The ADC module described here is a successive approximation (SAR) style ADC with resolution of 12 bits. This section refers to the analog circuits of the converter as the “core,” and includes the channel-select MUX, the sample-and-hold (S/H) circuit, the successive approximation circuits, voltage reference circuits, and other analog support circuits. The digital circuits of the converter are referred to as the “wrapper” and include logic for programmable conversions, result registers, interfaces to analog circuits, interfaces to the peripheral buses, post-processing circuits, and interfaces to other on-chip modules.

Each ADC module consists of a single sample-and-hold (S/H) circuit. The ADC module is designed to be duplicated multiple times on the same chip, allowing simultaneous sampling or independent operation of multiple ADCs. The ADC wrapper is start-of-conversion (SOC)-based.

Each ADC has the following features:

- Resolution of 12 bits
- Ratiometric external reference set by VREFHI/VREFLO
- Selectable internal reference of 2.5 V or 3.3 V
- Single-ended signal mode
- Input multiplexer with up to 32 channels
- 16 configurable SOC's controlled by sequencers (SEQ[0:3])
- 16 individually addressable result registers
- Sample cap reset feature for memory crosstalk mitigation
- Multiple trigger sources
 - Software immediate start
 - All MCPWMs: ADCSOC A or B
 - GPIO (external SOC)
 - GP Timers 0/1
 - ADCINT1/2
 - eCAP events in capture mode (CEVT1, CEVT2, CEVT3, and CEVT4) and APWM mode (period match, compare match, or both).
 - Global software trigger for multiple ADCs
- Four flexible interrupts
- Burst-mode triggering option
- Hardware oversampling mode up to 128x, with configurable trigger spread delay
- Hardware undersampling mode
- Trigger phase delay function

- Four post-processing blocks, each with:
 - Saturating offset calibration
 - Error from setpoint calculation
 - High, low, and zero-crossing compare, with interrupt and MCPWM trip capability
 - Configurable digital filter for high/low/zero-crossing compare
 - Trigger-to-sample delay capture
 - Absolute value calculation
 - 24-bit accumulation register for oversampling, with configurable binary shift
 - Minimum/maximum calculation for outlier rejection

6.6.2 ADC Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
General					
ADCCLK Conversion Cycles	Using Wrapper, 200MHz SYSCLK			11	ADCCLKs
Power Up Time	External Reference mode			500	μs
	Internal Reference mode (both bg and ADC)			5000	μs
	Internal Reference mode, when switching between 2.5V range and 3.3V range.			5000	μs
VREFHI input current ⁽¹⁾			200		μA
Internal Reference Capacitor Value ⁽²⁾		2.2			μF
External Reference Capacitor Value ⁽²⁾		2.2			μF
DC Characteristics					
Gain Error	Internal reference	TBD	45	TBD	LSB
	External reference		±3		
Offset Error			±2		LSB
Channel-to-Channel Gain Error ⁽⁴⁾			2		LSB
Channel-to-Channel Offset Error ⁽⁴⁾			2		LSB
ADC-to-ADC Gain Error ⁽⁵⁾	Identical VREFHI and VREFLO for all ADCs		4		LSB
ADC-to-ADC Offset Error ⁽⁵⁾	Identical VREFHI and VREFLO for all ADCs		2		LSB
DNL Error		-0.999 to 1			LSB
INL Error			±2.0		LSB
ADC-to-ADC Isolation	VREFHI = 2.5V, synchronous ADCs	-1		1	LSBs
AC Characteristics					
SNR ⁽³⁾	VREFHI = 2.5V, fin = 100kHz, MCLK from X1		67.08		dB
	VREFHI = 2.5V, fin = 100kHz, MCLK from SYSOSC		TBD		
THD ⁽³⁾	VREFHI = 2.5V, fin = 100kHz		-80		dB
SFDR ⁽³⁾	VREFHI = 2.5V, fin = 100kHz		82		dB
SINAD ⁽³⁾	VREFHI = 2.5V, fin = 100kHz, MCLK from X1		66.8		dB
	VREFHI = 2.5V, fin = 100kHz, MCLK from SYSOSCDIV4		TBD		
ENOB ⁽³⁾	VREFHI = 2.5V, fin = 100kHz, MCLK from X1, Single ADC		10.8		bits
PSRR	VDD = 1.2V DC + 100mV DC up to Sine at 1kHz		TBD		dB
	VDD = 1.2V DC + 100mV DC up to Sine at 300kHz		TBD		
	VDDA = 3.3V DC + 200mV DC up to Sine at 1kHz		TBD		
	VDDA = 3.3V DC + 200mV Sine at 900kHz		TBD		

(1) Load current on VREFHI increases when ADC input is greater than VDDA. This causes inaccurate conversions.

(2) A ceramic capacitor with package size of 0805 or smaller is preferred. Up to ±20% tolerance is acceptable.

(3) IO activity is minimized on pins adjacent to ADC input and VREFHI pins as part of best practices to reduce capacitive coupling and crosstalk.

(4) Variation across all channels belonging to the same ADC module.

(5) Worst case variation compared to other ADC modules.

6.6.2.1 ADC Operating Conditions

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
ADCCLK (derived from MCLK)		5		100	MHz
Sample rate ⁽³⁾ ⁽⁴⁾	Using Wrapper, 100MHz ADCCLK		6.67		MSPS
Sample window duration (set by ACQPS and MCLK) ⁽¹⁾	With 50Ω or less R _s		40		ns
	Internal VREFLO Connection		40		
VREFHI	External Reference	2.4	2.5 or 3.0	VDDA	V
VREFHI ⁽²⁾	Internal Reference = 3.3V Range		1.65		V
	Internal Reference = 2.5V Range		2.5		V
VREFLO		VSSA		VSSA	V
VREFHI - VREFLO		2.4		VDDA	V
Conversion range	Internal Reference = 3.3V Range	0		3.3	V
	Internal Reference = 2.5V Range	0		2.5	
	External Reference	VREFLO		VREFHI	
Conversion range	Package = LQFN48	0		VDDA	V

(1) The sample window must also be at least as long as 1 ADCCLK cycle for correct ADC operation.

(2) In internal reference mode, the reference voltage is driven out of the VREFHI pin by the device. The user should not drive a voltage into the pin in this mode.

(3) Non-integer ADC clock dividers are not supported: ADCCTL2.PRESCALE should only use even values

(4) Sample and hold cap reset feature must be enabled; SAMPCAPRESETSEL = 0

6.6.2.2 ADC Electrical Data and Timing

6.6.2.3 External ADC Start-of-Conversion Switching Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER	MIN	MAX	UNIT
t _w (ADCSOCL) Pulse duration, ADCSOCxO low	32t _c (SYSCLK)		cycles

6.6.3 Comparator Subsystem (CMPSS)

The Comparator Subsystem (CMPSS) consists of analog comparators and supporting circuits that are useful for power applications such as peak current mode control, switched-mode power supply, power factor correction, voltage trip monitoring, and so forth.

The comparator subsystem is built around a number of modules. Each subsystem contains two comparators, two reference 8-bit DACs, and two digital filters. Comparators are denoted "H" or "L" within each module where "H" and "L" represent high and low, respectively. Each comparator generates a digital output which indicates whether the voltage on the positive input is greater than the voltage on the negative input. The positive input of the comparator is driven from an external pin. The negative input can be driven by an external pin or by the programmable reference 10-bit DAC. Each comparator output passes through a programmable digital filter that can remove spurious trip signals. An unfiltered output is also available if filtering is not required.

Each CMPSS includes:

- Two analog comparators
- Two (10-bit effective DACs on CMPSS_LITE instances)
- Two digital filters, 65536 max filter clock prescale
- Ability to synchronize submodules with EPWMSYNCPER
- Ability to synchronize output with MCLK
- Ability to latch output
- Ability to invert output
- Option to use hysteresis on the input

- Option for negative input of comparator to be driven by an external signal or by the reference DAC
- Option for positive input of comparator to be driven by an external signal or by the PGA
- Option to use the low comparator DAC output, CMPx_DACL, on an external pin (select instances only, mutually exclusive with use of compare functionality)

6.6.4 CMPSS Electrical Data and Timing

6.6.4.1 CMPSS_LITE Comparator Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
TPU	Power-up time	Bandgap Not Enabled			500	μs
Comparator input (CMPINxx) range			0		VDDA	V
Input referred offset error		Via AIO/AGPIO, Input common mode = 5% to 95% of VDDA	−20		20	mV
Hysteresis ⁽¹⁾	Hysteresis ⁽¹⁾	0x	−6	0	6	mV
Hysteresis ⁽¹⁾		1x	1	10	19	mV
		2x	7	20	34	
		3x	14	30	51	
		4x	19	41	70	
		5x	25	52	88	
		6x	31	64	109	
		7x	37	77	131	
Response time (delay from CMPINx input change to output on MCPWM X-BAR or Output X-BAR)		Step response		21	40	ns
		Ramp response (1.65V/μs)		26		
		Ramp response (8.25mV/μs)		30		
VDDA	Analog Supply		2.8	3.3	3.63	V
VDD	Core Supply		1.08	1.2	1.32	V
Tj	Temperature		−40	27	155	°C
Resolution				12		bits
Input Clock (SYSCLK) Frequency			1		100	MHz
Input Clock (SYSCLK) Pulse Width			TSYSCLK/2			
Conversion Range		VDAC	0		VDAC	V
Conversion Range		VDDA	0		VDDA	V
VDAC	VDAC Range		2.4	3.3	VDDA	V
DNL	Differential Non Linearity		−1		4	LSB
INL	Static Integral Non Linearity		−16		16	LSB
Ramp Linearity	Dynamic Ramp Error	20 DAC Input Steps per 60 MHz SYSCLK. Response Must be Monotonic.	−64		64	LSB
Full Scale Step Response Settling Time					1	μs
Comparator Trip Disturbance			−512	+/-120	512	LSB
Comparator Trip Disturbance Settling Time					200	ns
Gain	Gain Error		−2		2	% of FSR
Reference Input Impedence	Reference Input Impedance			8		kΩ
PSRR	Power Supply Rejection Ratio	Up to 250 kHz		46		dB
Ramp Response Time				26		ns
Slow Ramp Response Time				30		ns
Step Response Time		AIO			50	ns
Input Offsett Error	Input Offset Error	w/ Jitter Aggressor	−20	5	20	mV
Input Hysteresis from Ideal			−5	0	5	mV
CMRR	Common Mode Rejection Ratio		40			dB
IVDDA	Active Current (Analog Supply)	CMPSS			120	μA
IVDD	Active Current (Core Supply)	CMPSS			6	μA
IVDDA(leak)	Leakage Current (Analog Supply)	CMPSS				μA
IVDD(leak)	Leakage Current (Core Supply)	CMPSS				μA
IVDDA	Active Current (Analog Supply)	DAC		400		μA

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
IVDD	Active Current (Core Supply)		0		μA
IVDDA(leak)	Leakage Current (Analog Supply)				μA
IVDD(leak)	Leakage Current (Core Supply)				μA
dvt	Transient vt shift		5		mV

(1) Hysteresis is available for all comparator input source configurations.

6.6.4.2 CMPSS_LITE DAC Static Electrical Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
CMPSS_LITE DAC output range		0		VDDA	V
Static offset error ⁽¹⁾		–25		25	mV
Static gain error ⁽¹⁾		–0.5		0.5	% of FSR
Static DNL	Endpoint corrected	–5		5	LSB (12-bit)
Static INL	Endpoint corrected	–5		5	LSB (12-bit)
Static TUE (Total Unadjusted Error)				35	mV
Settling time	Settling to 1LSB after full-scale output change		1		μs
Resolution ⁽²⁾			12		bits

(1) Includes comparator input referred errors.

(2) 9.5-bit effective resolution for monotonic response

6.6.5 Programmable Gain Amplifier (PGA)

The Programmable Gain Amplifier (PGA) is used to amplify an input voltage for the purpose of increasing the effective resolution of the downstream ADC and CMPSS modules.

The integrated PGA helps to reduce cost and design effort for many control applications that traditionally require external, stand-alone amplifiers. On-chip integration ensures that the PGA is compatible with the downstream ADC and CMPSS modules. Software-selectable gain and filter settings make the PGA adaptable to various performance needs.

The PGA has the following features:

- Rail to rail input and output voltage within VDDA and VSSA range
- Programmable gain modes including unity gain and other values from 2X - 64X
- Standalone gain mode using off-chip passive components
- Post-gain filtering using on-chip resistors
- Differential input support
- Hardware assisted chopping for offset reduction
- Support for Kelvin ground connections using PGA_INM pins

The active component in the PGA is an embedded operational amplifier (op amp) that is configured as a non-inverting or inverting amplifier with internal feedback resistors. These internal feedback resistor values are paired to produce software selectable voltage gains.

Three PGA signals are available at the device pins:

- PGA_INP is the positive input to the PGA op-amp.
- PGA_INM is the negative input to the PGA op-amp. See the device data manual for more information.
- PGA_OUT supports op-amp output filtering with RC components. The filtered signal is available for sampling and monitoring by on-chip ADC and CMPSS modules.

6.6.6 PGA Electrical Data and Timing

6.6.6.1 PGA Operating Conditions

over recommended operating s (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
VDDA		2.8	3.3	3.6	V
VDD		1.08	1.2	1.32	V
TEMP	T _J	–40	27	155	C
Clock Frequency		SYSCLK		150	MHz
Clock Duty Cycle		40	50	60	%
PGA Output Range ⁽¹⁾		VSSA+0.025		VDDA–0.025	V
PGA Input Range		–0.05		VDDA	V
Min ADC S+H	With Filter	75			ns
Min ADC S+H (No Filter, Level Shifting)		220			ns
Capacitive Load on PGA Out			40		pF

(1) This is the linear output range of the PGA. The PGA can output voltages outside this range, but the voltages will not be linear.

6.6.6.2 PGA Characteristics

over recommended operating s (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
General					
Min ADC S+H Settling within ±1 ADC LSB Accuracy (No Filter; All Gain Settings; Single ADC Driven) ⁽⁵⁾	Gain = 1	125			ns
	Gain = 2/-1	146			
	Gain = 4/-3	125			
	Gain = 8/-7	154			
	Gain = 16/-15	227			
	Gain = 32/-31	322			
	Gain = 64/-63	420			
Gain Settings			1		
			2, 4, 8, 16, 32, 64		
			–1, –3, –7, –15, – 31, –63		
Short Circuit Current ⁽⁶⁾			41		mA
Full Scale Step Response (No Filter) Settling within 0.05% Accuracy ⁽⁵⁾	G<64			420	ns
	G = 64/-63			500	ns
Settling Time: Gain Switching				10	μs
Slew Rate	Naked OPA Mode		12		V/μs
Slew Rate	Gain = 1		12		V/μs
	Gain = 2/-1		24		V/μs
	Gain = 4/-3		43		V/μs
	Gain = 8/-7		67		V/μs
	Gain = 16/-15		35		V/μs
	Gain = 32/-31		29		V/μs
	Gain = 64/-63		26		V/μs
Overload Recovery Time	Settling to 0.1%		.400		μs

over recommended operating s (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
R_{ia}	Gain = 1		256		k Ω
	Gain = 2/-1		14		k Ω
	Gain = 4/-3		7		k Ω
	Gain = 8/-7		8		k Ω
	Gain = 16/-15		8		k Ω
	Gain = 32/-31		8		k Ω
	Gain = 64/-63		4		k Ω
R_{ib}	Gain = 1		0		k Ω
	Gain = 2/-1		14		k Ω
	Gain = 4/-3		21		k Ω
	Gain = 8/-7		56		k Ω
	Gain = 16/-15		120		k Ω
	Gain = 32/-31		248		k Ω
	Gain = 64/-63		252		k Ω
Filter Resistor Targets	$R_{FILT} = 800\Omega$		800		Ω
	$R_{FILT} = 400\Omega$		400		Ω
	$R_{FILT} = 200\Omega$		200		Ω
	$R_{FILT} = 100\Omega$		100		Ω
	$R_{FILT} = 50\Omega$		50	62	Ω
Active Current	VDDA Without Filter		1.3	1.7	mA
	VDDA With Filter		1.3	1.9	mA
	VDD Without Filter		10	200	μ A
	VDD With Filter		10	200	μ A
Leakage Current	VDDA		.02		μ A
	VDD		.03		μ A
Gain Bandwidth Product (Naked Op-Amp Mode)	Gain=1		7		MHz
Closed Loop -3bd BW	Gain=1		15		MHz
	Gain=2/-1		14		MHz
	Gain=4/-3		13.5		MHz
	Gain=8/-7		12		MHz
	Gain=16/-15		11		MHz
	Gain=32/-31		5.5		MHz
	Gain=64/-63		5.0		MHz
DC Characteristics					
Gain Error ⁽¹⁾	Gain = 1	-0.18		0.18	%
	Gain = 2, -1	-0.37		0.37	%
	Gain = 4, -3	-0.6		0.6	%
	Gain = 8, -7	-0.73		0.73	%
	Gain = 16, -15	-0.81		0.81	%
	Gain = 32, -31	-1.0		1.0	%
	Gain = 64, -63	-1.82		1.82	%
Offset Error (Untrimmed)	Input Referred	-8		8	mV
Offset Error ⁽²⁾	Input Referred	-3.0	+/-1.0	3.0	mV
Offset Temp Coefficient	Input Referred	-7.0		7.0	μ V/C

over recommended operating s (unless otherwise noted)

PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
Offset Error - Chopped		–0.8		0.8	mV
Offset Temp Coefficient - Chopped			0.3		μV/C
Offset Trim Range	Min			–8	mV
	8			mV	
Long Term Offset Drift	Input Referred		3		mV
INL	With ADC	–3		3	12b LSB
DC Code Spread	G<64		2.5		12b LSB
	G = 64/-63		4		12b LSB
AC Characteristics					
Phase Margin Naked OPA	C _{load} = 40pF G=1		45		Deg
Aol (Open loop voltage gain) Naked OPA	R _L =7.5kΩ to GND 0.3V<V _O <VDDA-0.3V		94		dB
THD + Noise (THD+N) Naked OPA	f _{in} =1kHz G=1		82		dB
Bandwidth ⁽³⁾	All Gain Modes		7		MHz
SNR 10kHz (With ADC)	Gain = 1		68		dB
	Gain = 2, -1		68		
	Gain = 4, -3		66		
	Gain = 8, -7		62		
	Gain = 16, -15		58		
	Gain = 32, -31		55		
	Gain = 64, -63		51		
THD ⁽⁴⁾	DC		–78		dB
THD(Up to 100kHz) ⁽⁴⁾	Gain = 1		–58		dB
	Gain = 2, -1		–70		
	Gain = 4, -3		–70		
	Gain = 8, -7		–70		
	Gain = 16, -15		–70		
	Gain = 32, -31		–58		
	Gain = 64, -63		–58		
CMRR	DC: V _{IN} ≤1.5V		–86		dB
	DC: Full Input Range		–77		dB
	Up to 100kHz		–50		dB
PSRR ⁽⁴⁾	DC		–75		dB
	Up to 10kHz		–60		dB
	Up to 100kHz		–40		dB
Noise PSD ⁽⁴⁾	1kHz		200		nV/sqrt(Hz)
	10kHz		100		nV/sqrt(Hz)
Integrated Noise (Input Referred) ⁽⁴⁾	3Hz to 30MHz		100		μV

(1) Includes ADC gain error.

(2) Includes ADC offset error.

(3) 3dB bandwidth.

(4) Performance of PGA alone.

 (5) Step response time w filter = t_S+H + 7.6*R_{filt}* C_{filt}

(6) Assumes no filter circuit

6.6.7 Temperature Sensor Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
T _{acc}	Temperature Accuracy	Internal reference		±15		°C
T _{acc}	Temperature Accuracy	External reference		±15		°C
dVout/dT	Temperature Sensitivity		3.3	3.8	4.3	mV/°C
t _{pu}	Power up time				500	µs
t _{startup}	Start-up time (TSNSCTL[ENABLE] to sampling temperature sensor)			500		µs
t _{OS}	Voltage Output Settling Time				450	ns
t _{acq}	ADC acquisition time		450			ns
PSR	Power Supply Rejection				40	dB
IDDA	Active Current (Analog Supply)			210	296	µA
IDD	Active Current (Core Supply)					µA
IDDA(leak)	Leakage Current (Analog Supply)			17	147	nA
IDD(leak)	Leakage Current (Core Supply)				400	nA

Internal Analog Connections

over operating free-air temperature range (unless otherwise noted)

Internal Signal	Connections
TEMPSENSOR	A0_13/A2_13
PGA0_OUT (Internal)	A0_31
PGA1_OUT (Internal)	A1_31
PGA2_OUT (Internal)	A2_31

6.7 Control Peripherals

6.7.1 Multichannel Pulse Width Modulator (MCPWM)

The MCPWM peripheral is a key element in controlling many of the power electronic systems found in both commercial and industrial equipment. The MCPWM module is able to generate complex pulse width waveforms with minimal CPU overhead by building the peripheral up from smaller modules with separate resources that can operate together to form a system. Some of the highlights of the MCPWM module include complex waveform generation, dead-band generation, a flexible synchronization scheme, advanced trip-zone functionality, and global register reload capabilities.

The MCPWM and eCAP synchronization scheme on the device provides flexibility in partitioning the MCPWM and eCAP modules and allows localized synchronization within the modules.

[Figure 6-1](#) shows the MCPWM module.

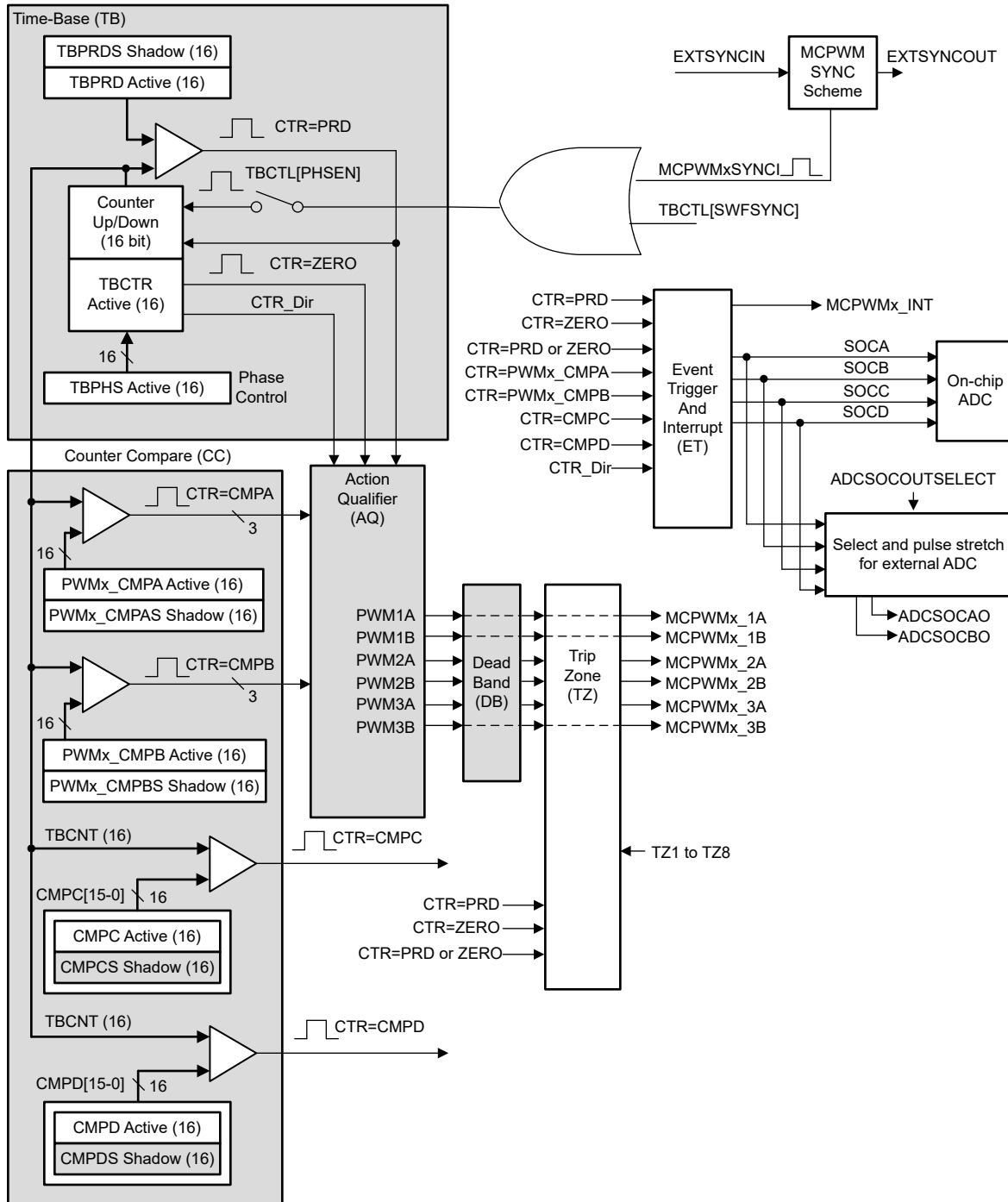


Figure 6-1. MCPWM Submodules and Critical Internal Signal Interconnects

6.7.2 Control Peripherals Synchronization

The MCPWM and eCAP synchronization scheme on the device provides flexibility in partitioning the MCPWM and eCAP modules and allows localized synchronization within the modules. Figure 6-2 shows the synchronization scheme.

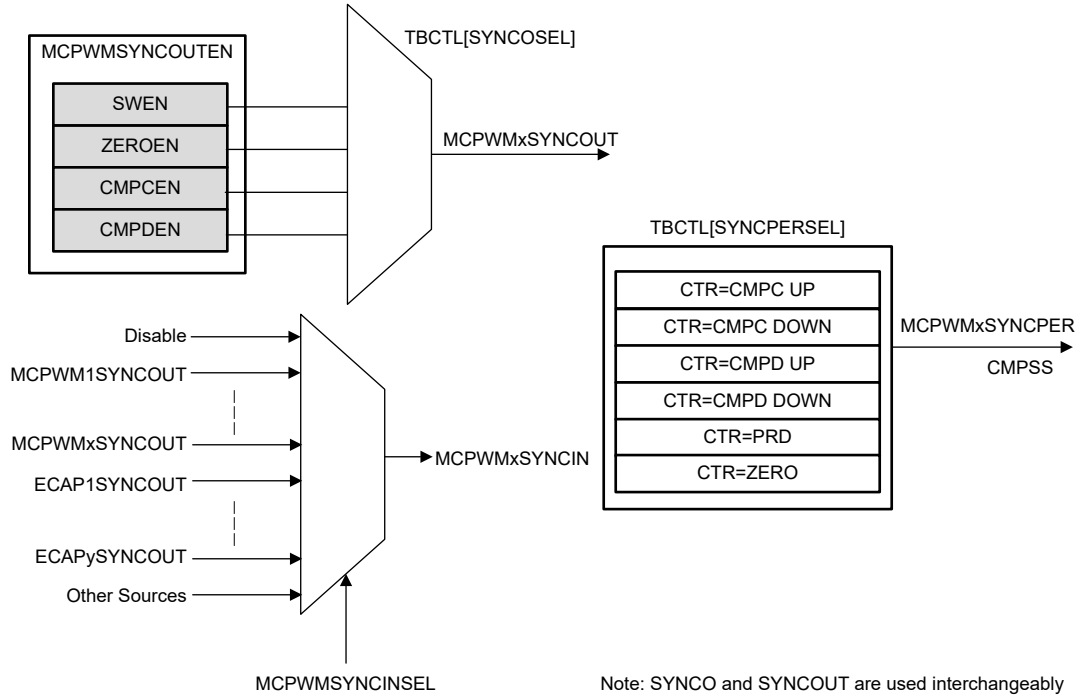


Figure 6-2. Synchronization Chain Architecture

6.7.3 MCPWM Electrical Data and Timing

6.7.3.1 MCPWM Timing Requirements

PARAMETER			MIN	MAX	UNIT
t _w (SYNCIN)	Sync input pulse width	Asynchronous	2t _c (EPWMCLK)		cycles
		Synchronous	2t _c (EPWMCLK)		
		With input qualifier	1t _c (EPWMCLK) + t _w (IQSW)		

6.7.3.2 MCPWM Switching Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		MIN	MAX	UNIT
$t_w(\text{PWM})$	Pulse duration, PWMx output high/low	20		ns
$t_w(\text{SYNCO})$	Sync output pulse width	$8t_{c(\text{SYSCLK})}$		cycles
$t_d(\text{TZ-PWM})$	Delay time, trip input active to PWM forced high Delay time, trip input active to PWM forced low Delay time, trip input active to PWM Hi-Z	30		ns
tskew	Skew of all MCPWM outputs (Shortest Path) ⁽¹⁾	5.1		ns
tskew	Skew of all MCPWM outputs (Longest Path) ⁽¹⁾	8.9		ns

(1) The MCPWMs have a similar configuration.

6.7.4 Enhanced Capture eCAP

The features of the eCAP module include:

- Speed measurements of rotating machinery (for example, toothed sprockets sensed by way of Hall sensors)
- Elapsed time measurements between position sensor pulses
- Period and duty cycle measurements of pulse train signals
- Decoding current or voltage amplitude derived from duty cycle encoded current/voltage sensors

The eCAP module features described in this section include:

- 4-event time-stamp registers (each 32 bits)
- Edge polarity selection for up to four sequenced time-stamp capture events
- Interrupt on either of the four events
- Single-shot capture of up to four event time-stamps
- Continuous mode capture of time stamps in a four-deep circular buffer
- Absolute time-stamp capture
- Difference (Delta) mode time-stamp capture
- When not used in capture mode, the eCAP module can be configured as a single-channel PWM output

The capture functionality of the Type 1 eCAP is enhanced from the Type 0 eCAP with the following added features:

- Event filter reset bit
 - Writing a 1 to ECCTL2[CTRFILTRESET] clears the event filter, the modulo counter, and any pending interrupts flags. Resetting the bit is useful for initialization and debug.
- Modulo counter status bits
 - The modulo counter (ECCTL2 [MODCNRSTS]) indicates which capture register is loaded next. In the Type 0 eCAP, to know the current state of the modulo counter was not possible
- DMA trigger source
 - eCAPxDMA was added as a DMA trigger. CEVT[1-4] can be configured as the source for eCAPxDMA.
- Input multiplexer
 - ECCTL0 [INPUTSEL] selects one of 128 input signals, which are detailed in the Configuring Device Pins for the eCAP section of the Enhanced Capture (eCAP) chapter in the TRM.
- EALLOW protection
 - EALLOW protection was added to critical registers. To maintain software compatibility with Type-0, configure DEV_CFG_REGS.ECAPTYPE to make these registers unprotected.

The capture functionality of the Type 2 eCAP is enhanced from the Type 1 eCAP with the following added features:

- Added ECAPxSYNCINSEL register
 - ECAPxSYNCINSEL register is added for each eCAP to select an external SYNCIN. Every eCAP can have a separate SYNCIN signal.

6.7.6 eCAP Synchronization

The eCAP modules can be synchronized with each other by selecting a common SYNCIN source. SYNCIN source for eCAP can be either software sync-in or external sync-in. The external sync-in signal can come from PWM, eCAP, or X-Bar. The SYNC signal is defined by the selection in the ECAPxSYNCINSEL[SEL] bit for ECAPx as shown in the diagram below.

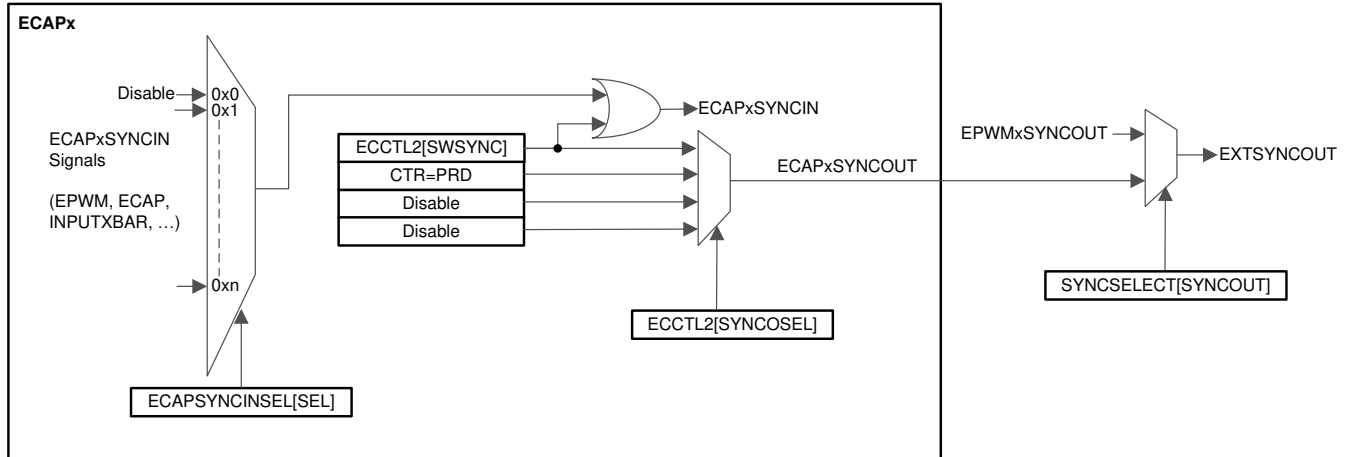


Figure 6-4. eCAP Synchronization Scheme

6.7.7 eCAP Electrical Data and Timing

6.7.7.1 eCAP Timing Requirements

			MIN	NOM	MAX	UNIT
t _{w(CAP)}	Capture input pulse width	Asynchronous	2t _{c(SYSCCLK)}			ns
		Synchronous	2t _{c(SYSCCLK)}			
		With input qualifier	1t _{c(SYSCCLK)} + t _{w_(IQSW)}			

6.7.7.2 eCAP Switching Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		MIN	TYP	MAX	UNIT
$t_{w(APWM)}$	Pulse duration, APWMx output high/low	20			ns

6.7.8 Enhanced Quadrature Encoder Pulse (eQEP)

The eQEP module on this device is Type-2. The eQEP interfaces directly with linear or rotary incremental encoders to obtain position, direction, and speed information from rotating machines used in high-performance motion and position control systems.

The eQEP peripheral contains the following major functional units:

- Programmable input qualification for each pin (part of the GPIO MUX)
- Quadrature decoder unit (QDU)
- Position counter and control unit for position measurement (PCCU)
- Quadrature edge-capture unit for low-speed measurement (QCAP)
- Unit time base for speed/frequency measurement (UTIME)
- Watchdog timer for detecting stalls (QWDOG)
- Quadrature Mode Adapter (QMA)

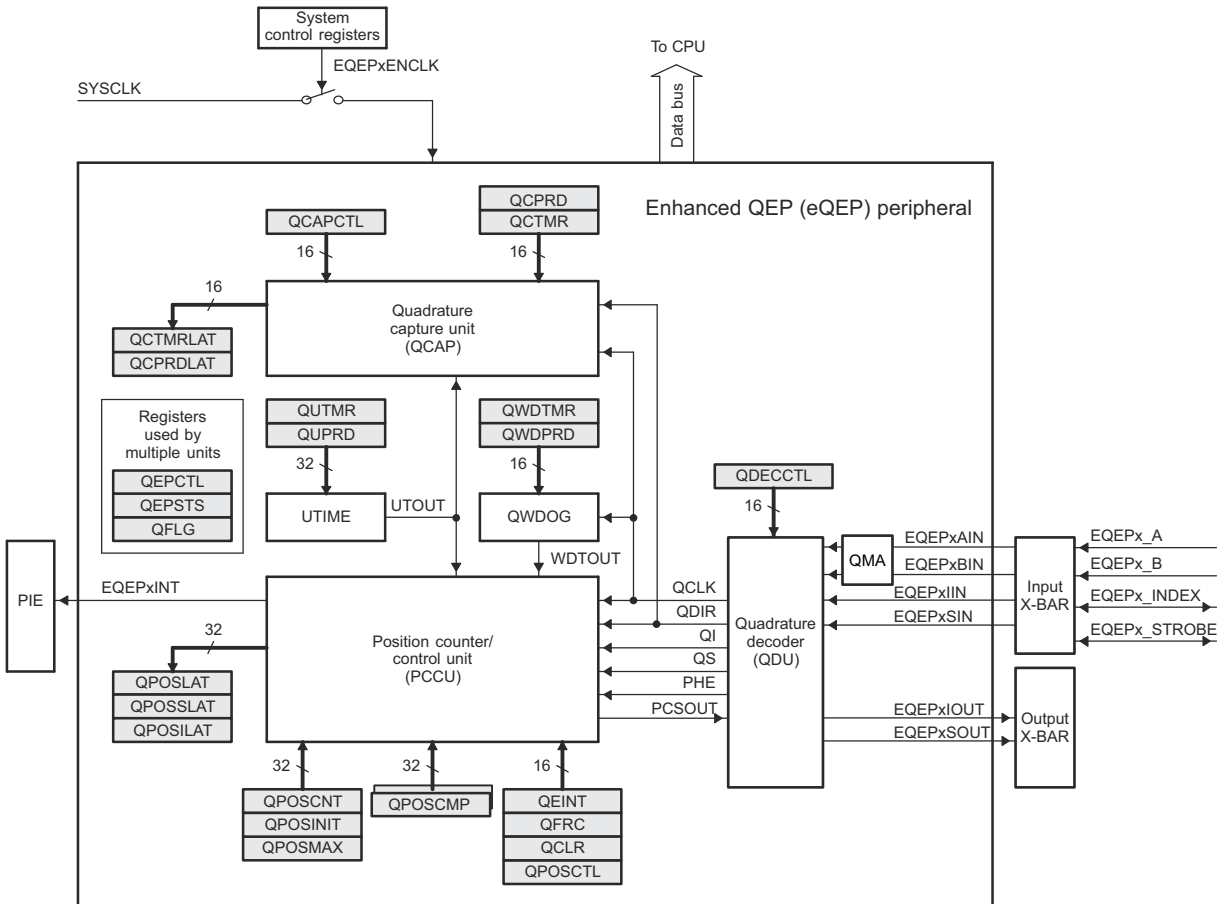


Figure 6-5. eQEP Block Diagram

6.7.9 eQEP Electrical Data and Timing

6.7.9.1 eQEP Timing Requirements

			MIN	MAX	UNIT
$t_{w(QEPP)}$	QEP input period	Synchronous ⁽¹⁾	$2t_{c(SYSCLK)}$		cycles
$t_{w(QEPP)}$	QEP input period	Synchronous with input qualifier	$2[1t_{c(SYSCLK)} + t_{w(IQSW)}]$		cycles
$t_{w(INDEXH)}$	QEP Index Input High time	Synchronous ⁽¹⁾	$2t_{c(SYSCLK)}$		cycles
$t_{w(INDEXH)}$	QEP Index Input High time	Synchronous with input qualifier	$2t_{c(SYSCLK)} + t_{w(IQSW)}$		cycles
$t_{w(INDEXL)}$	QEP Index Input Low time	Synchronous ⁽¹⁾	$2t_{c(SYSCLK)}$		cycles
$t_{w(INDEXL)}$	QEP Index Input Low time	Synchronous with input qualifier	$2t_{c(SYSCLK)} + t_{w(IQSW)}$		cycles
$t_{w(STROBH)}$	QEP Strobe High time	Synchronous ⁽¹⁾	$2t_{c(SYSCLK)}$		cycles
$t_{w(STROBH)}$	QEP Strobe High time	Synchronous with input qualifier	$2t_{c(SYSCLK)} + t_{w(IQSW)}$		cycles
$t_{w(STROBL)}$	QEP Strobe Input Low time	Synchronous ⁽¹⁾	$2t_{c(SYSCLK)}$		cycles
$t_{w(STROBL)}$	QEP Strobe Input Low time	Synchronous with input qualifier	$2t_{c(SYSCLK)} + t_{w(IQSW)}$		cycles

(1) The GPIO GPxQSELn Asynchronous mode should not be used for eQEP module input pins.

6.7.9.2 eQEP Switching Characteristics

over recommended operating conditions (unless otherwise noted)

PARAMETER		MIN	MAX	UNIT
$t_{d(CNTR)_{xin}}$	Delay time, external clock to counter increment		$5t_{c(SYSCLK)}$	cycles
$t_{d(PCS-OUT)_{QEP}}$	Delay time, QEP input edge to position compare sync output		$7t_{c(SYSCLK)}$	cycles

6.8 Communication Peripherals

6.8.1 Modular Controller Area Network (MCAN)

The Controller Area Network (CAN) is a serial communications protocol that efficiently supports distributed real-time control with a high level of reliability. CAN has high immunity to electrical interference and the ability to detect various type of errors. In CAN, many short messages are broadcast to the entire network, which provides data consistency in every node of the system.

The MCAN module supports both classic CAN and CAN FD (CAN with flexible data-rate) protocols. The CAN FD feature allows higher throughput and increased payload per data frame. Classic CAN and CAN FD devices may coexist on the same network without any conflict provided that partial network transceivers, which can detect and ignore CAN FD without generating bus errors, are used by the classic CAN devices. The MCAN module is compliant to ISO 11898-1:2015.

Note

The availability of the CAN FD feature is dependent on the device's part number.

The MCAN module implements the following features:

- Conforms with CAN Protocol 2.0 A, B and ISO 11898-1:2015
- Full CAN FD support (up to 64 data bytes)
- AUTOSAR and SAE J1939 support
- Flexible Message RAM allocation (maximum configuration below is for a device with 4352 32-bit word message RAM)
 - Up to 32 dedicated transmit buffers
 - Configurable transmit FIFO, up to 32 elements
 - Configurable transmit queue, up to 32 elements
 - Configurable transmit Event FIFO, up to 32 elements
 - Up to 64 dedicated receive buffers
 - Two configurable receive FIFOs, up to 64 elements each
 - Up to 128 filter elements
- Loop-back mode for self-test
- Maskable interrupt (two configurable interrupt lines, correctable ECC, counter overflow and clock stop/wakeup)
- Non-maskable interrupt (uncorrectable ECC)
- Two clock domains (CAN clock/host clock)
- ECC check for Message RAM
- Clock stop and wake-up support
- Timestamp counter

Non-supported features:

- Host bus firewall
- Clock calibration
- Debug over CAN

7 Detailed Description

7.1 Description

AM13E230x microcontrollers (MCUs) are part of the AM13x highly integrated, low-cost 32-bit MCU family based on the Arm® Cortex®-M33 32-bit CPU operating at up to 200MHz frequency. These real-time control optimized MCUs offer high-performance analog, control, and digital peripheral integration, support ambient temperature ranges from -40°C to 105°C, and operate with a 3.3V supply voltage.

The AM13E230x MCUs provide up to 512KB of embedded flash program memory (2 banks of up to 256KB) with built-in error correction code (ECC) and up to 128KB SRAM with hardware parity. Smaller memory configuration variants are offered.

The processing system incorporates Custom Datapath Extension (CDE) support, a Memory Protection Unit (MPU), Micro Trace Buffer (MTB), a 32-bit Trigonometric Math Unit (TMU), and a TinyEngine™ Neural-network Processing Unit (NPU).

AM13E230x MCUs are enabled with robust, high-performance analog peripherals. Three 12-bit ADCs with a maximum sampling rate of 6.67MSPS, four high speed comparator subsystems with built-in 10-bit reference DACs, and three programmable gain amplifiers with 4:1 mux provide true real-time signal chain performance.

These MCUs also offer real-time control and timing peripherals such as a 12-channel DMA controller, multi-channel PWM generation, generic timers, specialty timers for capture and encoder interface, and a flexible X-BAR system for connecting GPIO and control peripherals.

An independent oscillator and windowed watchdog timer are included as well as multiple internal and external clocking options. Multiple operational power modes are offered for flexibility in controlling power consumption vs. wake-up time.

Data integrity and encryption features (AES, secure boot) provide security across the AM13E230x domains. A Cyclic Redundancy Checker (CRC) module provides internal diagnostics to the AM13E230x MCUs.

Enhanced communication interfaces are supported through one MCAN and up to 6 UNICOMM peripherals to support a combination of UART/LIN, I2C/SMBUS, and SPI. For connecting to external devices or memory, the high-speed External Peripheral Interface (EPI) can connect to SDRAM or asynchronous RAM devices such as FPGA or ASIC.

Package options include 48-pin QFN as well as 48/64/80/100/128-pin QFP.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾	BODY SIZE (NOM)	PITCH
AM13E23019	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm
AM13E23018	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm

Package Information (continued)

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾	BODY SIZE (NOM)	PITCH
AM13E23017	PDT (TQFP, 128)	16mm × 16mm	14mm × 14mm	0.4mm
	PZ (LQFP, 100)	16mm × 16mm	14mm × 14mm	0.5mm
	PN (LQFP, 80)	14mm × 14mm	12mm × 12mm	0.5mm
	PM (LQFP, 64)	12mm × 12mm	10mm × 10mm	0.5mm
	PT (LQFP, 48)	9mm × 9mm	7mm × 7mm	0.5mm
	RGZ (VQFN, 48)	7mm × 7mm	7mm × 7mm	0.5mm

(1) For more information, see the Mechanical, Packaging, and Orderable Information section.

(2) The package size (length × width) is a nominal value and includes pins, where applicable.

7.1.1 Functional Block Diagram

Figure 7-1 shows the AM13E230x functional block diagram.

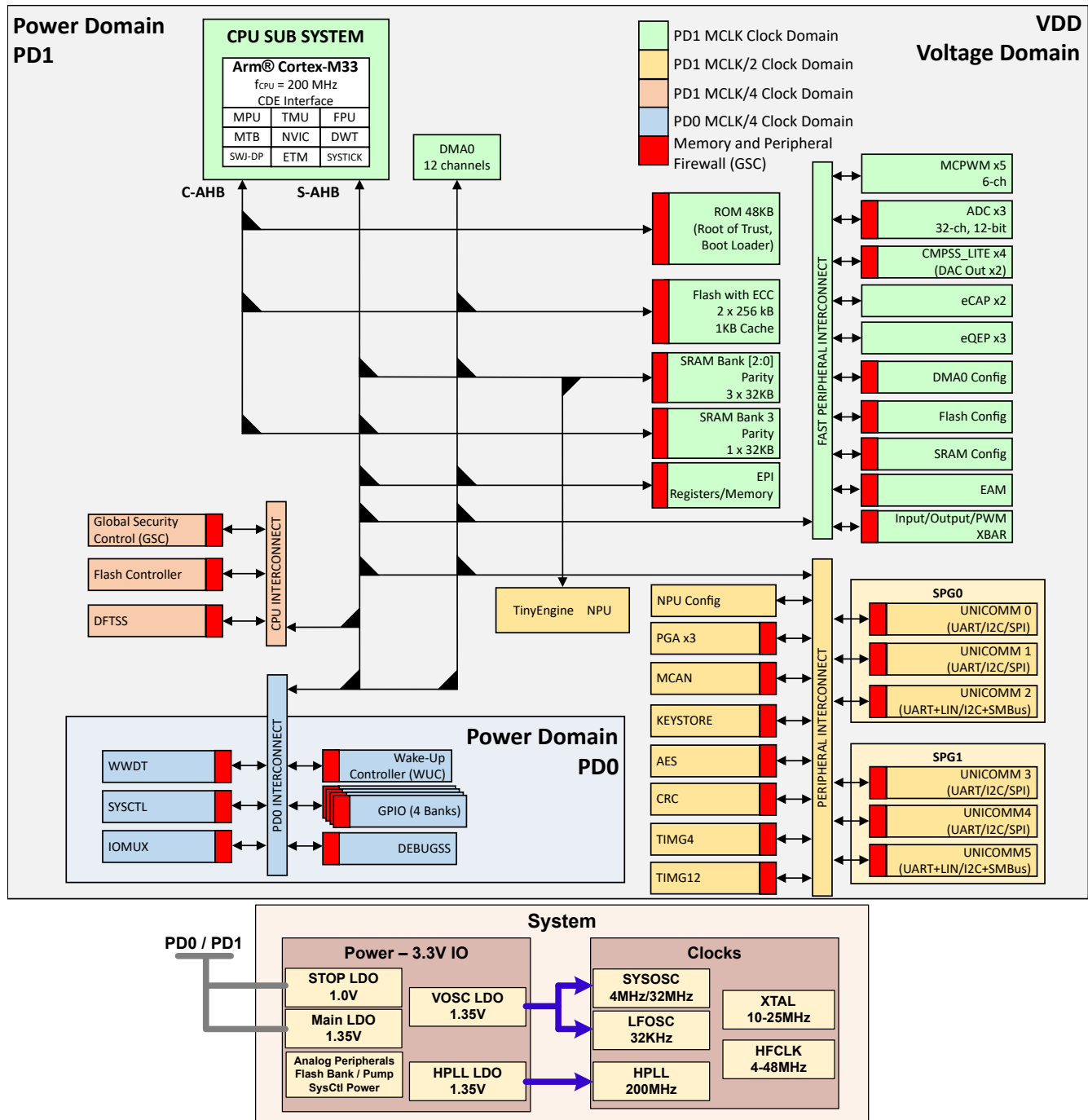


Figure 7-1. AM13E230x Functional Block Diagram

7.2 Memory

7.2.1 Peripheral Registers Memory Map

Table 7-1. Peripheral Registers Memory Map

Structure	DriverLib Name	Base Address
MCLK/2 Domain		
EPI_REGS_GPCFG, EPI_REGS_SDRAMCFG, EPI_REGS_HB8CFG, EPI_REGS_HB16CFG	EPI0_BASE, EPI0SDRAM_BASE, PI0HB8_BASE, EPI0HB16_BASE	0x4001_A000
PGA_REGS	PGA0_BASE	0x400F_C000
PGA_REGS	PGA1_BASE	0x400F_D000
PGA_REGS	PGA2_BASE	0x400F_E000
MCAN_REGS	MCAN0_BASE	0x4011_0000
TIMG4_REGS	TIMG4_BASE	0x4018_0000
TIMG12_REGS	TIMG12_BASE	0x4018_8000
AES_REGS	AES_BASE	0x401B_0000
CRCP_REGS	CRC_BASE	0x401B_2000
KEYSTORE_REGS	KEYSTORE_BASE	0x401B_6000
UNICOMMUART_REGS	UC0_UART_BASE	0x4060_0000
UNICOMMUART_REGS	UC1_UART_BASE	0x4060_1000
UNICOMMUART_REGS	UC2_UART_BASE	0x4060_2000
UNICOMMI2CC_REGS	UC0_I2CC_BASE	0x4060_8000
UNICOMMI2CC_REGS	UC1_I2CC_BASE	0x4060_9000
UNICOMMI2CC_REGS	UC2_I2CC_BASE	0x4060_A000
UNICOMMI2CT_REGS	UC0_I2CT_BASE	0x4061_0000
UNICOMMI2CT_REGS	UC1_I2CT_BASE	0x4061_1000
UNICOMMI2CT_REGS	UC2_I2CT_BASE	0x4061_2000
UNICOMMSPI_REGS	UC0_SPI_BASE	0x4061_8000
UNICOMMSPI_REGS	UC1_SPI_BASE	0x4061_9000
UNICOMM_REGS	UNICOMM0_BASE	0x4063_0000
UNICOMM_REGS	UNICOMM1_BASE	0x4063_2000
UNICOMM_REGS	UNICOMM2_BASE	0x4063_4000
SPG_REGS	SPG0_BASE	0x4063_F000
UNICOMMUART_REGS	UC3_UART_BASE	0x4064_0000
UNICOMMUART_REGS	UC4_UART_BASE	0x4064_1000
UNICOMMUART_REGS	UC5_UART_BASE	0x4064_2000
UNICOMMI2CC_REGS	UC3_I2CC_BASE	0x4064_8000
UNICOMMI2CC_REGS	UC4_I2CC_BASE	0x4064_9000
UNICOMMI2CC_REGS	UC5_I2CC_BASE	0x4064_A000
UNICOMMI2CT_REGS	UC3_I2CT_BASE	0x4065_0000
UNICOMMI2CT_REGS	UC4_I2CT_BASE	0x4065_1000
UNICOMMI2CT_REGS	UC5_I2CT_BASE	0x4065_2000
UNICOMMSPI_REGS	UC3_SPI_BASE	0x4065_8000
UNICOMMSPI_REGS	UC4_SPI_BASE	0x4065_9000
UNICOMM_REGS	UNICOMM3_BASE	0x4067_0000
UNICOMM_REGS	UNICOMM4_BASE	0x4067_2000
UNICOMM_REGS	UNICOMM5_BASE	0x4067_4000
SPG_REGS	SPG1_BASE	0x4067_F000
MCLK/1 Domain		
ADC_LITE_REGS	ADC0_BASE	0x4000_0000
ADC_LITE_REGS	ADC1_BASE	0x4000_2000
ADC_LITE_REGS	ADC2_BASE	0x4000_4000

Table 7-1. Peripheral Registers Memory Map (continued)

Structure	DriverLib Name	Base Address
ADC_LITE_RESULT_REGS	ADC0RESULT_BASE	0x4000_A000
ADC_LITE_RESULT_REGS	ADC1RESULT_BASE	0x4000_B000
ADC_LITE_RESULT_REGS	ADC2RESULT_BASE	0x4000_C000
MCPWM_6CH_REGS	MCPWM0_BASE	0x4001_0000
MCPWM_6CH_REGS	MCPWM1_BASE	0x4001_1000
MCPWM_6CH_REGS	MCPWM2_BASE	0x4001_2000
MCPWM_6CH_REGS	MCPWM3_BASE	0x4001_3000
MCPWM_6CH_REGS	MCPWM4_BASE	0x4001_4000
DMA_REGS	DMA0_BASE	0x4002_0000
FLASH_CTRL_REGS	FLASH_BASE	0x4002_8000
MEM_CFG_REGS	MEMCFG_BASE	0x4002_A000
EAM_REGS	EAM_BASE	0x4002_C000
ECAP_REGS	ECAP0_BASE	0x4044_0000
ECAP_REGS	ECAP1_BASE	0x4044_1000
EQEP_REGS	EQEP0_BASE	0x4044_8000
EQEP_REGS	EQEP1_BASE	0x4044_9000
EQEP_REGS	EQEP2_BASE	0x4044_A000
CMPSS_LITE_REGS	CMPSS0_BASE	0x4046_0000
CMPSS_LITE_REGS	CMPSS1_BASE	0x4046_1000
CMPSS_LITE_REGS	CMPSS2_BASE	0x4046_2000
CMPSS_LITE_REGS	CMPSS3_BASE	0x4046_3000
INPUT_XBAR_REGS	INPUTXBAR_BASE	0x4046_8000
EPWM_XBAR_REGS	PWMXBAR_BASE	0x4046_9000
OUTPUTXBAR_REGS	OUTPUTXBAR_BASE	0x4046_A000
SYNC_SOC_REGS	SYNC_BASE	0x4046_B000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR0_FLAGS_BASE	0x4047_0000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR1_FLAGS_BASE	0x4047_1000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR2_FLAGS_BASE	0x4047_2000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR3_FLAGS_BASE	0x4047_3000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR4_FLAGS_BASE	0x4047_4000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR5_FLAGS_BASE	0x4047_5000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR6_FLAGS_BASE	0x4047_6000
OUTPUTXBAR_FLAG_REGS	OUTPUTXBAR7_FLAGS_BASE	0x4047_7000
INPUT_FLAG_XBAR_REGS	INPUTXBAR_FLAGS_BASE	0x4049_0000
Power Domain 0 (Always ON)		
SYSCTL_REGS	SYSCTL_BASE	0x400A_F000
DEBUGSS_REGS	DEBUGSS_BASE	0x400C_7000
IOMUX_REGS	IOMUX_BASE	0x400C_C000
WWDT_REGS	WWDT_BASE	0x400D_0000
GPIO_REGS	GPIO0_BASE	0x400F_0000
GPIO_REGS	GPIO1_BASE	0x400F_2000
GPIO_REGS	GPIO2_BASE	0x400F_4000
GPIO_REGS	GPIO3_BASE	0x400F_6000
MCLK/4 Domain		
NVMNW_REGS	NVMNW_BASE	0x4004_2000
GSC_REGS	GSC_BASE	0x4004_6000

7.2.2 Static RAM

The CPU subsystem has a dedicated static RAM block with hardware parity, with up to 128KB of SRAM.

7.2.3 Flash Memory

On the AM13E230x microcontrollers, two flash banks of up to 256KB each are available. Code to program the flash should be executed out of RAM, there should not be any kind of access to the flash bank when an erase or program operation is in progress.

7.3 Identification

Table 7-2 lists the Device Identification Register parameters and descriptions.

Table 7-2. Device Identification Registers

NAME	ADDRESS	SIZE (x8)	DESCRIPTION	
			Bits	Options
PARTIDL	0x0005 D008	4	14-13 RESERVED	RESERVED
			10-8 PKG_TYPE	1 = 2 = 3 = 4 = 5 = 6 = 7 = 8 =
			7-6 QUAL	0 = Engineering sample (TMX) 1 = Pilot production (TMP) 2 = Fully qualified (TMS)
PARTIDH	0x0005 D00A	4	Device part identification number AM13E230x TBD	
REVID	0x0005 D00C	4	Silicon revision number Revision 0 0x0000 0001 Revision A 0x0000 0002 Revision B 0x0000 0003 Revision C 0x0000 0004	
UID_UNIQUE0	0x0007 114A	4	Unique identification number. This number is different on each individual device with the same PARTIDH. This unique number can be used as a serial number in the application.	
UID_UNIQUE1	0x0007 114C	4	Unique identification number. This number is different on each individual device with the same PARTIDH. This unique number can be used as a serial number in the application.	

7.4 Arm® Cortex®-M33 CPU

The Arm® Cortex®-M33 CPU is a 32-bit processor ideal for embedded applications that require efficient security or digital signal control. This CPU core includes features to enable such embedded applications, including memory protection units, a floating point unit, custom datapath instructions, and a micro trace buffer for instruction trace capabilities.

7.4.1 Trigonometric Math Unit (TMU)

The Trigonometric Math Unit (TMU) extends the capabilities of the Arm® Cortex®-M33 CPU by leveraging instructions to speed up common trigonometric and arithmetic operations listed in [Table 7-3](#).

Table 7-3. TMU Supported Instructions

Instructions	Description
SINPUF32	Returns the SINE of input value
COSPUF32	Returns the COSINE of input value
ATANPUF32	Returns the ATAN of input value
DIVF32	Returns DIV value of two input values
QUADF32	Returns the quadrant value and the ratio of X and Y inputs which are provided as per unit values
SQRTF32	Returns the square root of input value
IEXP2F32	Returns inverse exponent of input value
LOG2F32	Returns base-2 logarithm of input value
ISQRTF32	Returns the inverse square root of input value
RSCTFLG	Read/Set/Clear the LUF and LVF flags that are maintained inside the TMU CDE

7.4.2 Debug Subsystem

The AM13E230x Debug Subsystem integrates the JTAG interface and accesses the Cortex®-M33 CPU debug registers through the Debug Access Port (DAP). The Cortex®-M33 DAP can be configured as a JTAG Debug Port (JTAG-DP), Serial Wire Debug Port (SW-DP), or Serial Wire/JTAG Debug Port (SWJ-DP).

Note

MCLK (CPUCLK) must be at 100MHz to use ETM tracing.

Micro Trace Buffer

The Micro Trace Buffer (MTB) on AM13E230x MCUs provides basic execution trace capability to the CPU core. When enabled, the MTB records changes in program flow, reported by the Cortex®-M33 processor over the execution trace interface. This information is stored as trace packets in the MTB memory. An external debugger can extract the trace information using the DAP. The debugger can then reconstruct the program flow from this information.

7.5 TinyEngine™ Neural-network Processing Unit (NPU)

The TinyEngine™ Neural-network Processing Unit (NPU) supports intelligent inferencing running pre-trained models. Capable of 600-1200MOPS (Mega Operations Per Second), the TinyEngine™ NPU provides up to 10x Neural Network (NN) inferencing cycle improvement compared to a software-only implementation. Load and train models with tools from TI for an advanced set of capabilities.

7.6 DMA

The direct memory access (DMA) controller allows movement of data from one memory address to another without CPU intervention. For example, the DMA can be used to move data from ADC conversion memory to SRAM. The DMA reduces system power consumption by allowing the CPU to remain in low power mode, without having to awaken to move data to or from a peripheral.

- DMA0: 12 independent DMA transfer channels
 - 6 full-feature channel supporting repeated transfer modes
 - 6 basic channels supporting single transfer modes and scatter mode
- Configurable DMA channel priorities
- Byte (8-bit), short word (16-bit), word (32-bit) and long word (64-bit) or mixed byte and word transfer capability
- Transfer counter block size supports up to 64k transfers of any data type
- Configurable DMA transfer trigger selection
- Active channel interruption to service other channels
- Early interrupt generation for ping-pong buffer architecture
- Cascading channels upon completion of activity on another channel
- Stride mode to support data re-organization, such as 3-phase metering applications

For more details, see the DMA chapter of the AM13E230x 200-MHz Microcontrollers Technical Reference Manual.

7.7 Error Aggregator Module (EAM)

The Error Aggregator Module (EAM) aggregates single error correction (SEC) and double error detection (DED) for the system memory and security errors. EAM generates interrupt or NMI to the CPU based on the priority of the error. The EAM module is protected by a security firewall to allow customer critical code in secure mode of the application to handle the error in a context safe method.

The EAM supports the following features:

- ECC error logging for SEC and DED from flash and SRAM
- Security error logging for non-secure access to a firewall region for memory and peripherals
- Security error logging for hide protected region in the flash

- First error logged with initiator and type of access error logged

7.8 Power Management and Clock Unit (PMCU)

7.8.1 Power Management Unit (PMU)

The power management unit (PMU) generates the internally regulated core supplies for the device and provides supervision of the external supply (VDD). The PMU also contains the band-gap voltage reference used by the PMU itself as well as analog peripherals. Key features of the PMU include:

- Power-on reset (POR) supply monitor
- Brownout reset (BOR) supply monitor with early warning capability using three programmable thresholds
- Core regulator with support for RUN, SLEEP, STOP, and STANDBY operating modes to dynamically balance performance with power consumption
- Parity-protected trim to immediately generate a power-on reset (POR) in the event that a power management trim is corrupted

For more details, see the PMU chapter of the AM13E230x 200-MHz Microcontrollers Technical Reference Manual

7.8.2 Operating Modes

AM13E230x MCUs provide five main operating modes (power modes) to allow for optimization of the device power consumption based on application requirements. In order of decreasing power, the modes are: RUN, SLEEP, STOP, STANDBY, and SHUTDOWN. The CPU is active executing code when in RUN mode. Peripheral interrupt events can wake the device from SLEEP, STOP, or STANDBY mode to the RUN mode. SHUTDOWN mode completely disables the internal core regulator to minimize power consumption, and wake is only possible via NRST, SWD/JTAG interface, a logic level match on certain IOs, or an interrupt from the low frequency sub system (LFSS).

To further balance performance and power consumption, AM13E230x devices implement two power domains: PD1, PD0. PD1 contains the CPU, memories, and high performance peripherals. PD1 contains is always powered in RUN and SLEEP modes, but is disabled in all other modes. PD0 contains low speed, low power peripherals which are always powered in RUN, SLEEP, STOP, and STANDBY modes. PD1 and PD0 are both disabled in SHUTDOWN mode.

7.8.2.1 Functionality by Operating Mode

Supported functionality in each operating mode is given in [Table 7-4](#).

Functional key:

- **EN:** The function is enabled in the specified mode.
 - **DIS:** The function is disabled (either clock or power gated) in the specified mode, but the function's configuration is retained.
 - **OPT:** The function is optional in the specified mode, and remains enabled if configured to be enabled.
 - **OFF:** The function is fully powered off in the specified mode, and no configuration information is retained.
- When waking up from an OFF state, all module registers must be re-configured to the desired settings by application software.

Table 7-4. Supported Functionality by Operating Modes

OPERATING MODE		RUN	SLEEP	STOP	STANDBY	SHUTDOWN
Oscillators	SYSOSC	EN		OPT	DIS	OFF
	LFOSC	EN				
	XTAL	OPT		DIS		OFF
	SYSPLL	OPT		DIS		OFF

Table 7-4. Supported Functionality by Operating Modes (continued)

OPERATING MODE		RUN	SLEEP	STOP	STANDBY	SHUTDOWN
Clocks	CPUCLK	200MHz	DIS			OFF
	MCLK	200MHz		DIS		OFF
	MCLK/2	100MHz		DIS		OFF
	MCLK/4 (PD1)	50MHz		DIS		OFF
	ULPCLK	40MHz			32kHz	OFF
	LFCLK	32kHz				OFF
	HFCLK	OPT		DIS		OFF
	CANCLK	OPT		DIS		OFF
	LFCLK Monitor	OPT				OPT
	MCLK Monitor	OPT			DIS	OFF
PMU	POR monitor	EN				OFF
	BOR monitor	EN				OFF
	Core regulator	FULL DRIVE	FULL DRIVE	REDUCED DRIVE	LOW DRIVE	OFF
Core Functions	CPU	EN	DIS			OFF
	Flash	EN		DIS		OFF
	SRAM0	EN		DIS		OFF
	SRAM1/2/3	EN		OFF		OFF
PD1 Peripherals	ADC[0:2]	OPT		DIS		OFF
	PGA[0:2]	OPT		DIS		OFF
	CMPSS[0:3]	OPT		DIS		OFF
	ECAP[0:2]	OPT		DIS		OFF
	EQEP[0:3]	OPT		DIS		OFF
	AES	OPT		DIS		OFF
	MCAN0	OPT		DIS		OFF
	CRC	OPT		DIS		OFF
	DMA0	OPT		DIS		OFF
	GSC	OPT		DIS		OFF
	KESTORE	OPT		DIS		OFF
	UC[0:5]	OPT		DIS		OFF
	TIMG12_0	OPT		DIS		OFF
	TIMG4_0	OPT		DIS		OFF
	VREF	OPT		DIS		OFF
PD0 Peripherals	GPIO[0:3]	OPT				OFF
	SYSCTL	EN				OFF
	WWDT	OPT				OFF
IOMUX, DEBUGSS and IO Wakeup		EN				DIS w/ WAKE
Wake Sources		N/A	ANY IRQ	PD0 IRQ	PD0 IRQ	GPIO, NRST, SWD

7.8.3 Clock Module (CKM)

The clock module provides the following oscillators:

- **LFOSC**: Internal low-frequency oscillator (32 kHz)
- **SYSOSC**: Internal high-frequency oscillator (4 MHz or 32 MHz with factory trim, 16 MHz or 24 MHz with user trim)
- **HFXT/HFCKIN**: High-frequency external crystal oscillator or digital clock input (4 to 48 MHz)
- **SYSPLL**: System phase locked loop with 3 outputs (32 to 200 MHz)

The following clocks are distributed by the clock module for use by the processor, bus, and peripherals:

- **MCLK**: Main system clock for PD1 peripherals in MCLK domain, derived from SYSOSC, LFCLK, or HSCLK, active in RUN and SLEEP modes
- **MCLK/2**: Main system clock for PD1 peripherals in MCLK/2 domain, derived MCLK and divided by 2
- **MCLK/4**: Main system clock for PD1 peripherals in MCLK/4 domain, derived MCLK and divided by 4
- **CPUCLK**: Clock for the processor (derived from MCLK), active in RUN mode
- **ULPCLK**: Ultra-low power clock for PD0 peripherals, active in RUN, SLEEP, STOP, and STANDBY modes
- **LFCLK**: 32-kHz fixed low-frequency clock for peripherals or MCLK, active in RUN, SLEEP, STOP, and STANDBY modes
- **XCLKOUT**: Used to output a clock externally, available in RUN, SLEEP, STOP, and STANDBY modes
- **HFCLK**: High-frequency clock derived from HFXT or HFCLK_IN, available in RUN and SLEEP mode
- **HSCLK**: High-speed clock derived from HFCLK or the SYSPLL, available in RUN and SLEEP mode
- **CANCLK**: CAN functional clock, derived from HFCLK or SYSPLL

For more details, see the CKM chapter of the *Technical Reference Manual*.

7.9 UNICOMM (UART/I²C/SPI)

UNICOMM is a highly flexible peripheral which can be configured to operate with a UART, SPI, I²C Controller or a I²C Target protocol at runtime. The user can select one of the serial interfaces during initialization. The peripheral uses shared 16-deep FIFOs in each UCx instance to maximize the device capability. A scalable peripheral group (SPG) combines one or more UNICOMM instances for special functions like inter-module internal loopback and I2C pairing. [Table 7-5](#) describes the peripheral serial interfaces available on each UNICOMM instance and how these are grouped into SPG groupings on the device.

Table 7-5. UNICOMM (UCx) Serial Interface

SERIAL PERIPHERAL GROUP	UNICOMM INSTANCE	UART	SPI	I ² C Controller	I ² C Target
SPG0 (PD1)	UC0	Basic	Basic	Basic	Basic
	UC1	Basic	Basic	Basic	Basic
	UC2	Basic+	-	Advanced	Advanced
SPG1 (PD1)	UC3	Basic	Basic	Basic	Basic
	UC4	Basic	Basic	Basic	Basic
	UC5	Basic+	-	Advanced	Advanced

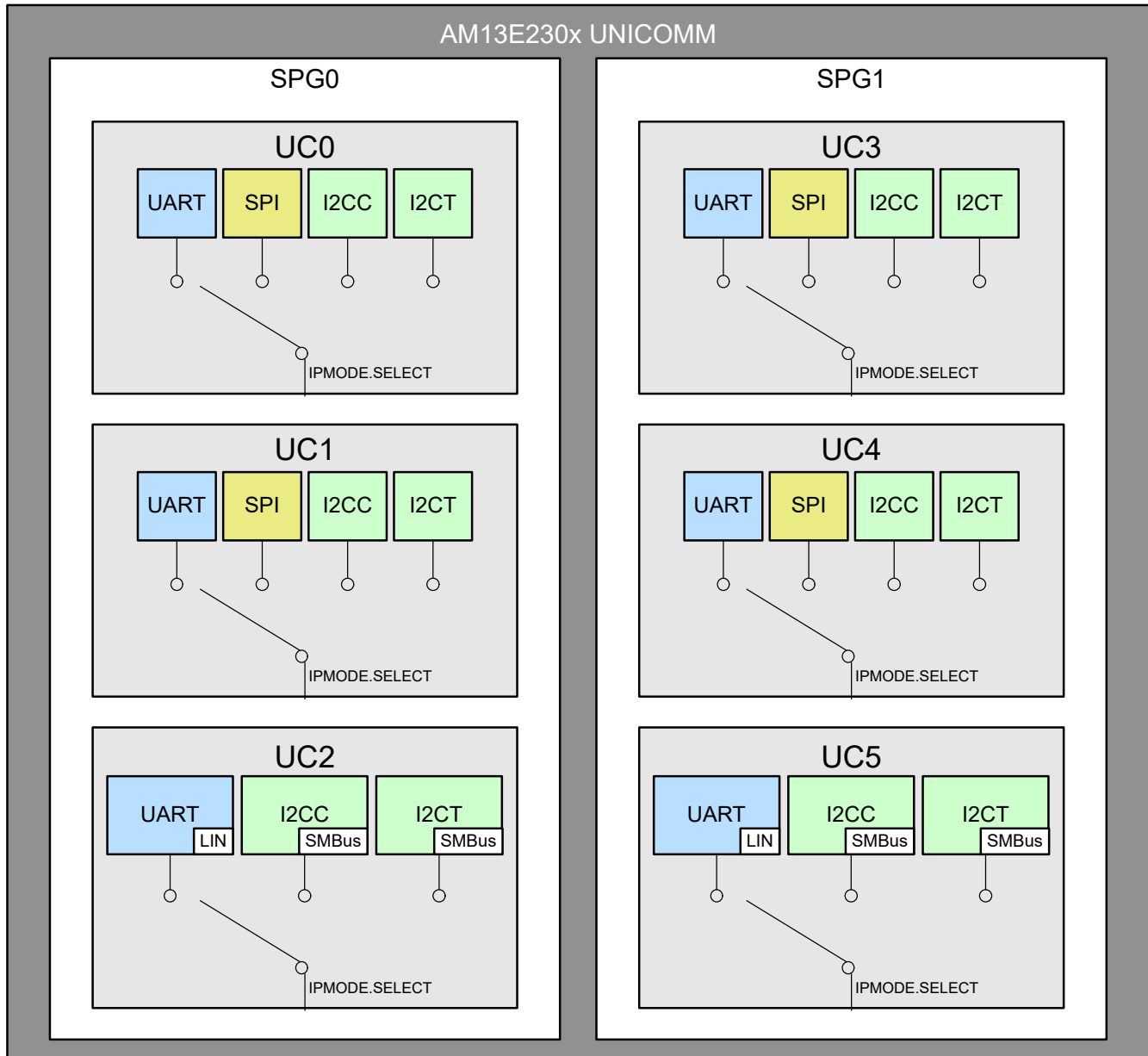


Figure 7-2. Unicomm Block Diagram

7.9.1 Universal Asynchronous Receiver/Transmitter (UART)

The universal asynchronous receiver/transmitter (UART) UNICOMM peripheral mode supports the following key features:

- Fully programmable serial interface:
 - 5, 6, 7 or 8 data bits
 - Even, odd, stick, or no-parity bit generation and detection
 - 1 or 2 stop bit generation
 - LSB-first or MSB-first data transmit and receive
 - Line-break detection
 - Programmable baud-rate generation with oversampling by 16, 8 or 3
- Separate 16-deep transmit (TX) and receive (RX) FIFOs
- Direct Memory Access (DMA) Support

- Local Interconnect Network (LIN) hardware support (Basic+ instances)
- Transmit to receive internal loopback mode operation
- Hardware Flow Control (CTS/RTS)
- RS485 Flow Control support
- Idle-line Multiprocessor Mode
- 9-Bit UART Mode
- ISO7816 Smartcard support (Basic instances)

See [Table 7-6](#) for more detailed information on supported features for individual UCx instances.

Table 7-6. UART (UNICOMM) Features

Supported Features	Basic Instances: UC0.UART, UC1.UART, UC3.UART,UC4.UART	Basic+ Instances: UC2.UART, UC5.UART
Active in Stop and Standby Mode	Yes	Yes
Hardware Flow Control (CTS/RTS)	Yes	Yes
9-bit Mode	Yes	Yes
LIN Mode	No	Yes
ISO7816 Smart Card	Yes	No
DMA Access / Support	Yes	Yes
Internal Loopback Support	Yes	Yes
Idle-line Multiprocessor Mode	Yes	Yes
RS485 Flow Control Mode	Yes	Yes

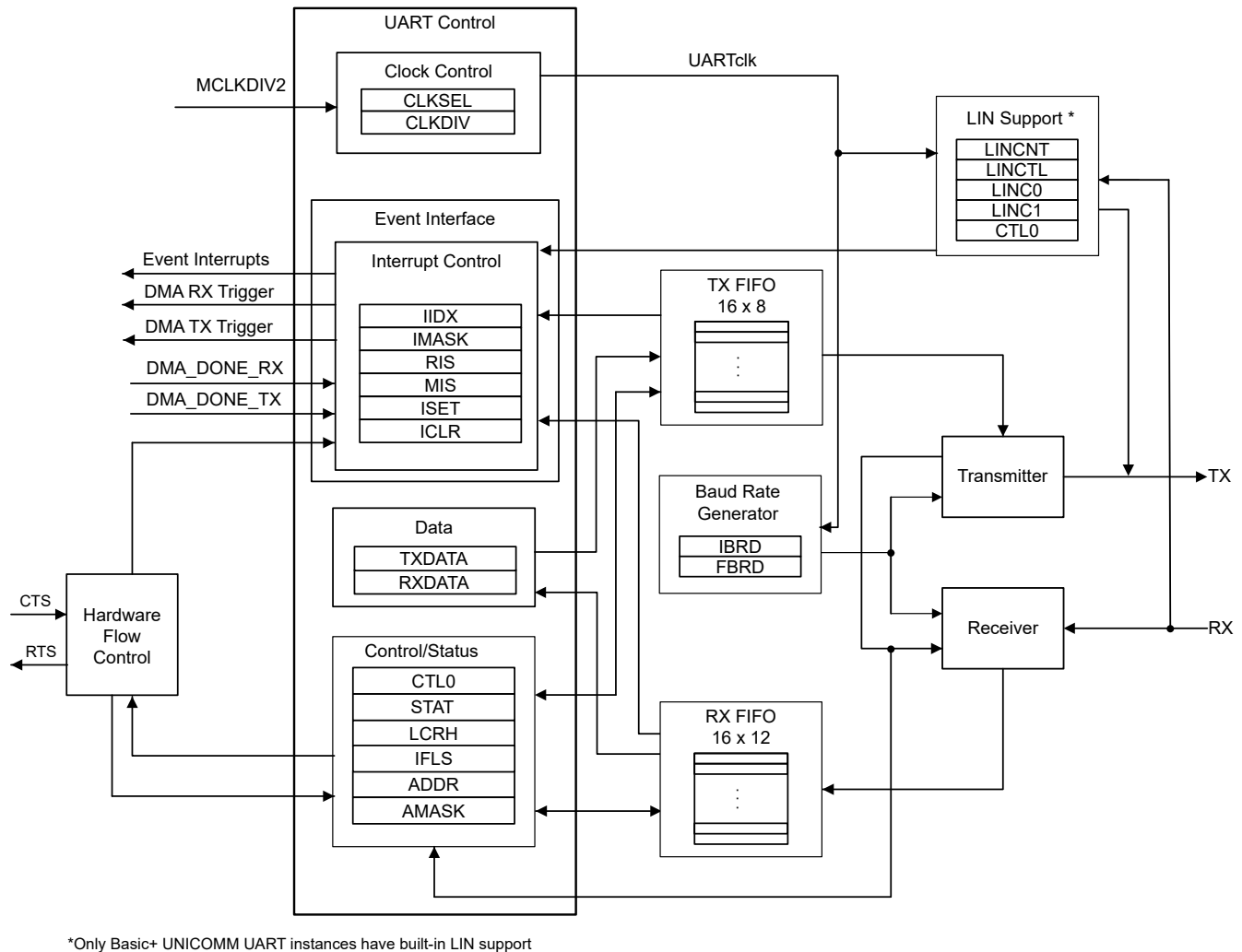


Figure 7-3. UART Functional Block Diagram

For more details, see the UART (UNICOMM) chapter of the *AM13E230x Microcontrollers Technical Reference Manual*.

7.9.2 Inter-Integrated Circuit (I2C)

The inter-integrated circuit (I2C) UNICOMM peripheral modes (I2C Controller and I2C Target) support the following key features:

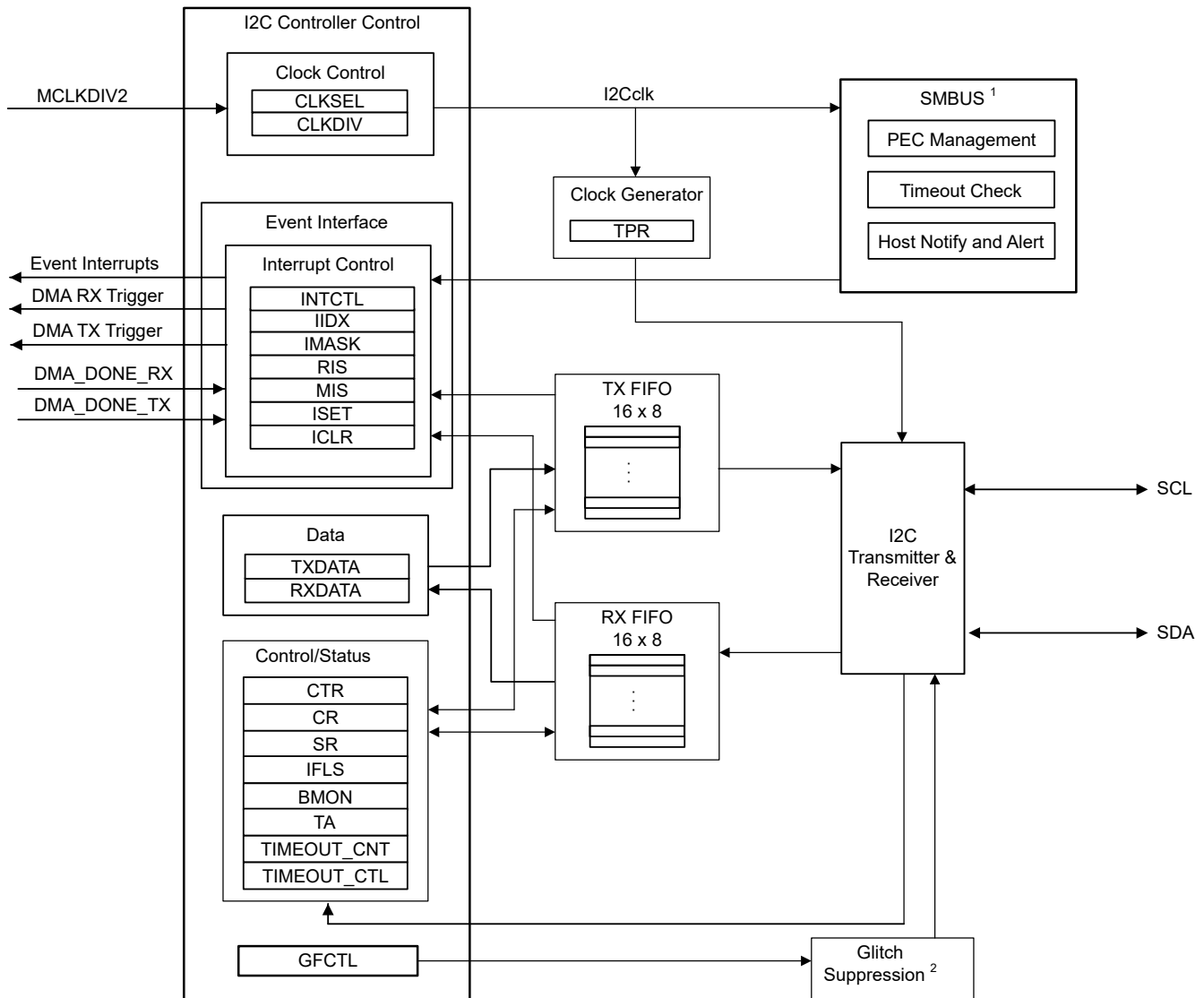
- 7-bit and 10-bit addressing modes
- Dual Addressing Support
- Standard-mode (Sm) Support, with a bit rate up to 100 kbit/s
- Fast-mode (Fm) Support, with a bit rate up to 400 kbit/s
- Fast-mode Plus (Fm+) Support, with a bit rate up to 1 Mbit/s
 - Supported on open drain IOs (ODIO) and high-drive (HDIO) IOs only
- Separate 16-deep transmit (TX) and receive (RX) FIFOs
- Direct Memory Access (DMA) Support
- SMBus 3.0 Support
 - Packet Error Checking (PEC)
 - Timeout Detection
 - Enhanced Frame Acknowledgement: Manual or Automatic
 - Default Device/Host/Alert Response Address

- Target Arbitration
- Analog and Digital Glitch Suppresion

See [Table 7-7](#) for more detailed information on supported features for individual UCx instances and I2C operating modes (I2C Controller and I2C Target).

Table 7-7. I2C Controller and Target (UNICOMM) Features

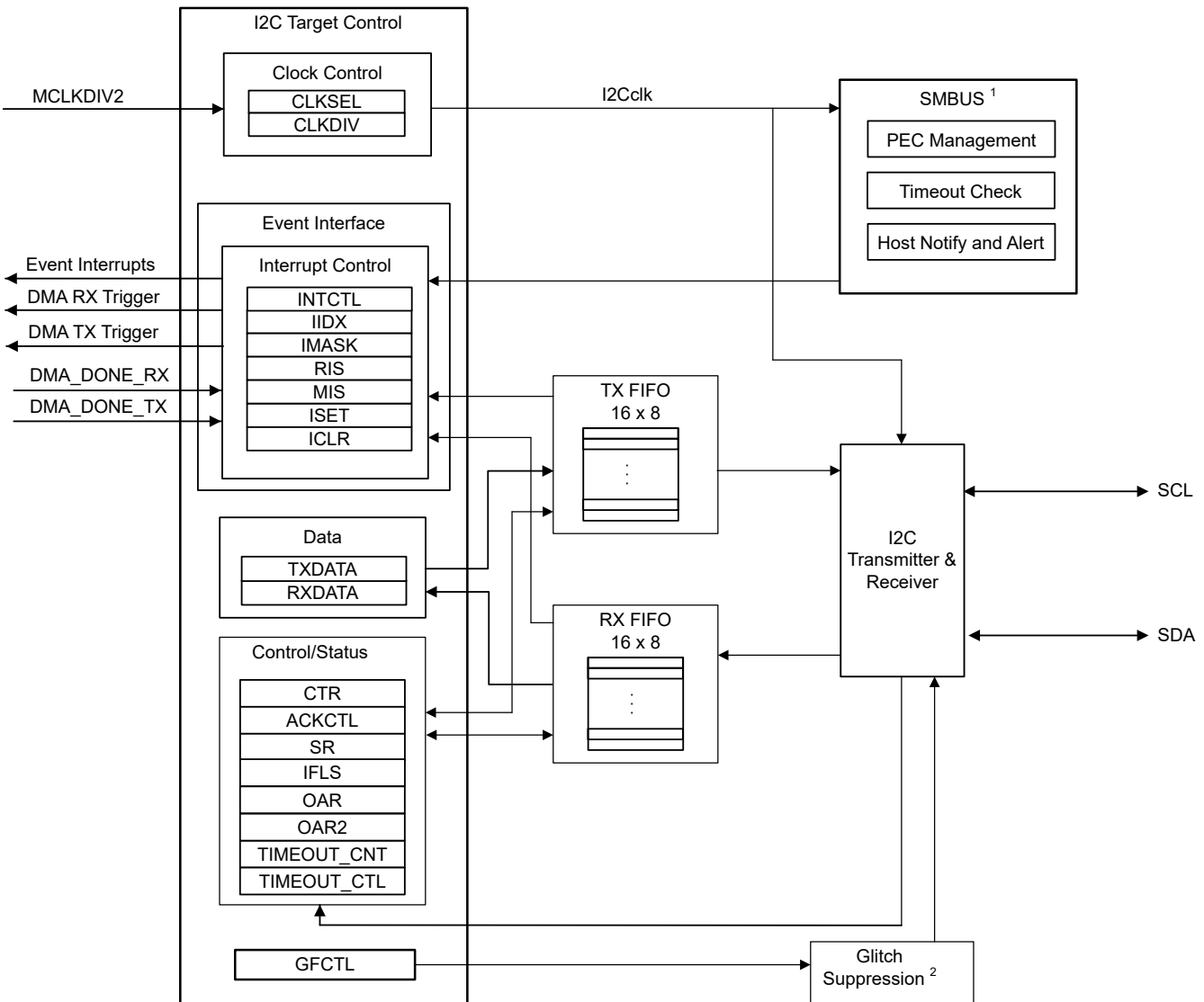
Supported Features	I2C Controllers		I2C Targets	
	Basic Instances: UC0.I2CC, UC1.I2CC, UC3.I2CC, UC4.I2CC	Advanced Instances: UC2.I2CC, UC5.I2CC	Basic Instances: UC0.I2CT, UC1.I2CT, UC3.I2CT, UC4.I2CT	Advanced Instances: UC2.I2CT, UC5.I2CT
Standard-mode (Sm) Support	Yes	Yes	Yes	Yes
Fast-mode (Fm) Support	Yes	Yes	Yes	Yes
Fast-mode Plus (Fm+) Support	Yes	Yes	Yes	Yes
Analog Glitch Filtering	No	Yes	No	Yes
Digital Glitch Filtering	Yes	No	Yes	No
Burst Mode	No	Yes	-	-
SMBus v3.0 Support	No	Yes		
Dual Addressing	-	-	No	Yes



¹ Only Advanced I2CC instances have built-in SMBUS support

² Basic I2CC instances have only digital glitch support and Advanced I2CC instances have only analog glitch support

Figure 7-4. I2C Controller (I2CC) Functional Block Diagram



¹ Only Advanced I2CT instances have built-in SMBUS support

² Basic I2CT instances have only digital glitch support and Advanced I2CT instances have only analog glitch support

For more details, see the I2C (UNICOMM) chapter of the *AM13E230x Microcontrollers Technical Reference Manual*.

Figure 7-5. I2C Target (I2CT) Functional Block Diagram

7.9.3 Serial Peripheral Interface (SPI)

The serial peripheral interface (SPI) UNICOMM peripheral mode supports the following key features:

- Supports up to 40 Mbps/s in both controller and peripheral mode ¹
- Controller or Peripheral Modes
- Separate 16-deep transmit (TX) and receive (RX) FIFOs
- Direct Memory Access (DMA) Support
- Single Parity for Transmit and Receive

¹ Only SPI signals on HSIO pins support data rates up to 40 Mbps/s; see the *Pin Diagrams* section for HSIO pins.

- Programmable clock prescaler and bit rate
- Programmable data frame size from 4-16 bits (controller mode) and 7-16 bits (peripheral mode)
- Texas Instruments Synchronous Serial and Motorola SPI Frame Format Support

All UCx instances with SPI peripheral mode available on this device (UC0.SPI, UC1.SPI, UC3.SPI, and UC4.SPI) support all of the above features.

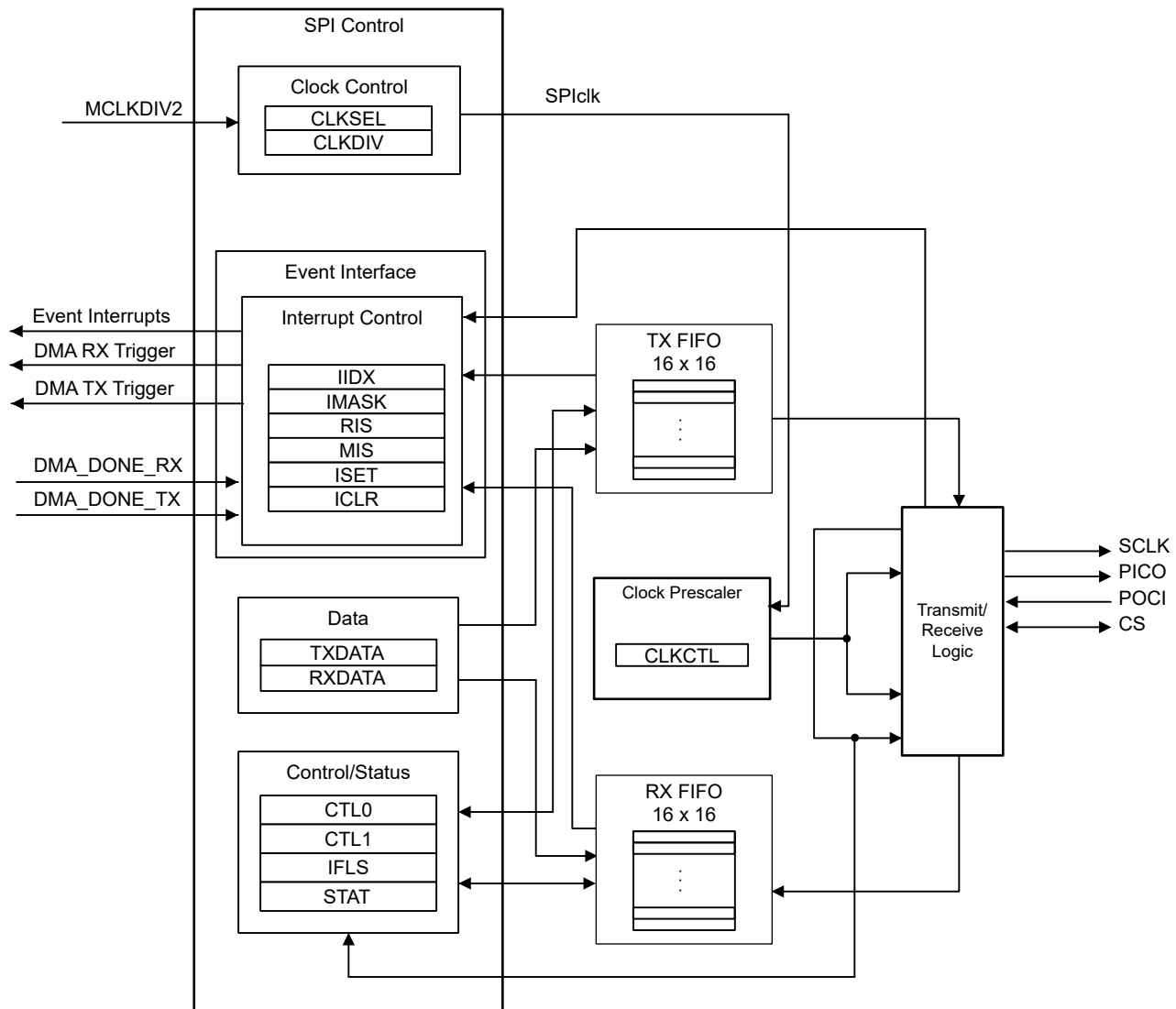


Figure 7-6. SPI Functional Block Diagram

For more details, see the SPI (UNICOMM) chapter of the *AM13E230x Microcontrollers Technical Reference Manual*.

7.10 CAN-FD

The controller area network (CAN) controller enables communication with a CAN2.0A, CAN2.0B, or CAN-FD bus and is compliant to ISO 11898-1:2015 standard supporting up to 5Mbit/s bit rate. Key features of the CAN-FD peripheral include:

- Full support for 64-byte CAN-FD frames
- Dedicated 1KB message SRAM with ECC
- Configurable transmit FIFO, transmit queue and event FIFO (up to 32 elements)
- Up to 32 dedicated transmit buffers and 64 dedicated receive buffers

- Two configurable receive FIFOs (up to 64 elements each)
- Up to 128 filter elements
- Two interrupt lines
- Power-down and wake-up support
- Timestamp counter

For more details, see the CAN-FD chapter of the AM13E230x 200-MHz Microcontrollers Technical Reference Manual.

7.11 Serial Wire Debug Interface

A serial wire debug (SWD) two-wire interface is provided via an Arm compatible serial wire debug port (SW-DP) to enable access to multiple debug functions within the device. For a complete description of the debug functionality, see the debug chapter of the AM13E230x 200-MHz Microcontrollers Technical Reference Manual.

Table 7-8. Serial Wire Debug Pin Requirements and Functions

DEVICE SIGNAL	DIRECTION	SWD FUNCTION
SWCLK	Input	Serial wire clock from debug probe
SWDIO	Input/Output	Bi-directional (shared) serial wire data

7.12 External Peripheral Interface (EPI)

The external peripheral interface (EPI) is a high-speed parallel bus for external peripherals or memory. The module has several modes of operation to interface seamlessly to many types of external devices. The EPI is similar to a standard microprocessor address/data bus, except that it must typically be connected to just one type of external device. Enhanced capabilities include DMA support, clocking control and support for external FIFO buffers.

The EPI has the following features:

- 8/16/32-bit dedicated parallel bus for external peripherals and memory
- Memory interface supports contiguous memory access independent of data bus width, thus enabling code execution directly from SDRAM, SRAM and Flash memory
- Blocking and non-blocking reads
- Separates processor from timing details through use of an internal write FIFO
- Efficient transfers using Direct Memory Access Controller (DMA)
 - Separate channels for read and write
 - Read channel request asserted by programmable levels on the internal non-blocking read FIFO (NBRFIFO)
 - Write channel request asserted by empty on the internal write FIFO (WFIFO)

The EPI supports three primary functional modes: Synchronous Dynamic Random Access Memory (SDRAM) mode, Traditional Host-Bus mode, and General-Purpose mode. The EPI module also provides custom GPIOs; however, unlike regular GPIOs, the EPI module uses a FIFO in the same way as a communication mechanism and is speed-controlled using clocking.

- Synchronous Dynamic Random Access Memory (SDRAM)
 - Supports x16 (single data rate) SDRAM at up to 62.5MHz
 - Supports low-cost SDRAMs up to 64 MB (512 megabits)
 - Includes automatic refresh and access to all banks/rows
 - Includes a Sleep/Standby mode to keep contents active with minimal power draw
 - Multiplexed address/data interface for reduced pin count
- Host-bus
 - Traditional x8 and x16 MCU bus interface capabilities
 - Similar device compatibility options as PIC, ATmega, 8051, and others
 - Access to SRAM, NOR Flash memory, and other devices, with up to 1 MB of addressing in non-multiplexed mode and 256 MB in multiplexed mode (512 MB in Host-Bus 16 mode with no byte selects)
 - Support of both muxed and de-muxed address and data

- Access to a range of devices supporting the non-address FIFO x8 and x16 interface variant, with support for external FIFO (XFIFO) EMPTY and FULL signals
- Speed controlled, with read and write data wait-state counters
- Support for read/write burst mode to Host Bus
- Multiple chip select modes including single, dual, and quad chip selects, with and without ALE
- External iRDY signal provided for stall capability of reads and writes
- Manual chip-enable (or use extra address pins)
- General Purpose
 - Wide parallel interfaces for fast communications with CPLDs and FPGAs
 - Data widths up to 32 bits
 - Data rates up to 150 MB/second
 - Optional "address" sizes from 4 bits to 20 bits
 - Optional clock output, read/write strobes, framing (with counter-based size), and clock-enable input
- General parallel GPIO
 - 1 to 32 bits, FIFOed with speed control
 - Useful for custom peripherals or for digital data acquisition and actuator controls

7.13 Bootstrap Loader (BSL)

The bootstrap loader (BSL) enables configuration of the device as well as programming of the device memory through a UART, I2C, or MCAN serial interface. Access to the device memory and configuration through the BSL is protected by a 256-bit user-defined HASH password. The BSL can be completely disabled in the device configuration, if desired. The BSL is enabled by default from TI to support use of the BSL for production programming.

A minimum of two pins are required to use the BSL: the BSL_UART_RX and BSL_UART_TX signals (for UART), or the BSL_I2C_SCL and BSL_I2C_SDA signals (for I2C) or the BSL_CAN_RX and BSL_CAN_TX signals (for MCAN). Additionally, one or two additional pins (BSL_INVOKE and NRST) can be used for controlled invocation of the bootloader by an external host.

If enabled, the BSL can be invoked (started) in the following ways:

- The BSL is invoked during the boot process if the BSL_invoke pin state matches the defined BSL_invoke logic level. If the device fast boot mode is enabled, this invocation check is skipped. An external host can force the device into the BSL by asserting the invoke condition and applying a reset pulse to the NRST pin to trigger a BOOTRST, after which the device verifies the invoke condition during the reboot process and start the BSL if the invoke condition matches the expected logic level.
- The BSL is automatically invoked during the boot process if the reset vector and stack pointer are left unprogrammed. As a result, a blank device from TI invokes the BSL during the boot process without any need to provide a hardware invoke condition on the BSL_invoke pin. This enables production programming using just the serial interface signals.
- The BSL can be invoked at runtime from application software by issuing a SYSRST with BSL entry command.

Table 7-9. BSL Pin Requirements and Functions

DEVICE SIGNAL	CONNECTION	BSL FUNCTION
BSL_UART_RX	Required for UART	UART receive signal (RX), an input
BSL_UART_TX	Required for UART	UART transmit signal (TX), an output
BSL_I2C_SCL	Required for I2C	I2C BSL clock signal (SCL)
BSL_I2C_SDA	Required for I2C	I2C BSL data signal (SDA)
BSL_CAN_RX	Required for CAN	MCAN receive signal (RX), an input
BSL_CAN_TX	Required for CAN	MCAN receive signal (TX), an output
BSL_INVOKE	Optional	Active-high digital input used to start the BSL during boot

Table 7-9. BSL Pin Requirements and Functions (continued)

DEVICE SIGNAL	CONNECTION	BSL FUNCTION
NRST	Optional	Active-low reset pin used to trigger a reset and subsequent check of the invoke signal (BSL_invoke)

For a complete description of the BSL functionality and command set, see the [AM13E230x Bootloader User's Guide](#).

7.14 Security

Security features are enforced by the Global Security Controller (GSC). The AM13E230x microcontroller supports the following security features using a combination of hardware blocks, BootROM software, and Customer Secure Code (CSC) programmable into the flash sectors:

- Secure boot
- Secure debug
- Secure firmware update
- Secure key storage
- Secure key management
- Privileged/Non-Privileged partitioning of on chip resources (flash sectors, RAM chunks, peripherals)

In addition to the GSC, AM13E230x has two other security hardware IPs present on the MCU: AESADV and the Keystore Controller.

7.14.1 Global Security Controller

The Global Security Controller (GSC) is implemented on the AM13E230x microcontroller to support the following features:

- Provides privileged and non-privileged context information to access on-chip memory and peripherals
- Monitors the bus transactions from multiple initiators to ensure context of access to targets is maintained
- Logs errors for incorrect transactions on the bus
- Performs interrupt or reset generation when context is violated
- Provides mechanism to handle static and dynamic configuration of the security block
- Provides mechanism for managing the life cycle of the device.

The GSC is comprised of the following blocks:

- SRAM Protection Controller (SPC): Controls the context for SRAM
- Flash Protection Controller (FPC): Controls the context for on-chip flash
- Peripheral Protection Controller (PPC): Controls the context for peripherals
- Secure Exception Controller (SEC): Logs and provides action on a security exception

7.14.2 AESADV

The AESADV accelerator module performs encryption and decryption of 128-bit data blocks with 128-bit or 256-bit keys in hardware according to the Advanced Encryption Standard (AES).

7.14.3 Keystore Controller

The Keystore Controller on the AM13E230x MCU provides secure management of the Advanced Encryption Engine (AES) keys. During the execution of secure customer code, keys are securely desposited into the Keystore Controller. The AES engine can then access keys in a secure manner without leaking any key data to observers.

Both 128- and 256-bit keys can be stored in the Keystore key slots.

7.15 Timers (TIMx)

The timer peripherals in these devices support the following key features, for specific configuration see [Table 7-10](#):

Specific features for the general-purpose timer (TIMGx) include:

- 16-bit and 32-bit timers with up, down or up-down counting modes, with repeat-reload mode
- Selectable and configurable clock source
- 8-bit programmable prescaler to divide the counter clock frequency
- Two independent CC channels for
 - Output compare
 - Input capture
 - PWM output

- One-shot mode
- Shadow CC/load register available
- Support interrupt/DMA trigger generation and cross peripherals (such as ADC) trigger capability

Table 7-10. TIMx Configurations

TIMER NAME	POWER DOMAIN	RESOLUTION	PRESCALE R	REPEAT COUNTER	CAPTURE / COMPARE CHANNELS	PHASE LOAD	SHADOW LOAD	SHADOW CC	DEADBAND	FAULT	QEI
TIMG4_0	PD1	16-bit	8-bit	–	2	–	Yes	Yes	–	–	–
TIMG12_1	PD1	32-bit	–	–	2	–	–	Yes	–	–	–

7.16 WWDT

The windowed watchdog timer (WWDT) can be used to supervise the operation of the device, specifically code execution. The WWDT can be used to generate a reset or an interrupt if the application software does not successfully reset the watchdog within a specified window of time. Key features of the WWDT include:

- 25-bit counter
- Programmable clock divider
- Eight software selectable watchdog timer periods
- Eight software selectable window sizes
- Support for stopping the WWDT automatically when entering a sleep mode
- Interval timer mode for applications which do not require watchdog functionality

8 Applications, Implementation, and Layout

8.1 External Oscillator

For more information about External Oscillators, see the *Clock Specifications* section.

8.2 JTAG and TRACE

Texas Instruments supports a variety of eXtended Development System (XDS™) JTAG controllers with various debug capabilities beyond only JTAG support. A summary of this information is available in the [XDS Target Connection Guide](#).

For recommendations on JTAG, and TRACE routing, see the [Emulation and Trace Headers Technical Reference Manual](#)

8.3 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

9 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

9.1 Third-Party Products Disclaimer

TI'S PUBLICATION OF INFORMATION REGARDING THIRD-PARTY PRODUCTS OR SERVICES DOES NOT CONSTITUTE AN ENDORSEMENT REGARDING THE SUITABILITY OF SUCH PRODUCTS OR SERVICES OR A WARRANTY, REPRESENTATION OR ENDORSEMENT OF SUCH PRODUCTS OR SERVICES, EITHER ALONE OR IN COMBINATION WITH ANY TI PRODUCT OR SERVICE.

9.2 Device Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all ASM MCU devices and support tools. Each ASM MCU commercial family member has one of two prefixes: ASM or X. These prefixes represent evolutionary stages of product development from engineering prototypes (X) through fully qualified production devices (ASM).

X – Experimental device that is not necessarily representative of the final device's electrical specifications

ASM – Fully qualified production device

X devices are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes." ASM devices have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies. Predictions show that prototype devices (X) have a greater failure rate than the standard production devices. TI recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

TI device nomenclature also includes a suffix with the device family name. This suffix indicates the temperature range, package type, and distribution format. [Device Nomenclature](#) provides a legend for reading the complete device name.

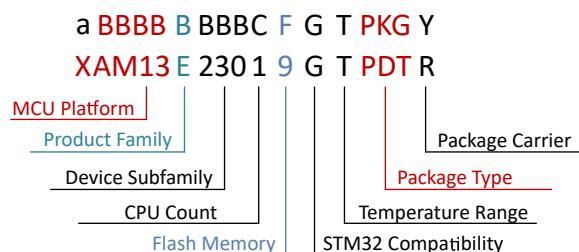


Figure 9-1. Device Nomenclature

Nomenclature Section	Device/Platform Subfamily	Descriptor	Device Options
Device Evolution		a	X = Prototype P = Preproduction (no reliability data) BLANK = Production
MCU Platform	Platform	B	AM1 = AM1x Family of MCU's
	CPU Type		3 = Cortex M33 CPU
Product/Family/Type		B	E = Entry Level Motor Control Device
Device Subfamily	Frequency	B	2 = 200 MHz Class Device
	Voltage	B	3 = 3.3V Design
	Variant	B	0 = Variant 0 in this family series
CPU Count		C	1 = 1x CPU Cores

Nomenclature Section	Device/Platform Subfamily	Descriptor	Device Options
Flash Memory		F	7 = 128KB Flash 8 = 256KB Flash 9 = 512KB Flash
STM32 Compatibility		G	G = STM32G4 Pin Compatible H = STM32H5 Pin Compatible
Temperature Range		T	T = -40°C to 105°C (Ambient)
Package Type		PKG	PDT = LQFP128 PZ = LQFP100_G/H PN = LQFP80 PM = LQFP64_G/H PT = LQFP48 RGZ = QFN48
Package Carrier		Y	R = Tape & Reel Carrier

For orderable part numbers of ASM devices in different package types, see the Package Option Addendum of this document, [ti.com](https://www.ti.com), or contact your TI sales representative.

9.3 Tools and Software

Design Kits and Evaluation Modules

[AM13E230LaunchPad \(LP\)
Boards: LP-AM13E230](#) [Update link](#)

Empowers you to immediately start developing on the industry's best integrated analog and most cost-optimized general purpose ASM MCU family. Exposes all device pins and functionality; includes some built-in circuitry, out-of-box software demos, and on-board XDS110 debug probe for programming/debugging.

The LP ecosystem includes dozens of [BoosterPack](#) stackable plug-in modules to extend functionality.

Embedded Software

[AM13 Software Development Kit \(SDK\)](#)[\(update link\)](#)

Contains software drivers, middleware libraries, documentation, tools, and code examples that create a familiar and easy user experience for all AM13 devices.

Software Development Tools

[TI Developer Zone](#)

Start your evaluation and development on a web browser without any installation. Cloud tools also have a downloadable, offline version.

[TI Resource Explorer](#)

Online portal to TI SDKs. Accessible in CCS IDE or in TI Cloud Tools.

[SysConfig](#)

Intuitive GUI to configure device and peripherals, resolve system conflicts, generate configuration code, and automate pin mux settings. Accessible in CCS IDE, in TI Cloud Tools or a standalone version. [\(offline version\)](#)

[ASM Academy](#)[\(update the link\)](#)

Great starting point for all developers to learn about the ASM MCU Platform with training modules that span a wide range of topics. Part of TIRex.

[GUI Composer](#)

GUIs that simplify evaluation of certain ASM MCU features, such as configuring and monitoring a fully integrated analog signal chain without any code needed.

IDE & compiler toolchains

[Code Composer Studio™ \(CCS\)](#)

Code Composer Studio is an integrated development environment (IDE) for TI's microcontrollers and processors. It comprises a suite of tools used to develop and debug embedded applications. CCS is completely free to use and is available on Eclipse and Theia frameworks.

[IAR Embedded Workbench® IDE](#)

IAR Embedded Workbench for Arm delivers a complete development toolchain for building and debugging embedded applications for ASM

AM13. The included IAR C/C++ Compiler generates highly optimized code for your application, and the C-SPY Debugger is a fully integrated debugger for source and disassembly level debugging with support for complex code and data breakpoint.

Keil® MDK IDE

Arm Keil MDK is a complete debugger and C/C++ compiler toolchain for building and debugging embedded applications for ARM AM13. Keil MDK includes a fully integrated debugger for source and disassembly level debugging. MDK provides full CMSIS compliance.

TI Arm-Clang

TI Arm Clang is included in the Code Composer Studio IDE.

GNU Arm Embedded Toolchain

The ARM AM13 SDK supports development using the open-source Arm GNU Toolchain. Arm GCC is supported by Code Composer Studio IDE (CCS).

9.4 Documentation Support

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

The following documents describe the AM13E230x MCUs. Copies of these documents are available on the Internet at www.ti.com.

Technical Reference Manual

AM13E230x 200MHz Microcontrollers Technical Reference Manual

This manual describes the modules and peripherals of the AM13E230x family of devices. Each description presents the module or peripheral in a general sense. Not all features and functions of all modules or peripherals are present on all devices. In addition, modules or peripherals can differ in the exact implementation on different devices. Pin functions, internal signal connections, and operational parameters differ from device to device.

9.5 Support Resources

[TI E2E™ support forums](#) are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

9.6 Trademarks

XDS™ and TI E2E™ are trademarks of Texas Instruments.

Arm® and Cortex® are registered trademarks of Arm Limited (or its subsidiaries or affiliates) in the US and/or elsewhere.

are registered trademarks of Arm Limited.

All trademarks are the property of their respective owners.

9.7 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.8 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

10 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

DATE	REVISION	NOTES
February 2026	*	Initial Release

11 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
XAM13E23019GTPDT	Active	Preproduction	TQFP (PDT) 128	90 JEDEC TRAY (10+1)	-	Call TI	Call TI	-40 to 105	
XAM13E23019GTPM	Active	Preproduction	LQFP (PM) 64	160 JEDEC TRAY (10+1)	-	Call TI	Call TI	-40 to 105	
XAM13E23019GTPN	Active	Preproduction	LQFP (PN) 80	190 JEDEC TRAY (10+1)	-	Call TI	Call TI	-40 to 105	
XAM13E23019GTPT	Active	Preproduction	LQFP (PT) 48	1000 LARGE T&R	-	Call TI	Call TI	-40 to 105	
XAM13E23019GTPZ	Active	Preproduction	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	-	Call TI	Call TI	-40 to 105	
XAM13E23019GTRGZR	Active	Preproduction	VQFN (RGZ) 48	4000 LARGE T&R	-	Call TI	Call TI	-40 to 105	

⁽¹⁾ **Status:** For more details on status, see our [product life cycle](#).

⁽²⁾ **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

⁽³⁾ **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

⁽⁴⁾ **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

⁽⁵⁾ **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

⁽⁶⁾ **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "-" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

Important Information and Disclaimer:The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative

and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

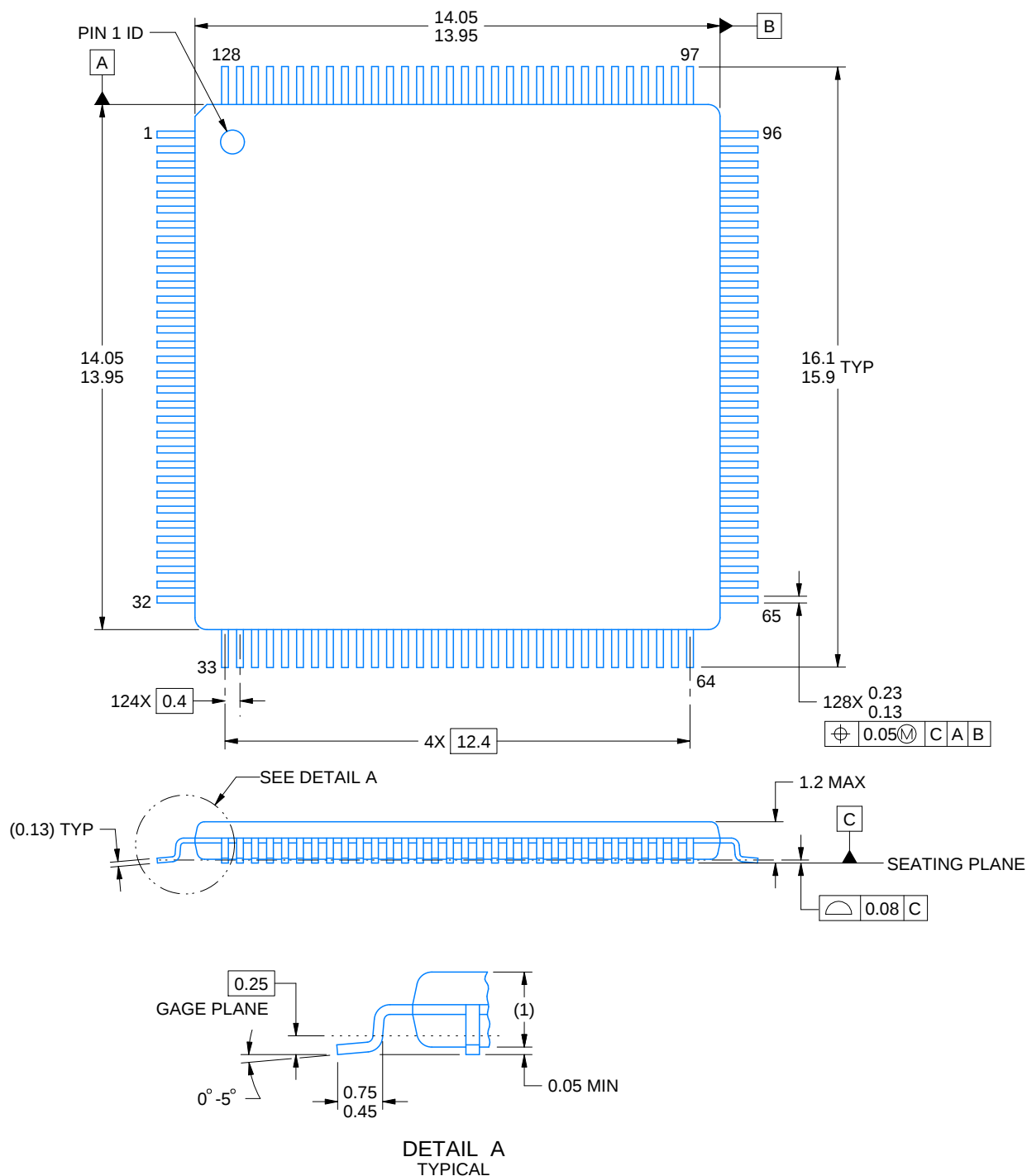
In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

PACKAGE OUTLINE

PDT0128A

TQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



4215171/A 10/2023

NOTES:

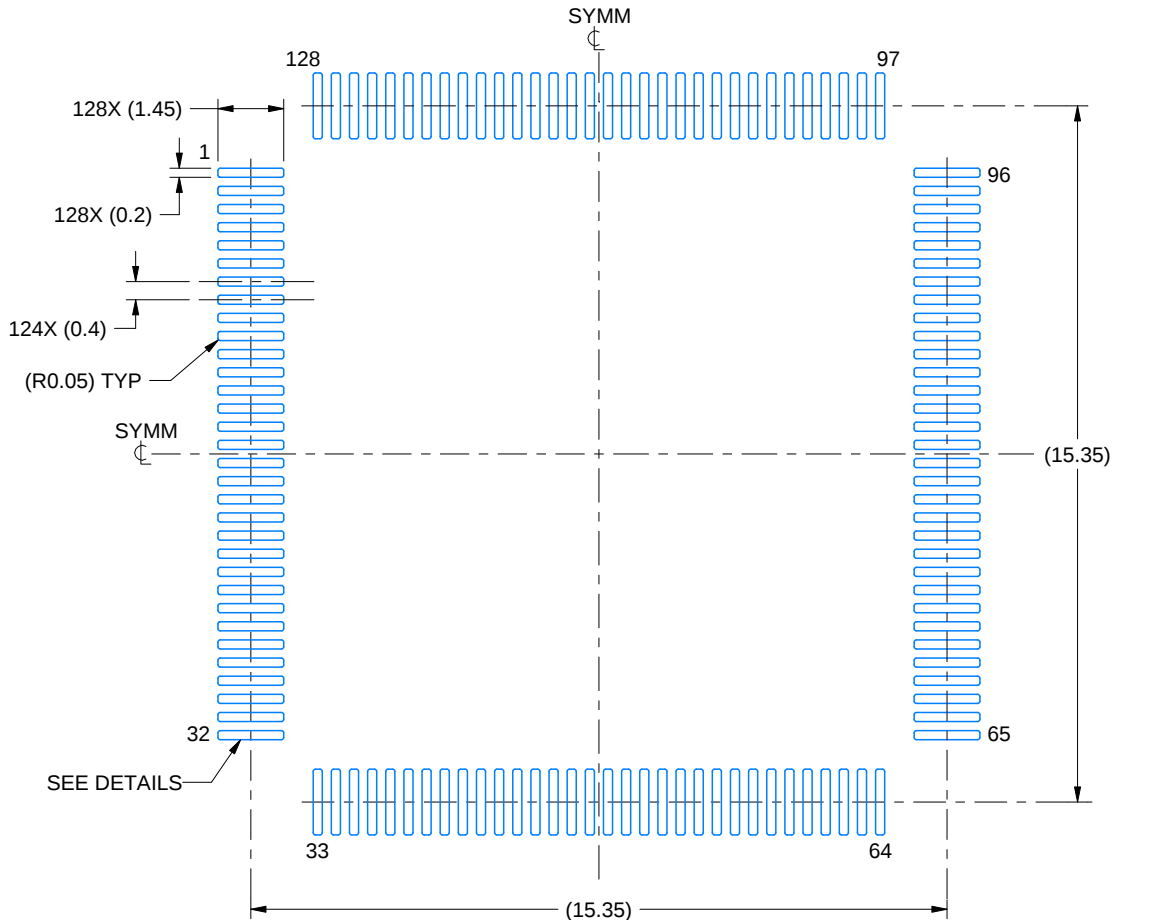
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.

EXAMPLE BOARD LAYOUT

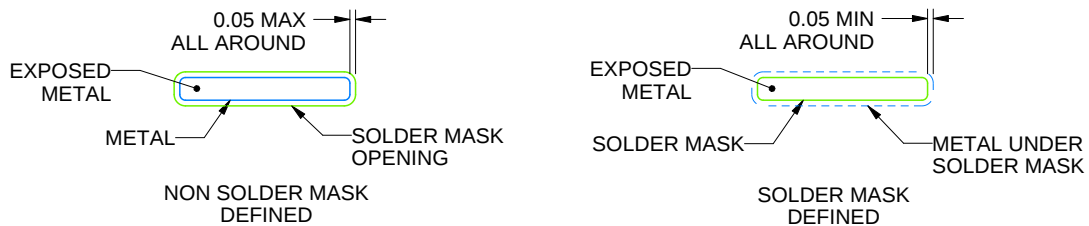
PDT0128A

TQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4215171/A 10/2023

NOTES: (continued)

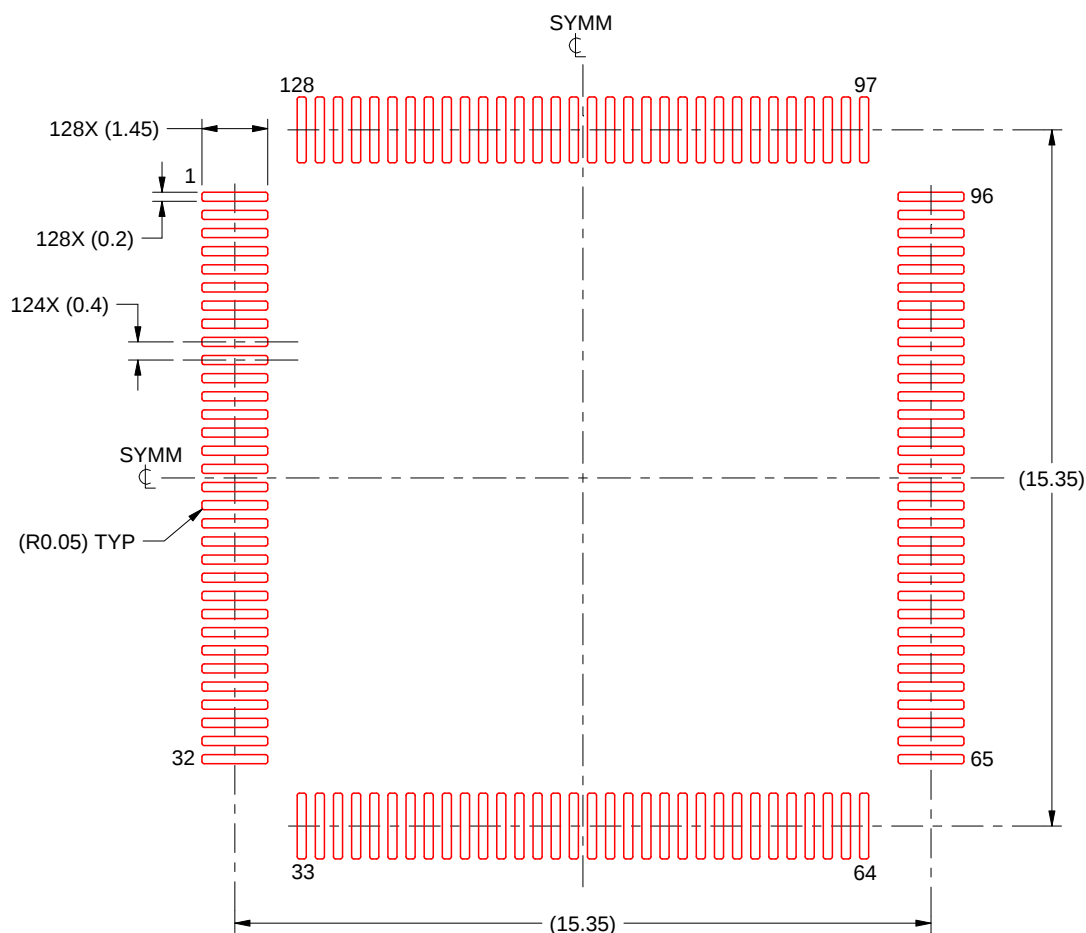
3. Publication IPC-7351 may have alternate designs.
4. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
5. For more information, see Texas Instruments literature numbers SLMA002 (www.ti.com/lit/slma002) and SLMA004 (www.ti.com/lit/slma004).

EXAMPLE STENCIL DESIGN

PDT0128A

TQFP - 1.2 mm max height

PLASTIC QUAD FLATPACK



SOLDER PASTE EXAMPLE
BASED ON 0.1 mm THICK STENCIL
SCALE:6X

4215171/A 10/2023

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
7. Board assembly site may have different recommendations for stencil design.

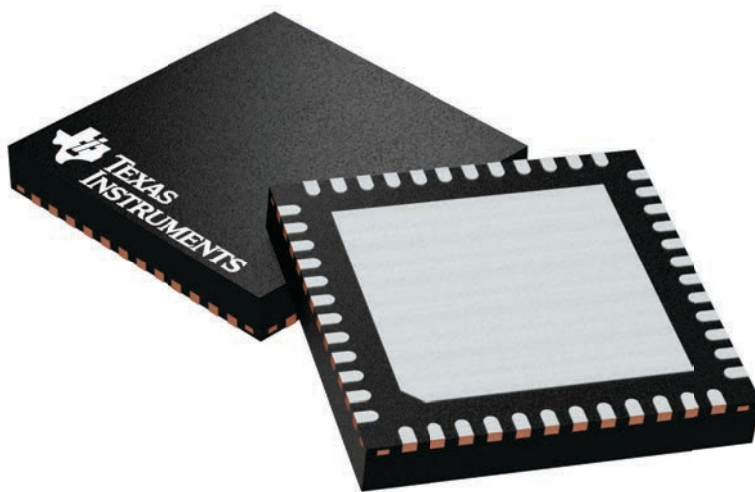
GENERIC PACKAGE VIEW

RGZ 48

VQFN - 1 mm max height

7 x 7, 0.5 mm pitch

PLASTIC QUADFLAT PACK- NO LEAD



Images above are just a representation of the package family, actual package may vary.
Refer to the product data sheet for package details.

4224671/A



LQFP - 1.6 mm max height

Technical drawing of a square electronic component, likely a microchip, showing dimensions and feature callouts.

Top View Dimensions:

- Overall width: 9.2
- Overall height: 9.2
- Distance from top edge to center of top pins: 8.8
- Distance from left edge to center of left pins: 7.2
- Distance from right edge to center of right pins: 6.8
- Distance from bottom edge to center of bottom pins: 7.2
- Distance from left edge to center of left pins: 6.8

Pin Dimensions:

- Pin pitch (horizontal): 4X 5.5
- Pin pitch (vertical): 44X 0.5
- Pin width: 0.27
- Pin thickness: 0.17

Feature Callouts:

- Feature A:** Callout to the top edge of the component.
- Feature B:** Callout to the left edge of the component.
- Feature C:** Callout to the bottom edge of the component.
- SEATING PLANE:** Indicated by a triangle pointing to the bottom edge.
- 0.08 M C A B:** Feature control frame for the bottom edge, indicating a maximum material condition (M) and a tolerance of 0.08.
- 0.1 C:** Feature control frame for the bottom edge, indicating a tolerance of 0.1.

Detail A:

Detail A shows a cross-section of the component, highlighting the pin profile and the seating plane. Dimensions include:

- Pin height: 1.6 MAX
- Pin width: 0.25
- Pin thickness: 0.75
- Pin pitch: 0.45
- Pin angle: 0° - 7°
- Pin thickness: 0.05 MIN
- Pin height: 1.45
- Pin height: 1.35

SEE DETAIL A: Callout to the top edge of the component.

NOTES:

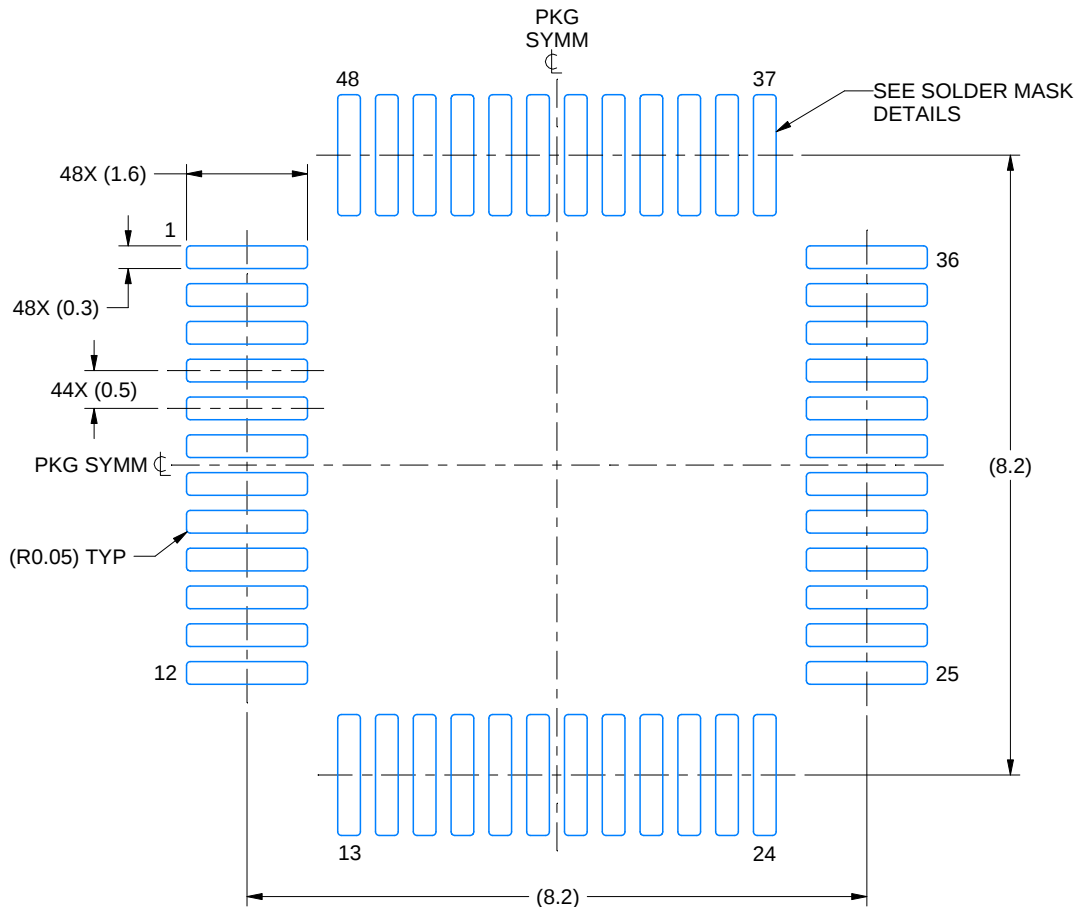
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration MS-026.
4. This may also be a thermally enhanced plastic package with leads connected to the die pads.

EXAMPLE BOARD LAYOUT

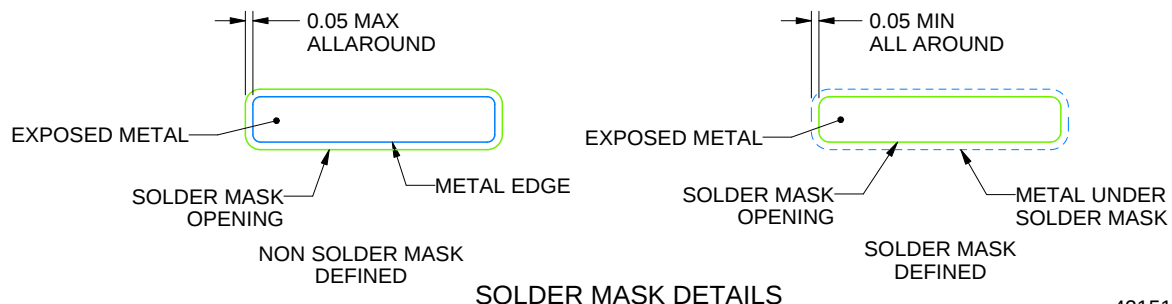
PT0048A

LQFP - 1.6 mm max height

LOW PROFILE QUAD FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE 10.000



SOLDER MASK DETAILS

4215159/B 11/2023

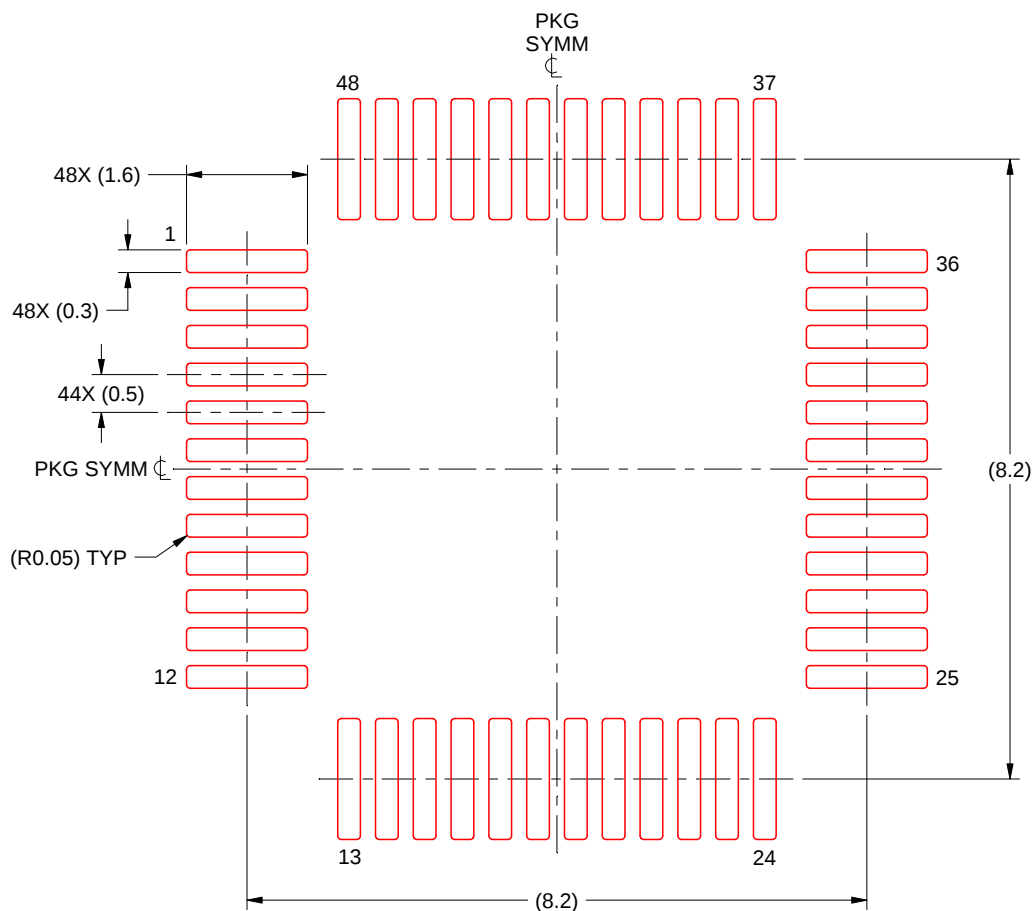
NOTES: (continued)

5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

PT0048A

LQFP - 1.6 mm max height

LOW PROFILE QUAD FLATPACK



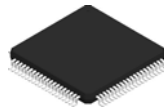
SOLDER PASTE EXAMPLE
BASED ON 0.1 mm THICK STENCIL
SCALE: 10X

4215159/B 11/2023

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.

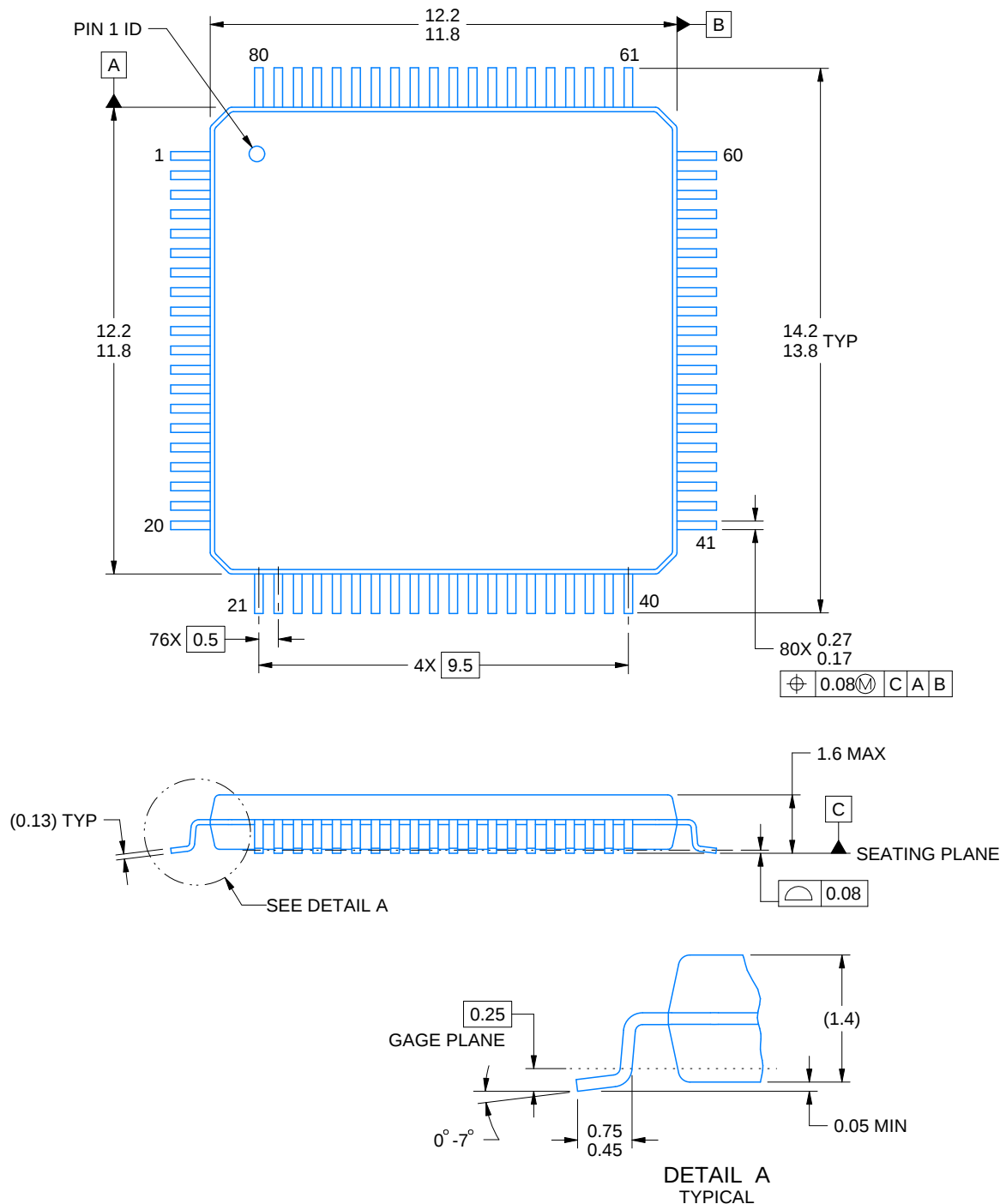
PN0080A



PACKAGE OUTLINE

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



4215166/A 08/2022

NOTES:

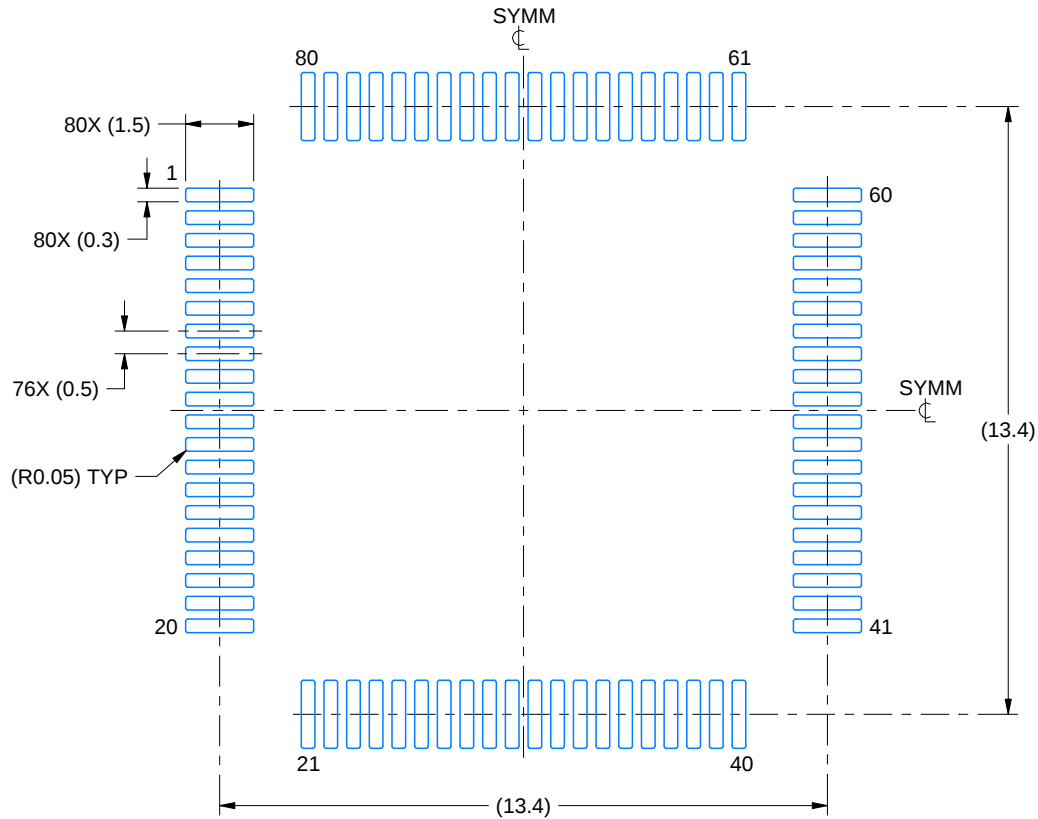
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration MS-026.

EXAMPLE BOARD LAYOUT

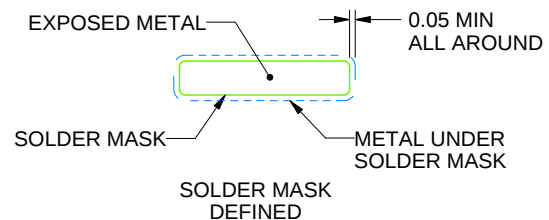
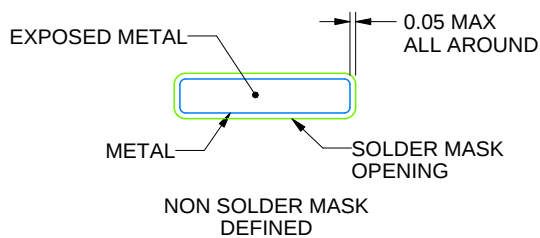
PN0080A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4215166/A 08/2022

NOTES: (continued)

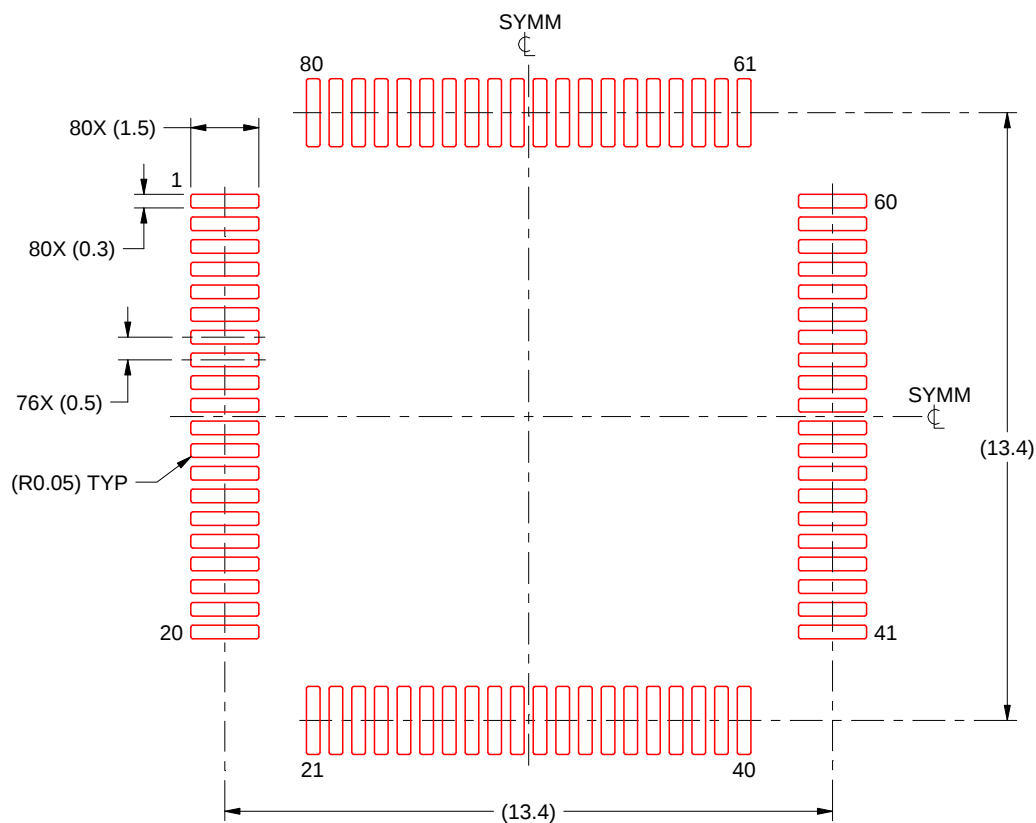
4. Publication IPC-7351 may have alternate designs.
5. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
6. For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).

EXAMPLE STENCIL DESIGN

PN0080A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK

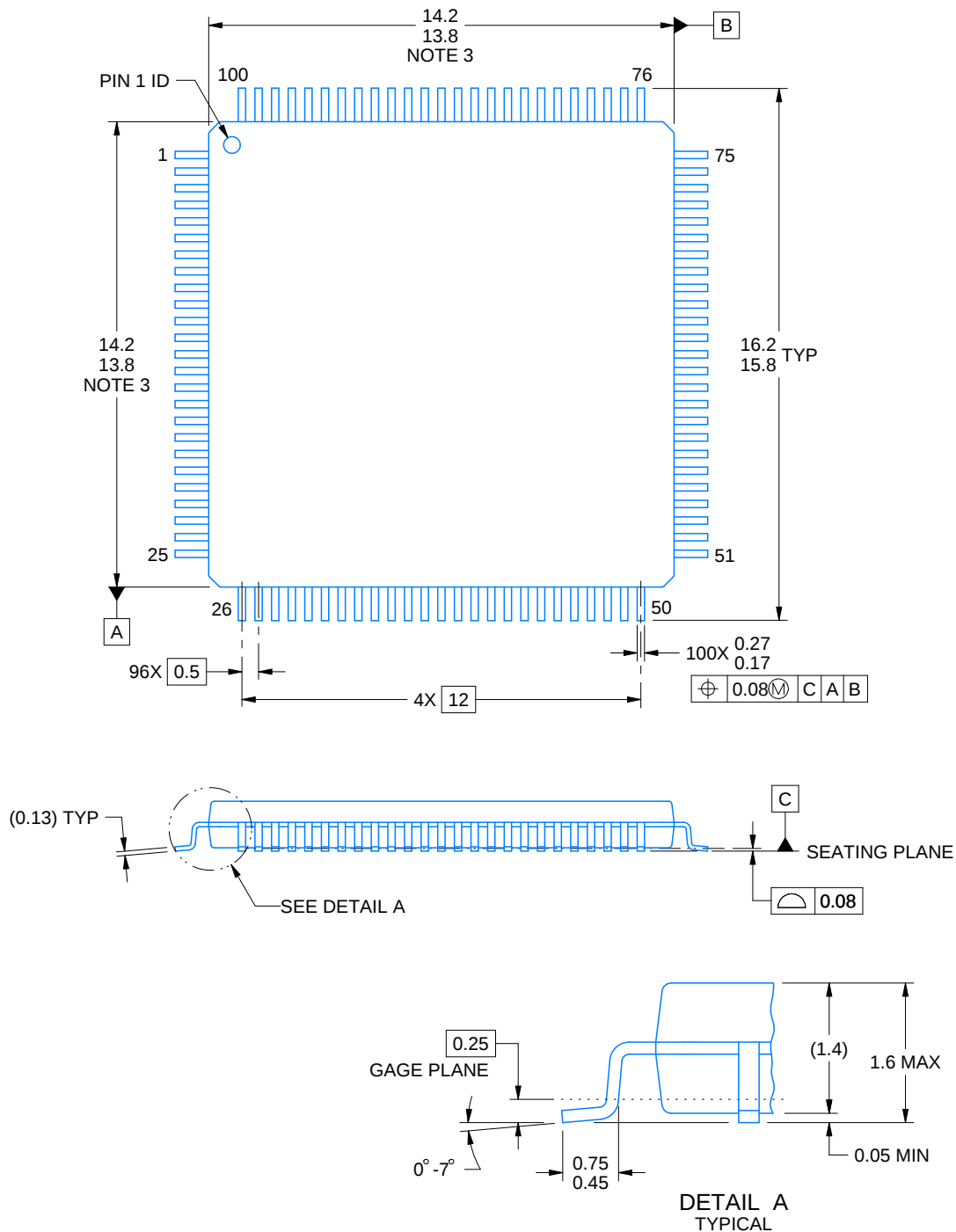
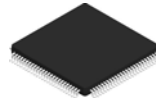


SOLDER PASTE EXAMPLE
BASED ON 0.1 mm THICK STENCIL
SCALE:6X

4215166/A 08/2022

NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.



4215169/A 03/2017

NOTES:

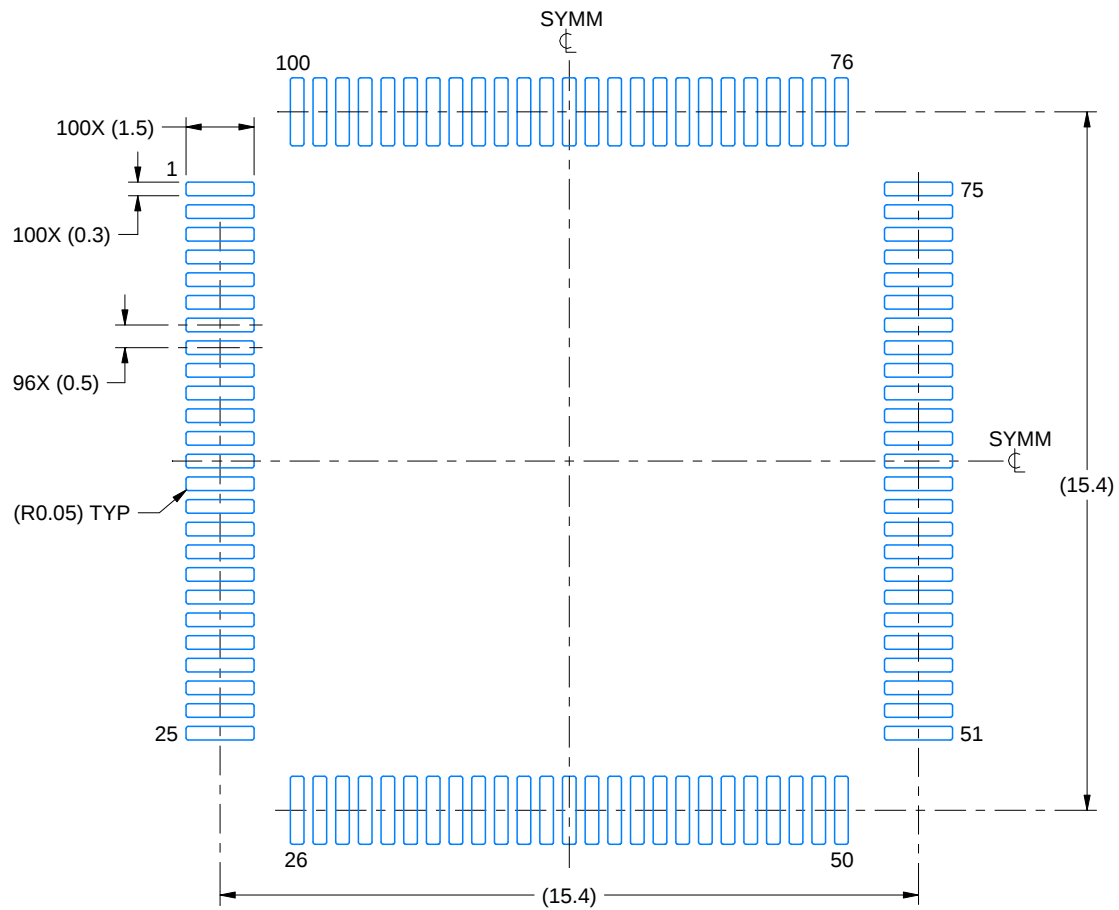
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MS-026.

EXAMPLE BOARD LAYOUT

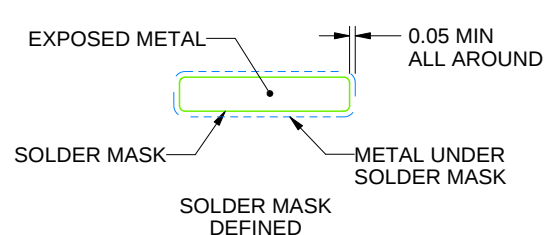
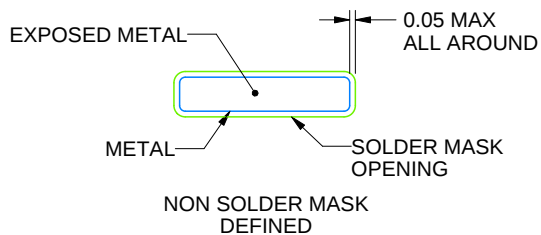
PZ0100A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:6X



SOLDER MASK DETAILS

4215169/A 03/2017

NOTES: (continued)

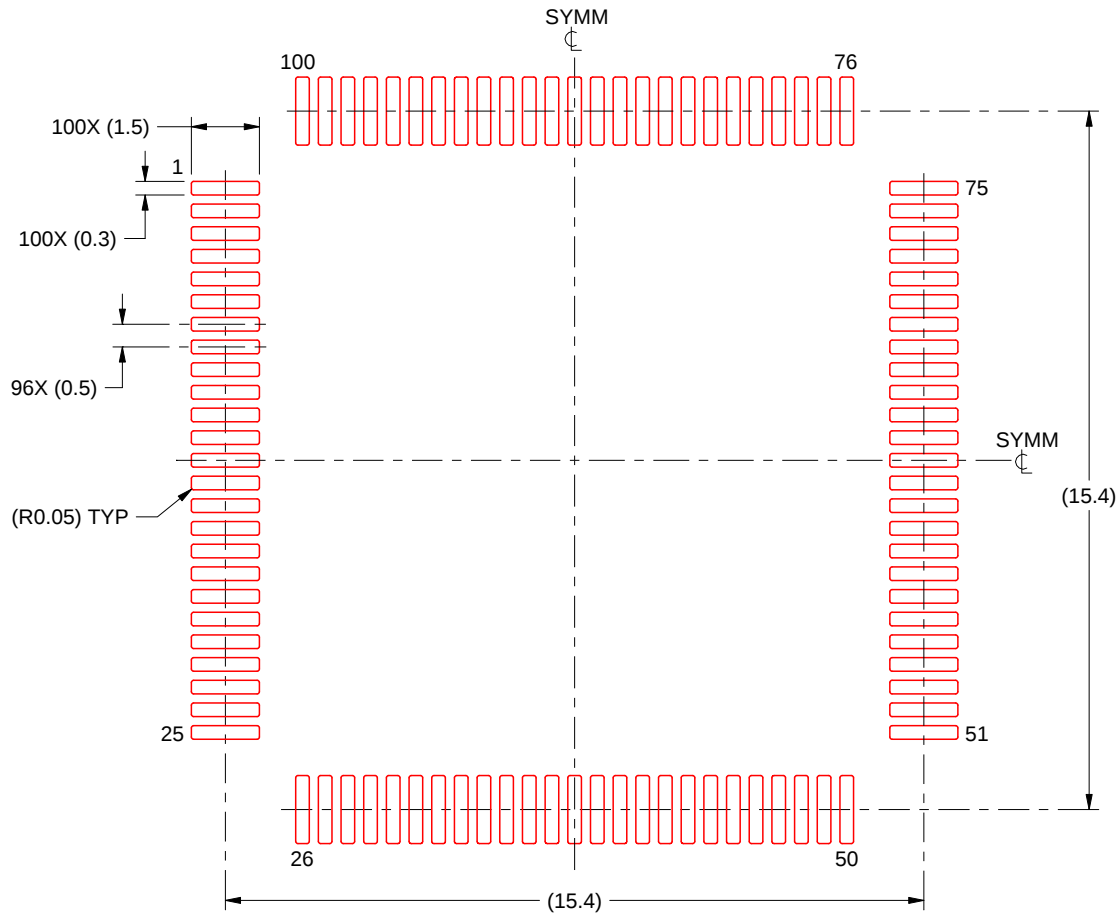
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
7. For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).

EXAMPLE STENCIL DESIGN

PZ0100A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK

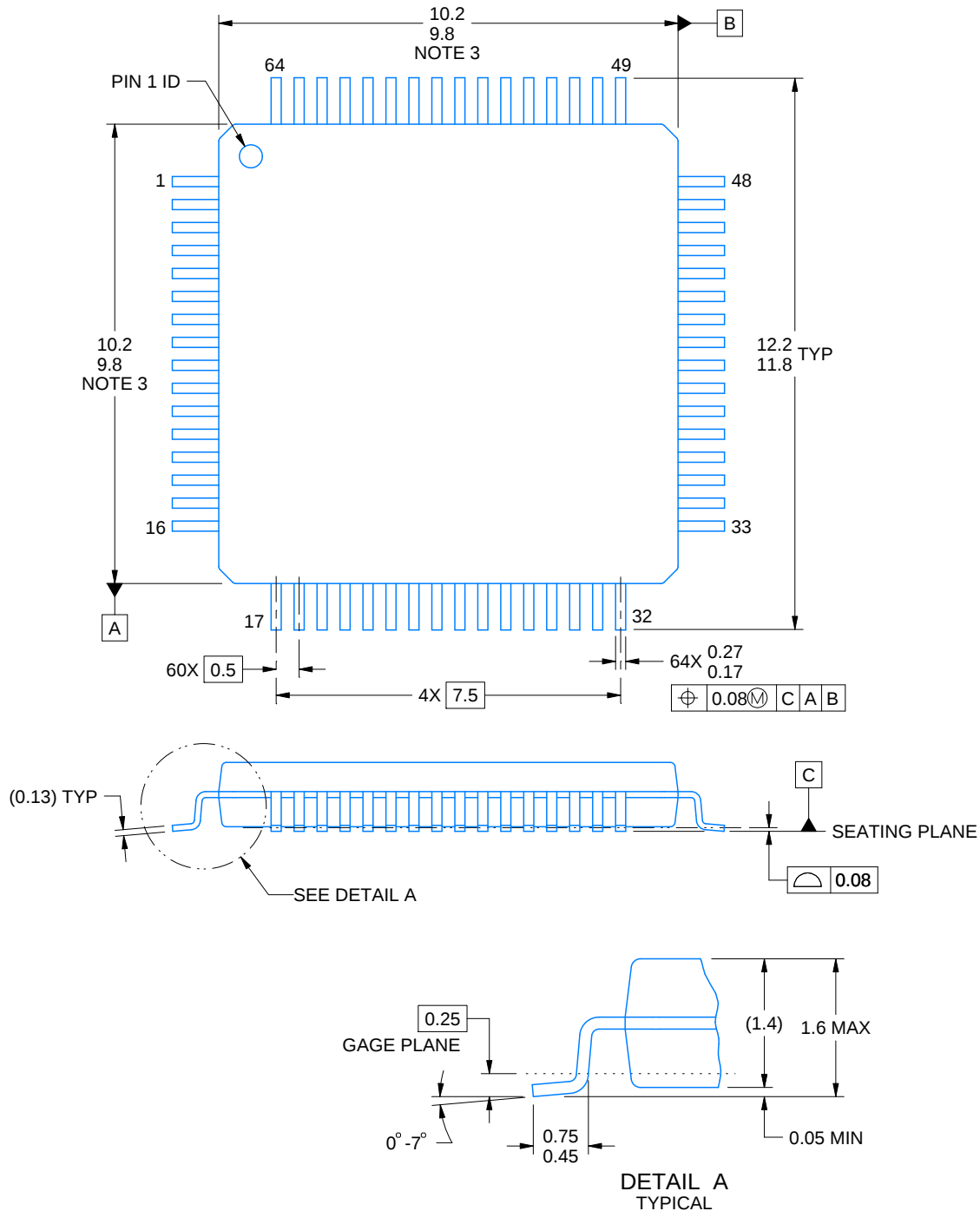
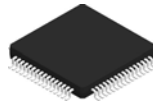


SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:6X

4215169/A 03/2017

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.



4215162/A 03/2017

NOTES:

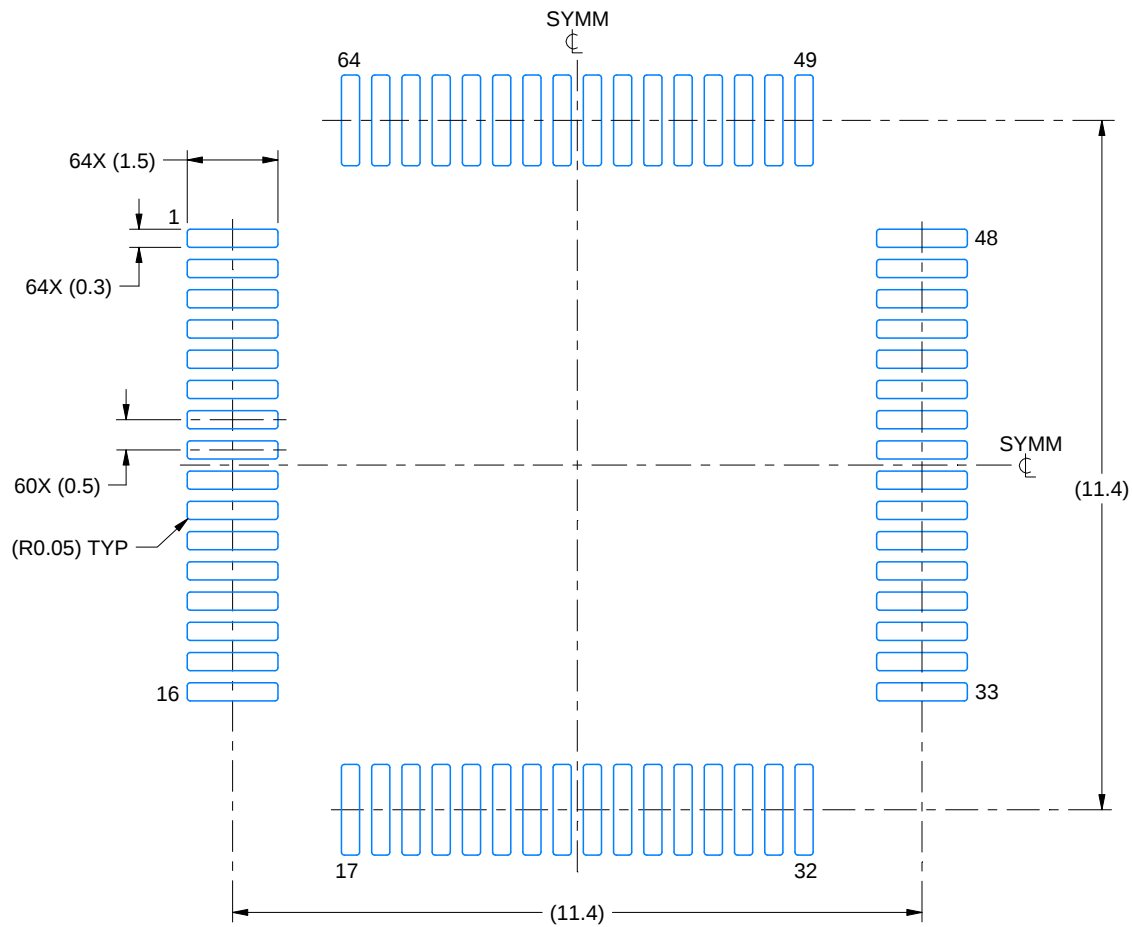
1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm per side.
4. Reference JEDEC registration MS-026.

EXAMPLE BOARD LAYOUT

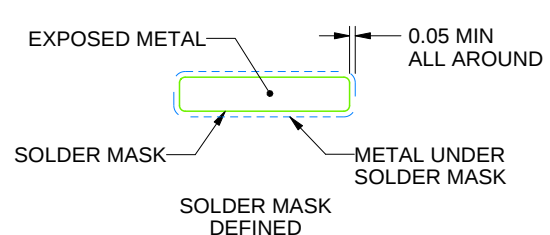
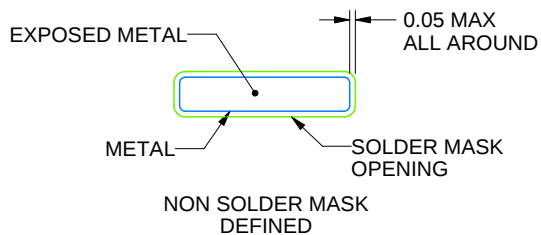
PM0064A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:8X



SOLDER MASK DETAILS

4215162/A 03/2017

NOTES: (continued)

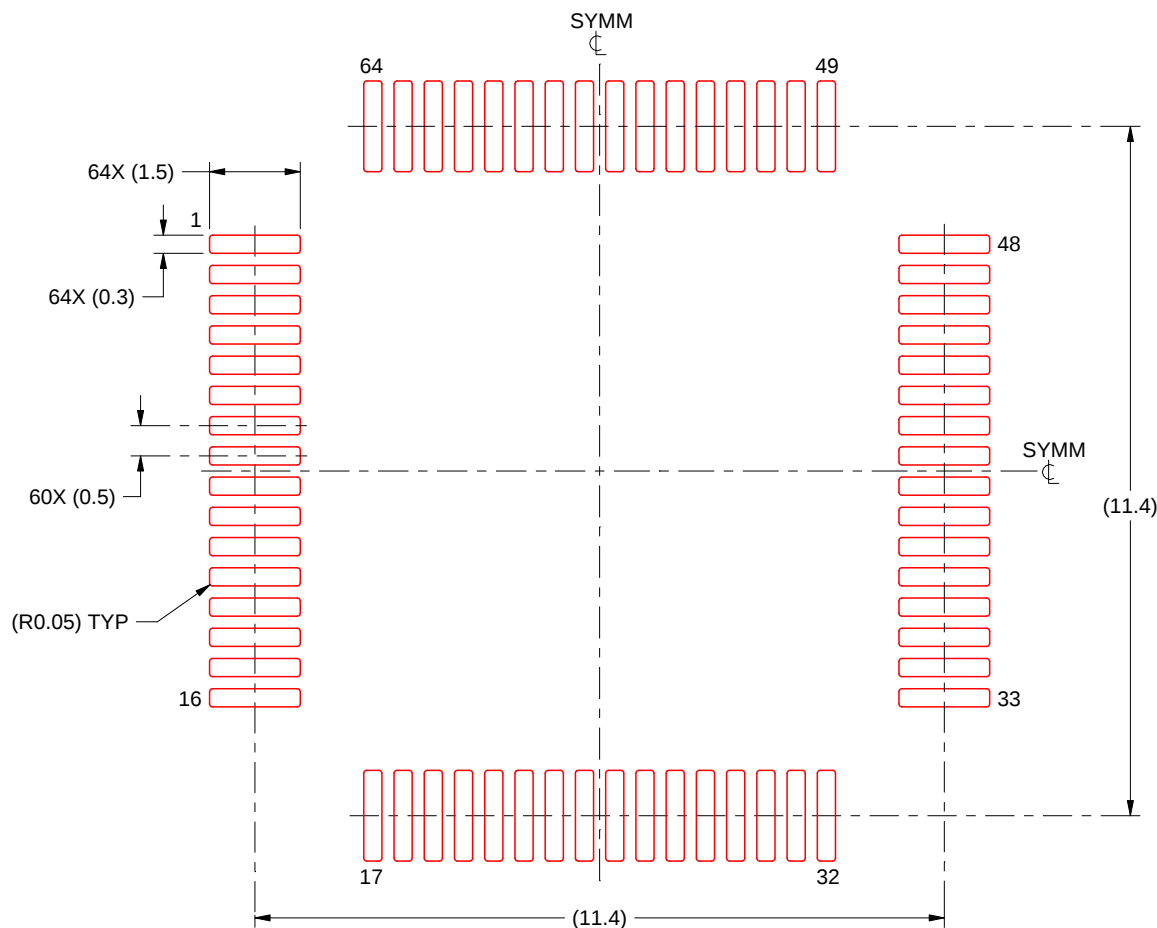
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.
7. For more information, see Texas Instruments literature number SLMA004 (www.ti.com/lit/slma004).

EXAMPLE STENCIL DESIGN

PM0064A

LQFP - 1.6 mm max height

PLASTIC QUAD FLATPACK



SOLDER PASTE EXAMPLE
BASED ON 0.125 mm THICK STENCIL
SCALE:8X

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NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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